



## SM470R1B1M-HT 16-/32-Bit RISC Flash Microcontroller

### 1 Device Overview

#### 1.1 Features

- High-Performance Static CMOS Technology
  - SM470R1x 16-/32-Bit RISC Core ( ARM7TDMI™)
    - 60-MHz System Clock (Pipeline Mode)
    - Independent 16-/32-Bit Instruction Set
    - Open Architecture With Third-Party Support
    - Built-In Debug Module
  - Integrated Memory
    - 1MB Program Flash
      - Two Banks With 16 Contiguous Sectors
    - 64KB Static RAM (SRAM)
    - Memory Security Module (MSM)
    - JTAG Security Module
  - Operating Features
    - Low-Power Modes: STANDBY and HALT
    - Industrial Temperature Range
  - 470+ System Module
    - 32-Bit Address Space Decoding
    - Bus Supervision for Memory/Peripherals
    - Digital Watchdog (DWD) Timer
    - Analog Watchdog (AWD) Timer
    - Enhanced Real-Time Interrupt (RTI)
    - Interrupt Expansion Module (IEM)
    - System Integrity and Failure Detection
    - ICE Breaker
  - Direct Memory Access (DMA) Controller
    - 32 Control Packets and 16 Channels
  - Zero-Pin Phase-Locked Loop (ZPLL)-Based Clock Module With Prescaler
    - Multiply-by-4 or -8 Internal ZPLL Option
    - ZPLL Bypass Mode
  - Twelve Communication Interfaces:
    - Two Serial Peripheral Interfaces (SPIs)
    - 255 Programmable Baud Rates
    - Three Serial Communication Interfaces (SCIs)
      - 2<sup>24</sup> Selectable Baud Rates
      - Asynchronous/Isosynchronous Modes
    - Two High-End CAN Controllers (HECC)
      - 32-Mailbox Capacity
      - Fully Compliant With CAN Protocol, Version 2.0B
    - Five Inter-Integrated Circuit (I<sup>2</sup>C) Modules
      - Multi-Master and Slave Interfaces
      - Up to 400 Kbps (Fast Mode)
      - 7- and 10-Bit Address Capability
    - High-End Timer Lite (HET)
      - 12 Programmable I/O Channels:
        - 12 High-Resolution Pins
      - High-Resolution Share Feature (XOR)
      - High-End Timer RAM
        - 64-Instruction Capacity
    - External Clock Prescale (ECP) Module
      - Programmable Low-Frequency External Clock (CLK)
    - 12-Channel, 10-Bit Multi-Buffered ADC (MibADC)
      - 64-Word FIFO Buffer
      - Single- or Continuous-Conversion Modes
      - 1.55-μs Minimum Sample and Conversion Time
      - Calibration Mode and Self-Test Features
    - Flexible Interrupt Handling
    - Expansion Bus Module (EBM)
      - Supports 8- and 16-Bit Expansion Bus Memory Interface Mappings
      - 42 I/O Expansion Bus Pins
    - 46 Dedicated General-Purpose I/O (GIO) Pins and 47 Additional Peripheral I/Os
    - Sixteen External Interrupts
    - On-Chip Scan-Base Emulation Logic, IEEE Standard 1149.1 <sup>(1)</sup> (JTAG) Test-Access Port
    - Available in KGD, HFQ, HKP, and PGE Packages
- (1) The test-access port is compatible with the IEEE Standard 1149.1-1990, IEEE Standard Test-Access Port and Boundary Scan Architecture specification. Boundary scan is not supported on this device.



## 1.2 Applications

- Supports Extreme Temperature Applications:
  - Controlled Baseline
  - One Assembly/Test Site
  - One Fabrication Site
  - Available in Extreme (–55°C to 220°C) Temperature Range <sup>(2)</sup>
  - Extended Product Life Cycle
  - Extended Product-Change Notification
  - Product Traceability
  - Texas Instruments' high temperature products use highly optimized silicon (die) solutions with design and process enhancements to maximize performance over extended temperatures.

(2) Custom temperature ranges available

## 1.3 Description

The SM470R1B1M <sup>(3)</sup> devices are members of the Texas Instruments SM470R1x family of general-purpose 16-/32-bit reduced instruction set computer (RISC) microcontrollers. The B1M microcontroller offers high performance using the high-speed ARM7TDMI 16-/32-bit RISC central processing unit (CPU), resulting in a high instruction throughput while maintaining greater code efficiency. The ARM7TDMI 16-/32-bit RISC CPU views memory as a linear collection of bytes numbered upwards from zero. The SM470R1B1M uses the big-endian format where the most significant byte of a word is stored at the lowest numbered byte and the least significant byte of a word is stored at the highest numbered byte.

High-end embedded control applications demand more performance from their controllers while maintaining low costs. The B1M RISC core architecture offers solutions to these performance and cost demands while maintaining low power consumption.

The B1M devices contain the following:

- ARM7TDMI 16-/32-bit RISC CPU
- SM470R1x system module (SYS) with 470+ enhancements
- 1MB flash
- 64KB SRAM
- ZPLL clock module
- DWD timer
- AWD timer
- Enhanced RTI module
- IEM
- MSM
- JTAG security module
- Two SPI modules
- Three SCI modules
- Two HECC
- Five I<sup>2</sup>C modules
- 10-bit MibADC, with 12 input channels
- HET controlling 12 I/Os
- ECP

(3) Throughout the remainder of this document, the SM470R1B1M will be referred to as either the full device name or as B1M.

- EBM
- Up to 93 I/O pins

The functions performed by the 470+ system module (SYS) include:

- Address decoding
- Memory protection
- Memory and peripherals bus supervision
- Reset and abort exception management
- Prioritization for all internal interrupt sources
- Device clock control
- Parallel signature analysis (PSA)

The enhanced RTI module on the B1M has the option to be driven by the oscillator clock. The DWD is a 25-bit resettable decremting counter that provides a system reset when the watchdog counter expires. This data sheet includes device-specific information such as memory and peripheral select assignment, interrupt priority, and a device memory map. For a more detailed functional description of the SYS module, see the *TMS470R1x System Module Reference Guide* ([SPNU189](#)).

The B1M memory includes general-purpose SRAM supporting single-cycle read/write accesses in byte, half-word, and word modes.

The flash memory on this device is a nonvolatile, electrically erasable, and programmable memory implemented with a 32-bit-wide data bus interface. The flash operates with a system clock frequency of up to 24 MHz or 30 MHz, depending on the input voltage. When in pipeline mode, the flash operates with a system clock frequency of up to 48 MHz or 60 MHz, depending on the input voltage. For more detailed information on the flash, see [Section 8.2.1.4](#).

The MSM and the JTAG security module prevent unauthorized access and visibility to on-chip memory, thereby preventing reverse engineering or manipulation of proprietary code.

The B1M device has twelve communication interfaces: two SPIs, three SCIs, two HECCs, and five I<sup>2</sup>Cs. The SPI provides a convenient method of serial interaction for high-speed communications between similar shift-register type devices. The SCI is a full-duplex, serial I/O interface intended for asynchronous communication between the CPU and other peripherals using the standard non-return-to-zero (NRZ) format. The HECC uses a serial, multimaster communication protocol that efficiently supports distributed realtime control with robust communication rates of up to 1 Mbps. These CAN peripherals are ideal for applications operating in noisy and harsh environments (for example, industrial fields) that require reliable serial communication or multiplexed wiring. The I<sup>2</sup>C module is a multimaster communication module providing an interface between the B1M microcontroller and an I<sup>2</sup>C-compatible device through the I<sup>2</sup>C serial bus. The I<sup>2</sup>C supports both 100 Kbps and 400 Kbps speeds. For more detailed functional information on the SPI, SCI, and CAN peripherals, see the specific reference guides ([SPNU195](#), [SPNU196](#), and [SPNU197](#)). For more detailed functional information on the I<sup>2</sup>C, see the *TMS470R1x Inter-Integrated Circuit (I<sup>2</sup>C) Reference Guide* ([SPNU223](#)).

The HET is an advanced intelligent timer that provides sophisticated timing functions for realtime applications. The timer is software-controlled, using a reduced instruction set, with a specialized timer micromachine and an attached I/O port. The HET can be used for compare, capture, or general-purpose I/O. It is especially well-suited for applications requiring multiple sensor information and drive actuators with complex and accurate time pulses. The HET used in this device is the high-end timer lite. It has fewer I/Os than the usual 32 in a standard HET. For more detailed functional information on the HET, see the *TMS470R1x High-End Timer (HET) Reference Guide* ([SPNU199](#)).

The B1M HET peripheral contains the XOR-share feature. This feature allows two adjacent HET high-resolution channels to be XORED together, making it possible to output smaller pulses than a standard HET. For more detailed information on the HET XOR-share feature, see the *TMS470R1x High-End Timer (HET) Reference Guide* ([SPNU199](#)).

The B1M device has one 10-bit-resolution, sample-and-hold MibADC. Each of the MibADC channels can be converted individually or can be grouped by software for sequential conversion sequences. There are three separate groupings, two of which can be triggered by an external event. Each sequence can be converted once when triggered or configured for continuous conversion mode. For more detailed functional information on the MibADC, see the *TMS470R1x Multi-Buffered Analog-to-Digital Converter (MibADC) Reference Guide* ([SPNU206](#)).

The ZPLL clock module contains a phase-locked loop, a clock-monitor circuit, a clock-enable circuit, and a prescaler (with prescale values of 1 to 8). The function of the ZPLL is to multiply the external frequency reference to a higher frequency for internal use. The ZPLL provides ACLK to the system (SYS) module. The SYS module subsequently provides system clock (SYSCLK), realtime interrupt clock (RTICK), CPU clock (MCLK), and peripheral interface clock (ICLK) to all other B1M device modules. For more detailed functional information on the ZPLL, see the *TMS470R1x Zero-Pin Phase-Locked Loop (ZPLL) Clock Module Reference Guide* ([SPNU212](#)).

#### NOTE

ACLK should not be confused with the MibADC internal clock, ADCLK. ACLK is the continuous system clock from an external resonator/crystal reference.

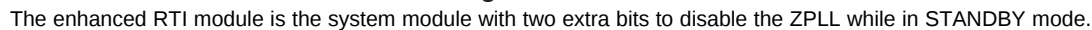
The EBM is a standalone module that supports the multiplexing of the GIO functions and the expansion bus interface. For more information on the EBM, see the *TMS470R1x Expansion Bus Module (EBM) Reference Guide* ([SPNU222](#)).

The B1M device also has an external clock prescaler (ECP) module that when enabled, outputs a continuous external clock (ECLK) on a specified GIO pin. The ECLK frequency is a user-programmable ratio of the peripheral interface clock (ICLK) frequency. For more detailed functional information on the ECP, see the *TMS470R1x External Clock Prescaler (ECP) Reference Guide* ([SPNU202](#)).

**Table 1-1. Device Information<sup>(1)</sup>**

| PART NUMBER   | PACKAGE         | T <sub>A</sub> |
|---------------|-----------------|----------------|
| SM470R1B1M-HT | KGD (0)         | –55°C to 220°C |
|               | CFP (TBAR) (84) |                |
|               | CFP (84)        |                |
|               | LQFP (144)      | –55°C to 150°C |

## 1.4 Functional Block Diagram



## Table of Contents

|          |                                                                |                           |           |                                                              |                           |
|----------|----------------------------------------------------------------|---------------------------|-----------|--------------------------------------------------------------|---------------------------|
| <b>1</b> | <b>Device Overview</b>                                         | <b><a href="#">1</a></b>  | 6.13      | SPI <sup>®</sup> Slave Mode Timing Parameters                | <a href="#">42</a>        |
| 1.1      | Features                                                       | <a href="#">1</a>         | 6.14      | SCIN Isosynchronous Mode Timings - Internal Clock            | <a href="#">45</a>        |
| 1.2      | Applications                                                   | <a href="#">2</a>         | 6.15      | SCIN Isosynchronous Mode Timings - External Clock            | <a href="#">46</a>        |
| 1.3      | Description                                                    | <a href="#">2</a>         | 6.16      | I <sup>2</sup> C Timing                                      | <a href="#">47</a>        |
| 1.4      | Functional Block Diagram                                       | <a href="#">5</a>         | 6.17      | Standard Can Controller (SCC) Mode Timings                   | <a href="#">48</a>        |
| <b>2</b> | <b>Revision History</b>                                        | <b><a href="#">7</a></b>  | 6.18      | Expansion Bus Module Timing                                  | <a href="#">49</a>        |
| <b>3</b> | <b>Device Characteristics</b>                                  | <b><a href="#">9</a></b>  | 6.19      | Multi-Buffered A-to-D Converter (MibADC)                     | <a href="#">51</a>        |
| <b>4</b> | <b>Bare Die</b>                                                | <b><a href="#">10</a></b> | <b>7</b>  | <b>Parameter Measurement Information</b>                     | <b><a href="#">55</a></b> |
| 4.1      | Bare Die Information                                           | <a href="#">10</a>        | 7.1       | External Reference Resonator/Crystal Oscillator Clock Option | <a href="#">55</a>        |
| <b>5</b> | <b>Pin Configuration and Functions</b>                         | <b><a href="#">15</a></b> | <b>8</b>  | <b>Detailed Description</b>                                  | <b><a href="#">56</a></b> |
| 5.1      | Features                                                       | <a href="#">17</a>        | 8.1       | Overview                                                     | <a href="#">56</a>        |
| 5.2      | Pin Functions (HFQ/HKP Package)                                | <a href="#">18</a>        | 8.2       | Memory                                                       | <a href="#">61</a>        |
| 5.3      | Pin Functions (PGE Package)                                    | <a href="#">23</a>        | <b>9</b>  | <b>Device and Documentation Support</b>                      | <b><a href="#">68</a></b> |
| <b>6</b> | <b>Specifications</b>                                          | <b><a href="#">30</a></b> | 9.1       | Device Support                                               | <a href="#">68</a>        |
| 6.1      | Absolute Maximum Ratings                                       | <a href="#">30</a>        | 9.2       | Development Support                                          | <a href="#">69</a>        |
| 6.2      | ESD Ratings                                                    | <a href="#">30</a>        | 9.3       | Device Nomenclature                                          | <a href="#">69</a>        |
| 6.3      | Recommended Operating Conditions                               | <a href="#">30</a>        | 9.4       | Documentation Support                                        | <a href="#">71</a>        |
| 6.4      | Electrical Characteristics                                     | <a href="#">31</a>        | 9.5       | Community Resources                                          | <a href="#">71</a>        |
| 6.5      | Thermal Characteristics                                        | <a href="#">32</a>        | 9.6       | Trademarks                                                   | <a href="#">71</a>        |
| 6.6      | ZPLL and Clock Specifications                                  | <a href="#">34</a>        | 9.7       | Electrostatic Discharge Caution                              | <a href="#">72</a>        |
| 6.7      | $\overline{\text{RST}}$ and $\overline{\text{PORRST}}$ Timings | <a href="#">36</a>        | 9.8       | Glossary                                                     | <a href="#">72</a>        |
| 6.8      | JTAG Scan Interface Timing                                     | <a href="#">37</a>        | <b>10</b> | <b>Mechanical Packaging and Orderable Information</b>        | <b><a href="#">73</a></b> |
| 6.9      | Output Timings                                                 | <a href="#">38</a>        | 10.1      | Packaging Information                                        | <a href="#">73</a>        |
| 6.10     | Input Timings                                                  | <a href="#">39</a>        |           |                                                              |                           |
| 6.11     | Flash Timings                                                  | <a href="#">39</a>        |           |                                                              |                           |
| 6.12     | SPI <sup>®</sup> Master Mode Timing Parameters                 | <a href="#">40</a>        |           |                                                              |                           |

## 2 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision H (September 2013) to Revision I                                                                                                                                                                                                                                                                                 | Page                       |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------|
| <ul style="list-style-type: none"> <li>Added <i>ESD Ratings</i> table, <i>Detailed Description</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section .....</li> <li>Updated <math>I_{CC}</math> standby mode maximum from 1.3 mA to 28 mA .....</li> </ul> | <div>1</div> <div>32</div> |

---

**Changes from Revision G (July 2013) to Revision H****Page**

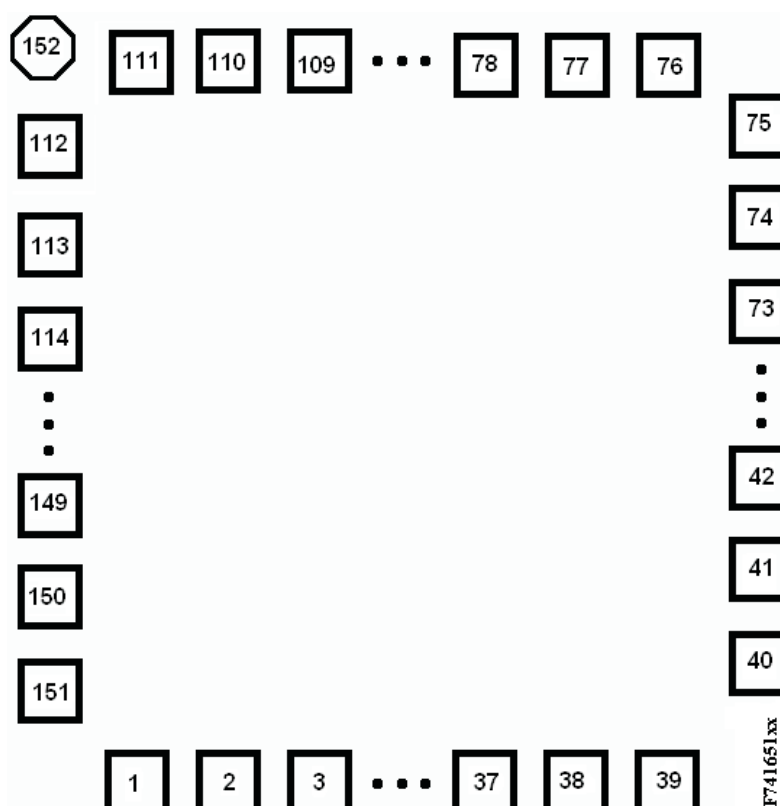
- 
- Changed temperature range condition on *Electrical Characteristics* table ..... [31](#)
  - Added *Thermal Information* table ..... [32](#)
-

### 3 Device Characteristics

| CHARACTERISTICS <sup>(1)</sup>                                                                                                                                                                                                                                                  | DEVICE DESCRIPTION<br>SM470R1B1M                                                       | COMMENTS                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>MEMORY</b>                                                                                                                                                                                                                                                                   |                                                                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| For the number of memory selects on this device, see <a href="#">Table 8-5, SM470R1B1M Memory Selection Assignment</a> .                                                                                                                                                        |                                                                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| INTERNAL MEMORY                                                                                                                                                                                                                                                                 | Pipeline/non-pipeline<br><br>1MB flash<br>64KB SRAM<br><br>MSM<br>JTAG security module | Flash is pipeline-capable.<br><br>The B1M RAM is implemented in one 64K array selected by two memory-select signals (see <a href="#">Table 8-5, SM470R1B1M Memory Selection Assignment</a> ).                                                                                                                                                                                                                                                                         |
| <b>PERIPHERALS</b>                                                                                                                                                                                                                                                              |                                                                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| For the device-specific interrupt priority configurations, see <a href="#">Table 8-2, Interrupt Priority</a> . And for the 1K peripheral address ranges and their peripheral selects, see <a href="#">Table 8-7, B1M Peripherals, System Module, and Flash Base Addresses</a> . |                                                                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| CLOCK                                                                                                                                                                                                                                                                           | ZPLL                                                                                   | Zero-pin PLL has no external loop filter pins.                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Expansion bus                                                                                                                                                                                                                                                                   | EBM                                                                                    | Expansion bus module with 42 pins. Supports 8- and 16-bit memories. See <a href="#">Table 8-3</a> for details.                                                                                                                                                                                                                                                                                                                                                        |
| GENERAL-PURPOSE I/Os                                                                                                                                                                                                                                                            | 46 I/O                                                                                 | Port A has 8 external pins.<br>Port B has only 1 external pin.<br>Port C has 5 external pins.<br>Port D has 6 external pins.<br>Ports E, F, and G each have 8 external pins.<br>Port H has 2 external pins.                                                                                                                                                                                                                                                           |
| ECP                                                                                                                                                                                                                                                                             | Yes                                                                                    |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| SCI                                                                                                                                                                                                                                                                             | 3 (3 pin)                                                                              |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| CAN (HECC and/or SCC)                                                                                                                                                                                                                                                           | 2 HECC                                                                                 | Two HECC                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| SPI (5-pin, 4-pin, or 3-pin)                                                                                                                                                                                                                                                    | 2 (5 pin)                                                                              |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| I <sup>2</sup> C                                                                                                                                                                                                                                                                | 5                                                                                      |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| HET with XOR share                                                                                                                                                                                                                                                              | 12 I/O                                                                                 | The high-resolution (HR) SHARE feature allows even-numbered HR pins to share the next higher odd-numbered HR pin structures. This HR sharing is independent of whether or not the odd pin is available externally. If an odd pin is available externally and <i>shared</i> , then the odd pin can only be used as a general-purpose I/O. For more information on HR SHARE, see the <i>TMS470R1x High-End Timer (HET) Reference Guide</i> ( <a href="#">SPNU199</a> ). |
| HET RAM                                                                                                                                                                                                                                                                         | 64-instruction capacity                                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| MibADC                                                                                                                                                                                                                                                                          | 10-bit, 12-channel<br>64-word FIFO                                                     | Both the logic and registers for a full 16-channel MibADC are present.                                                                                                                                                                                                                                                                                                                                                                                                |
| CORE VOLTAGE                                                                                                                                                                                                                                                                    | 1.8 V                                                                                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| I/O VOLTAGE                                                                                                                                                                                                                                                                     | 3.3 V                                                                                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| PINS                                                                                                                                                                                                                                                                            | 84 or 144                                                                              |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| PACKAGES                                                                                                                                                                                                                                                                        | HFQ, HKP, or PGE                                                                       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |

(1) This table identifies all the characteristics of the B1M device except the SYSTEM and CPU, which are generic.

## 4 Bare Die



### 4.1 Bare Die Information

| DIE SIZE                                        | DIE PAD SIZE     | DIE PAD COORDINATES <sup>(1)</sup> | DIE THICKNESS | DIE PAD COMPOSITION | BACKSIDE FINISH           | BACKSIDE POTENTIAL |
|-------------------------------------------------|------------------|------------------------------------|---------------|---------------------|---------------------------|--------------------|
| 208.858 × 211.890 mils/<br>5304.99 × 5382.01 μm | 65.1 × 65.1 (μm) | See <a href="#">Table 4-1</a>      | 11 mils       | AlCu                | Silicon with<br>backgrind | Ground             |

(1) Pads 12, 22, 26, 136, 143, 146, 149 and 152 are test pads, no connections required. It is highly recommended to leave them open.

**Table 4-1. Bond Pad Coordinates**

| PAD NO. | BOND PAD COORDINATES (μm) |          |          |          | PAD SIZE (μm) |      |
|---------|---------------------------|----------|----------|----------|---------------|------|
|         | X MIN                     | Y MIN    | X MAX    | Y MAX    | X             | Y    |
| 1       | 178.955                   | 10.08    | 244.055  | 75.18    | 65.1          | 65.1 |
| 2       | 368.2                     | 10.08    | 433.3    | 75.18    | 65.1          | 65.1 |
| 3       | 557.445                   | 10.08    | 622.545  | 75.18    | 65.1          | 65.1 |
| 4       | 664.335                   | 10.08    | 729.435  | 75.18    | 65.1          | 65.1 |
| 5       | 853.58                    | 10.08    | 918.68   | 75.18    | 65.1          | 65.1 |
| 6       | 1042.825                  | 10.08    | 1107.925 | 75.18    | 65.1          | 65.1 |
| 7       | 1149.715                  | 10.08    | 1214.815 | 75.18    | 65.1          | 65.1 |
| 8       | 1338.96                   | 10.08    | 1404.06  | 75.18    | 65.1          | 65.1 |
| 9       | 1445.85                   | 10.08    | 1510.95  | 75.18    | 65.1          | 65.1 |
| 10      | 1552.74                   | 10.08    | 1617.84  | 75.18    | 65.1          | 65.1 |
| 11      | 1659.63                   | 10.08    | 1724.73  | 75.18    | 65.1          | 65.1 |
| 12      | 1766.52                   | 10.08    | 1831.62  | 75.18    | 65.1          | 65.1 |
| 13      | 1866.2                    | 10.08    | 1931.3   | 75.18    | 65.1          | 65.1 |
| 14      | 1965.88                   | 10.08    | 2030.98  | 75.18    | 65.1          | 65.1 |
| 15      | 2065.56                   | 10.08    | 2130.66  | 75.18    | 65.1          | 65.1 |
| 16      | 2165.24                   | 10.08    | 2230.34  | 75.18    | 65.1          | 65.1 |
| 17      | 2272.13                   | 10.08    | 2337.23  | 75.18    | 65.1          | 65.1 |
| 18      | 2396.1                    | 10.08    | 2461.2   | 75.18    | 65.1          | 65.1 |
| 19      | 2520.07                   | 10.08    | 2585.17  | 75.18    | 65.1          | 65.1 |
| 20      | 2626.96                   | 10.08    | 2692.06  | 75.18    | 65.1          | 65.1 |
| 21      | 2733.85                   | 10.08    | 2798.95  | 75.18    | 65.1          | 65.1 |
| 22      | 2840.74                   | 10.08    | 2905.84  | 75.18    | 65.1          | 65.1 |
| 23      | 2947.63                   | 10.08    | 3012.73  | 75.18    | 65.1          | 65.1 |
| 24      | 3054.52                   | 10.08    | 3119.62  | 75.18    | 65.1          | 65.1 |
| 25      | 3243.765                  | 10.08    | 3308.865 | 75.18    | 65.1          | 65.1 |
| 26      | 3350.655                  | 10.08    | 3415.755 | 75.18    | 65.1          | 65.1 |
| 27      | 3539.9                    | 10.08    | 3605     | 75.18    | 65.1          | 65.1 |
| 28      | 3646.79                   | 10.08    | 3711.89  | 75.18    | 65.1          | 65.1 |
| 29      | 3746.47                   | 10.08    | 3811.57  | 75.18    | 65.1          | 65.1 |
| 30      | 3846.15                   | 10.08    | 3911.25  | 75.18    | 65.1          | 65.1 |
| 31      | 3953.04                   | 10.08    | 4018.14  | 75.18    | 65.1          | 65.1 |
| 32      | 4142.285                  | 10.08    | 4207.385 | 75.18    | 65.1          | 65.1 |
| 33      | 4331.53                   | 10.08    | 4396.63  | 75.18    | 65.1          | 65.1 |
| 34      | 4431.21                   | 10.08    | 4496.31  | 75.18    | 65.1          | 65.1 |
| 35      | 4530.89                   | 10.08    | 4595.99  | 75.18    | 65.1          | 65.1 |
| 36      | 4630.57                   | 10.08    | 4695.67  | 75.18    | 65.1          | 65.1 |
| 37      | 4730.25                   | 10.08    | 4795.35  | 75.18    | 65.1          | 65.1 |
| 38      | 4829.93                   | 10.08    | 4895.03  | 75.18    | 65.1          | 65.1 |
| 39      | 4936.82                   | 10.08    | 5001.92  | 75.18    | 65.1          | 65.1 |
| 40      | 5150.04                   | 178.955  | 5215.14  | 244.055  | 65.1          | 65.1 |
| 41      | 5150.04                   | 368.2    | 5215.14  | 433.3    | 65.1          | 65.1 |
| 42      | 5150.04                   | 557.445  | 5215.14  | 622.545  | 65.1          | 65.1 |
| 43      | 5150.04                   | 666.26   | 5215.14  | 731.36   | 65.1          | 65.1 |
| 44      | 5150.04                   | 855.505  | 5215.14  | 920.605  | 65.1          | 65.1 |
| 45      | 5150.04                   | 1044.75  | 5215.14  | 1109.85  | 65.1          | 65.1 |
| 46      | 5150.04                   | 1153.565 | 5215.14  | 1218.665 | 65.1          | 65.1 |

**Table 4-1. Bond Pad Coordinates (continued)**

| PAD NO. | BOND PAD COORDINATES (μm) |          |          |          | PAD SIZE (μm) |      |
|---------|---------------------------|----------|----------|----------|---------------|------|
|         | X MIN                     | Y MIN    | X MAX    | Y MAX    | X             | Y    |
| 47      | 5150.04                   | 1262.38  | 5215.14  | 1327.48  | 65.1          | 65.1 |
| 48      | 5150.04                   | 1371.195 | 5215.14  | 1436.295 | 65.1          | 65.1 |
| 49      | 5150.04                   | 1480.01  | 5215.14  | 1545.11  | 65.1          | 65.1 |
| 50      | 5150.04                   | 1669.255 | 5215.14  | 1734.355 | 65.1          | 65.1 |
| 51      | 5150.04                   | 1778.07  | 5215.14  | 1843.17  | 65.1          | 65.1 |
| 52      | 5150.04                   | 1886.885 | 5215.14  | 1951.985 | 65.1          | 65.1 |
| 53      | 5150.04                   | 1995.7   | 5215.14  | 2060.8   | 65.1          | 65.1 |
| 54      | 5150.04                   | 2184.945 | 5215.14  | 2250.045 | 65.1          | 65.1 |
| 55      | 5150.04                   | 2293.76  | 5215.14  | 2358.86  | 65.1          | 65.1 |
| 56      | 5150.04                   | 2402.575 | 5215.14  | 2467.675 | 65.1          | 65.1 |
| 57      | 5150.04                   | 2511.39  | 5215.14  | 2576.49  | 65.1          | 65.1 |
| 58      | 5150.04                   | 2700.635 | 5215.14  | 2765.735 | 65.1          | 65.1 |
| 59      | 5150.04                   | 2809.45  | 5215.14  | 2874.55  | 65.1          | 65.1 |
| 60      | 5150.04                   | 2998.695 | 5215.14  | 3063.795 | 65.1          | 65.1 |
| 61      | 5150.04                   | 3187.94  | 5215.14  | 3253.04  | 65.1          | 65.1 |
| 62      | 5150.04                   | 3296.755 | 5215.14  | 3361.855 | 65.1          | 65.1 |
| 63      | 5150.04                   | 3486     | 5215.14  | 3551.1   | 65.1          | 65.1 |
| 64      | 5150.04                   | 3675.245 | 5215.14  | 3740.345 | 65.1          | 65.1 |
| 65      | 5150.04                   | 3784.06  | 5215.14  | 3849.16  | 65.1          | 65.1 |
| 66      | 5150.04                   | 3973.305 | 5215.14  | 4038.405 | 65.1          | 65.1 |
| 67      | 5150.04                   | 4082.12  | 5215.14  | 4147.22  | 65.1          | 65.1 |
| 68      | 5150.04                   | 4190.935 | 5215.14  | 4256.035 | 65.1          | 65.1 |
| 69      | 5150.04                   | 4299.75  | 5215.14  | 4364.85  | 65.1          | 65.1 |
| 70      | 5150.04                   | 4408.565 | 5215.14  | 4473.665 | 65.1          | 65.1 |
| 71      | 5150.04                   | 4517.38  | 5215.14  | 4582.48  | 65.1          | 65.1 |
| 72      | 5150.04                   | 4626.195 | 5215.14  | 4691.295 | 65.1          | 65.1 |
| 73      | 5150.04                   | 4735.01  | 5215.14  | 4800.11  | 65.1          | 65.1 |
| 74      | 5150.04                   | 4843.825 | 5215.14  | 4908.925 | 65.1          | 65.1 |
| 75      | 5150.04                   | 4952.64  | 5215.14  | 5017.74  | 65.1          | 65.1 |
| 76      | 4981.165                  | 5148.85  | 5046.265 | 5213.95  | 65.1          | 65.1 |
| 77      | 4862.935                  | 5148.85  | 4928.035 | 5213.95  | 65.1          | 65.1 |
| 78      | 4738.965                  | 5148.85  | 4804.065 | 5213.95  | 65.1          | 65.1 |
| 79      | 4614.995                  | 5148.85  | 4680.095 | 5213.95  | 65.1          | 65.1 |
| 80      | 4496.765                  | 5148.85  | 4561.865 | 5213.95  | 65.1          | 65.1 |
| 81      | 4378.535                  | 5148.85  | 4443.635 | 5213.95  | 65.1          | 65.1 |
| 82      | 4189.29                   | 5148.85  | 4254.39  | 5213.95  | 65.1          | 65.1 |
| 83      | 4000.045                  | 5148.85  | 4065.145 | 5213.95  | 65.1          | 65.1 |
| 84      | 3881.815                  | 5148.85  | 3946.915 | 5213.95  | 65.1          | 65.1 |
| 85      | 3757.845                  | 5148.85  | 3822.945 | 5213.95  | 65.1          | 65.1 |
| 86      | 3639.615                  | 5148.85  | 3704.715 | 5213.95  | 65.1          | 65.1 |
| 87      | 3450.37                   | 5148.85  | 3515.47  | 5213.95  | 65.1          | 65.1 |
| 88      | 3332.14                   | 5148.85  | 3397.24  | 5213.95  | 65.1          | 65.1 |
| 89      | 3213.91                   | 5148.85  | 3279.01  | 5213.95  | 65.1          | 65.1 |
| 90      | 3095.68                   | 5148.85  | 3160.78  | 5213.95  | 65.1          | 65.1 |
| 91      | 2906.435                  | 5148.85  | 2971.535 | 5213.95  | 65.1          | 65.1 |
| 92      | 2717.19                   | 5148.85  | 2782.29  | 5213.95  | 65.1          | 65.1 |

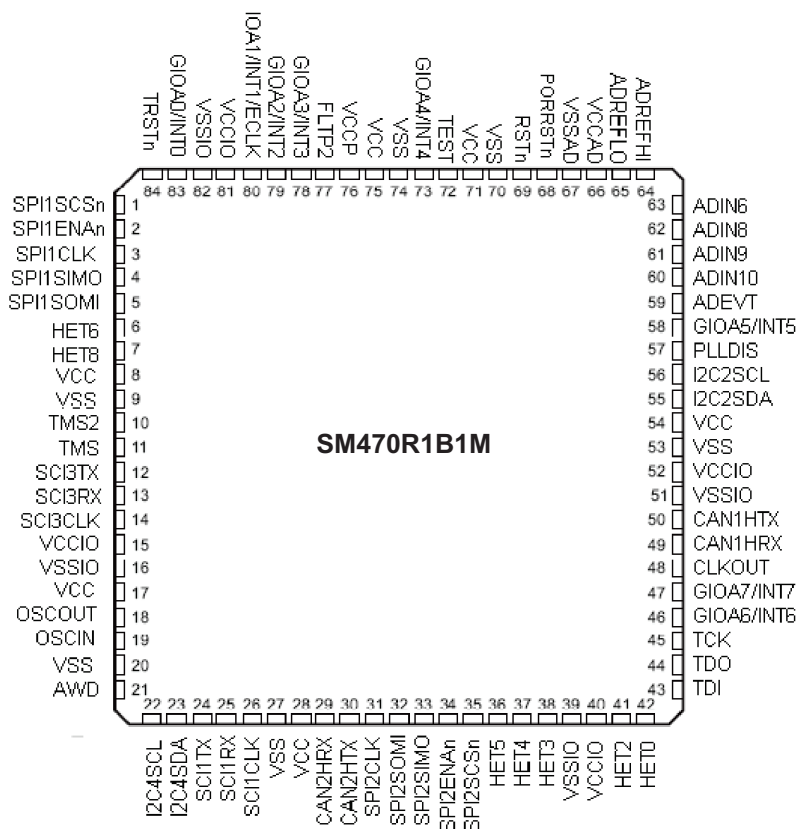
**Table 4-1. Bond Pad Coordinates (continued)**

| PAD NO. | BOND PAD COORDINATES (μm) |          |          |          | PAD SIZE (μm) |      |
|---------|---------------------------|----------|----------|----------|---------------|------|
|         | X MIN                     | Y MIN    | X MAX    | Y MAX    | X             | Y    |
| 93      | 2598.96                   | 5148.85  | 2664.06  | 5213.95  | 65.1          | 65.1 |
| 94      | 2480.73                   | 5148.85  | 2545.83  | 5213.95  | 65.1          | 65.1 |
| 95      | 2362.5                    | 5148.85  | 2427.6   | 5213.95  | 65.1          | 65.1 |
| 96      | 2244.27                   | 5148.85  | 2309.37  | 5213.95  | 65.1          | 65.1 |
| 97      | 2126.04                   | 5148.85  | 2191.14  | 5213.95  | 65.1          | 65.1 |
| 98      | 1936.795                  | 5148.85  | 2001.895 | 5213.95  | 65.1          | 65.1 |
| 99      | 1747.55                   | 5148.85  | 1812.65  | 5213.95  | 65.1          | 65.1 |
| 100     | 1629.32                   | 5148.85  | 1694.42  | 5213.95  | 65.1          | 65.1 |
| 101     | 1511.09                   | 5148.85  | 1576.19  | 5213.95  | 65.1          | 65.1 |
| 102     | 1321.845                  | 5148.85  | 1386.945 | 5213.95  | 65.1          | 65.1 |
| 103     | 1203.615                  | 5148.85  | 1268.715 | 5213.95  | 65.1          | 65.1 |
| 104     | 1085.385                  | 5148.85  | 1150.485 | 5213.95  | 65.1          | 65.1 |
| 105     | 967.155                   | 5148.85  | 1032.255 | 5213.95  | 65.1          | 65.1 |
| 106     | 843.185                   | 5148.85  | 908.285  | 5213.95  | 65.1          | 65.1 |
| 107     | 719.215                   | 5148.85  | 784.315  | 5213.95  | 65.1          | 65.1 |
| 108     | 595.245                   | 5148.85  | 660.345  | 5213.95  | 65.1          | 65.1 |
| 109     | 471.275                   | 5148.85  | 536.375  | 5213.95  | 65.1          | 65.1 |
| 110     | 347.305                   | 5148.85  | 412.405  | 5213.95  | 65.1          | 65.1 |
| 111     | 223.335                   | 5148.85  | 288.435  | 5213.95  | 65.1          | 65.1 |
| 112     | 10.08                     | 4979.975 | 75.18    | 5045.075 | 65.1          | 65.1 |
| 113     | 10.08                     | 4868.5   | 75.18    | 4933.6   | 65.1          | 65.1 |
| 114     | 10.08                     | 4757.025 | 75.18    | 4822.125 | 65.1          | 65.1 |
| 115     | 10.08                     | 4645.55  | 75.18    | 4710.65  | 65.1          | 65.1 |
| 116     | 10.08                     | 4534.075 | 75.18    | 4599.175 | 65.1          | 65.1 |
| 117     | 10.08                     | 4410.105 | 75.18    | 4475.205 | 65.1          | 65.1 |
| 118     | 10.08                     | 4286.135 | 75.18    | 4351.235 | 65.1          | 65.1 |
| 119     | 10.08                     | 4162.165 | 75.18    | 4227.265 | 65.1          | 65.1 |
| 120     | 10.08                     | 4038.195 | 75.18    | 4103.295 | 65.1          | 65.1 |
| 121     | 10.08                     | 3912.825 | 75.18    | 3977.925 | 65.1          | 65.1 |
| 122     | 10.08                     | 3801.35  | 75.18    | 3866.45  | 65.1          | 65.1 |
| 123     | 10.08                     | 3689.875 | 75.18    | 3754.975 | 65.1          | 65.1 |
| 124     | 10.08                     | 3578.4   | 75.18    | 3643.5   | 65.1          | 65.1 |
| 125     | 10.08                     | 3466.925 | 75.18    | 3532.025 | 65.1          | 65.1 |
| 126     | 10.08                     | 3355.45  | 75.18    | 3420.55  | 65.1          | 65.1 |
| 127     | 10.08                     | 3243.975 | 75.18    | 3309.075 | 65.1          | 65.1 |
| 128     | 10.08                     | 3132.5   | 75.18    | 3197.6   | 65.1          | 65.1 |
| 129     | 10.08                     | 3021.025 | 75.18    | 3086.125 | 65.1          | 65.1 |
| 130     | 10.08                     | 2909.55  | 75.18    | 2974.65  | 65.1          | 65.1 |
| 131     | 10.08                     | 2720.305 | 75.18    | 2785.405 | 65.1          | 65.1 |
| 132     | 10.08                     | 2608.83  | 75.18    | 2673.93  | 65.1          | 65.1 |
| 133     | 10.08                     | 2497.355 | 75.18    | 2562.455 | 65.1          | 65.1 |
| 134     | 10.08                     | 2385.88  | 75.18    | 2450.98  | 65.1          | 65.1 |
| 135     | 10.08                     | 2274.405 | 75.18    | 2339.505 | 65.1          | 65.1 |
| 136     | 10.08                     | 2162.93  | 75.18    | 2228.03  | 65.1          | 65.1 |
| 137     | 10.08                     | 2051.455 | 75.18    | 2116.555 | 65.1          | 65.1 |
| 138     | 10.08                     | 1862.21  | 75.18    | 1927.31  | 65.1          | 65.1 |

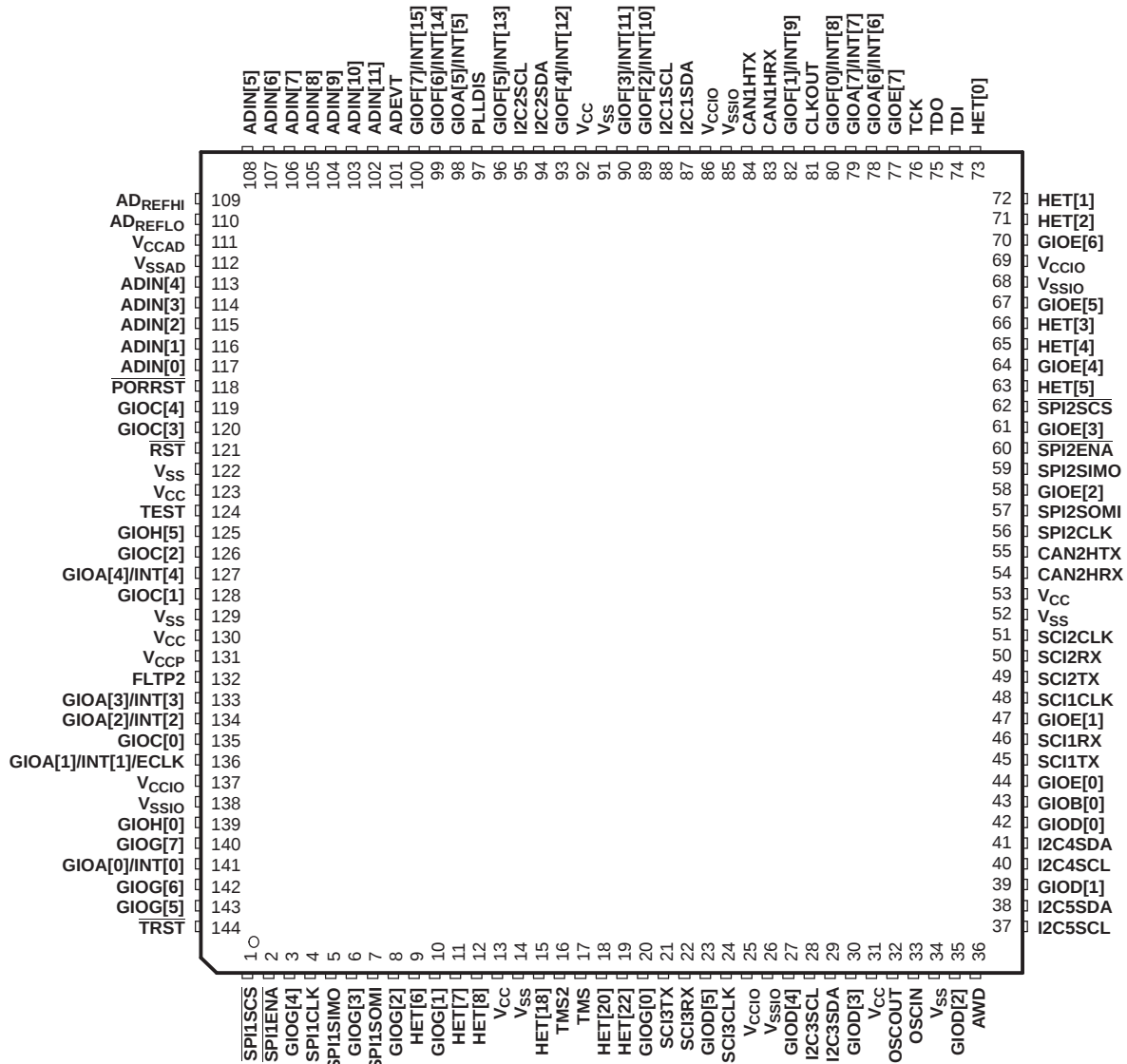
**Table 4-1. Bond Pad Coordinates (continued)**

| PAD NO. | BOND PAD COORDINATES (μm) |          |       |          | PAD SIZE (μm) |       |
|---------|---------------------------|----------|-------|----------|---------------|-------|
|         | X MIN                     | Y MIN    | X MAX | Y MAX    | X             | Y     |
| 139     | 10.08                     | 1672.965 | 75.18 | 1738.065 | 65.1          | 65.1  |
| 140     | 10.08                     | 1561.49  | 75.18 | 1626.59  | 65.1          | 65.1  |
| 141     | 10.08                     | 1372.245 | 75.18 | 1437.345 | 65.1          | 65.1  |
| 142     | 10.08                     | 1260.77  | 75.18 | 1325.87  | 65.1          | 65.1  |
| 143     | 10.08                     | 1149.295 | 75.18 | 1214.395 | 65.1          | 65.1  |
| 144     | 10.08                     | 1037.82  | 75.18 | 1102.92  | 65.1          | 65.1  |
| 145     | 10.08                     | 926.345  | 75.18 | 991.445  | 65.1          | 65.1  |
| 146     | 10.08                     | 814.87   | 75.18 | 879.97   | 65.1          | 65.1  |
| 147     | 10.08                     | 703.395  | 75.18 | 768.495  | 65.1          | 65.1  |
| 148     | 10.08                     | 514.15   | 75.18 | 579.25   | 65.1          | 65.1  |
| 149     | 10.08                     | 402.675  | 75.18 | 467.775  | 65.1          | 65.1  |
| 150     | 10.08                     | 291.2    | 75.18 | 356.3    | 65.1          | 65.1  |
| 151     | 10.08                     | 179.725  | 75.18 | 244.825  | 65.1          | 65.1  |
| 152     | 4.9                       | 5154.1   | 69.93 | 5219.13  | 65.03         | 65.03 |

## 5 Pin Configuration and Functions



**Figure 5-1. SM470R1B1M HFQ/HKP Packages, 84-Pin CQFP Ceramic Quad Flatpack (Top View)**



**Figure 5-2. SM470R1B1M-HT PGE Package, 144-Pin LQFP Plastic Low-Profile Quad Flatpack Without Expansion Bus (Top View)**

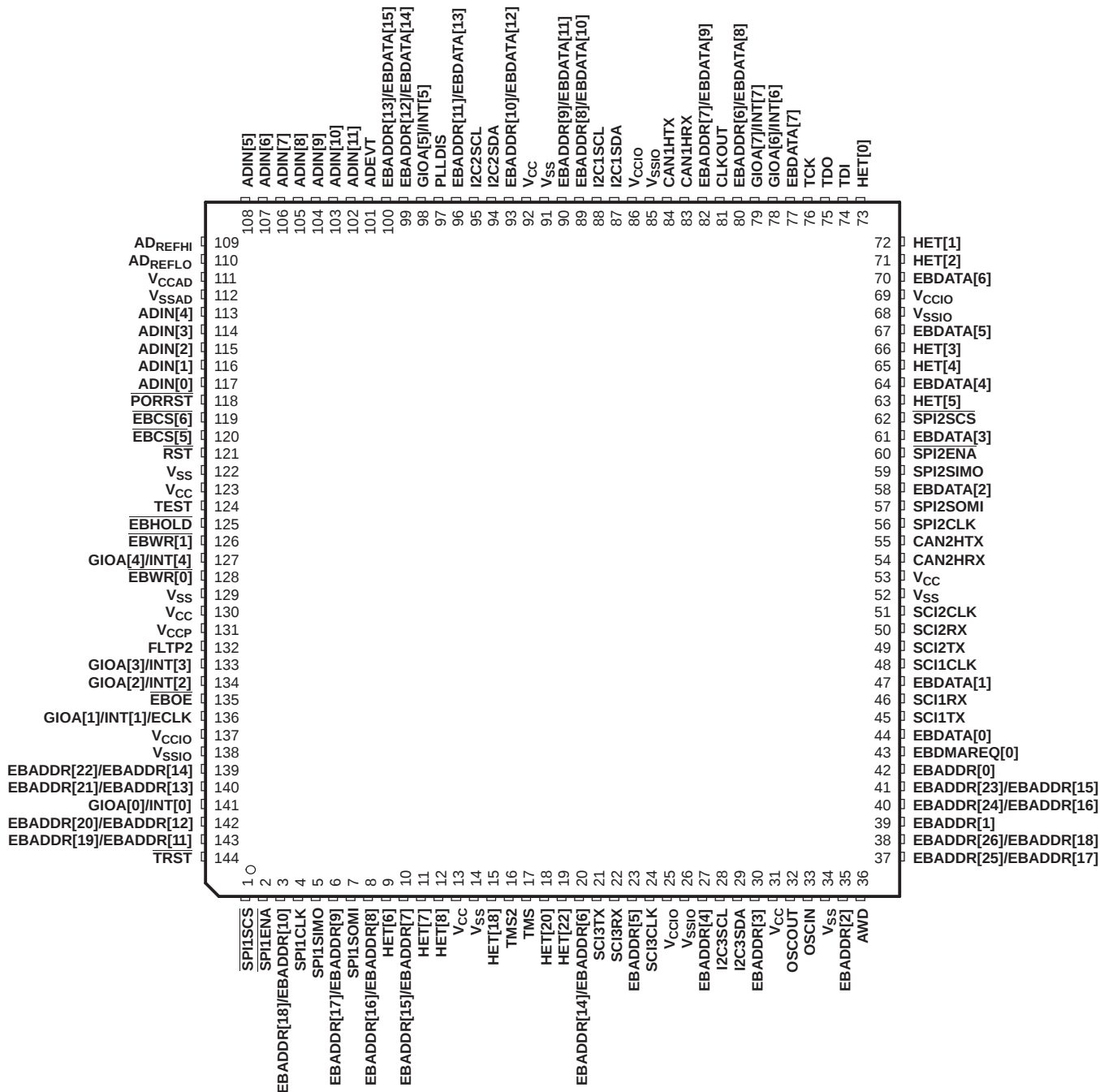


Figure 5-3. SM470R1B1M-HT PGE Package 144-Pin LQFP Plastic Low-Profile Quad Flatpack With Expansion Bus (Top View)

## 5.1 Features

The reduced pin count version of SM470R1B1M has the following features.

- Communication interfaces
  - Two SPIs
  - Two SCIs
  - Two HECC
  - Two I<sup>2</sup>C modules
- 4-channel, 10-bit MibADC

- High-end timer lite (HET) controlling seven programmable I/O channels
- Eight general-purpose I/Os

## 5.2 Pin Functions (HFQ/HKP Package)

| PIN                            |         |                         | TYPE <sup>(1) (2)</sup> | CURRENT OUTPUT | INTERNAL PULLUP/ PULLDOWN <sup>(3)</sup> | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|--------------------------------|---------|-------------------------|-------------------------|----------------|------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                           | PAD NO. | HFQ/ HKP <sup>(4)</sup> |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HIGH-END TIMER (HET)           |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[0]                         | 76      | 42                      | 3.3 V                   | 2 mA -z        | IPD (20 µA)                              | Timer input capture or output compare. The HET[8:0,18,20,22] applicable pins can be programmed as general-purpose input/output (GIO) pins. All are high-resolution pins.<br><br>The high-resolution (HR) SHARE feature allows even HR pins to share the next higher odd HR pin structures. This HR sharing is independent of whether or not the odd pin is available externally. If an odd pin is available externally and shared, then the odd pin can only be used as a general-purpose I/O. For more information on HR SHARE, see the <i>TMS470R1x High-End Timer (HET) Reference Guide</i> ( <a href="#">SPNU199</a> ). |
| HET[1]                         | 75      | NC                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[2]                         | 74      | 41                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[3]                         | 69      | 38                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[4]                         | 68      | 37                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[5]                         | 66      | 36                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[6]                         | 9       | 6                       |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[7]                         | 11      | NC                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[8]                         | 13      | 7                       |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[18]                        | 16      | NC                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[20]                        | 19      | NC                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[22]                        | 20      | NC                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HIGH-END CAN CONTROLLER (HECC) |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| CAN1HRX                        | 86      | 49                      | 5-V tolerant            | 4 mA           |                                          | HECC1 receive pin or GIO pin                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| CAN1HTX                        | 87      | 50                      | 3.3 V                   | 2 mA -z        | IPU (20 µA)                              | HECC1 transmit pin or GIO pin                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| CAN2HRX                        | 57      | 29                      | 5-V tolerant            | 4 mA           |                                          | HECC2 receive pin or GIO pin                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| CAN2HTX                        | 58      | 30                      | 3.3 V                   | 2 mA -z        | IPU (20 µA)                              | HECC2 transmit pin or GIO pin                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| GENERAL-PURPOSE I/O (GIO)      |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOA[0]/INT[0]                 | 147     | 83                      | 5-V tolerant            | 4 mA           |                                          | General-purpose input/output pins. GIOA[7:0]/INT[7:0] are interrupt-capable pins.<br><br>GIOA[1]/INT[1]/ECLK pin is multiplexed with the external clock-out function of the external clock prescale (ECP) module.                                                                                                                                                                                                                                                                                                                                                                                                           |
| GIOA[1]/INT[1]/ECLK            | 140     | 80                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOA[2]/INT[2]                 | 138     | 79                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOA[3]/INT[3]                 | 137     | 78                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOA[4]/INT[4]                 | 130     | 73                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOA[5]/INT[5]                 | 101     | 58                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOA[6]/INT[6]                 | 81      | 46                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOA[7]/INT[7]                 | 82      | 47                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOB[0]/EBDMAREQ0              | 46      | NC                      | 3.3 V                   | 2 mA -z        | IPD (20 µA)                              | GIOB[0], GIOC[4:0], GIOD[5:0], GIOE[7:0:], GIOF[7:0:], GIOG[7:0:], and GIOH[5.0] are multiplexed with the expansion bus module.<br><br>See <a href="#">Table 8-3</a> .                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| GIOC[0]/EBOE                   | 139     | NC                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOC[1]/EBWR[0]                | 131     | NC                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOC[2]/EBWR[1]                | 129     | NC                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOC[3]/EBCS[5]                | 123     | NC                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GIOC[4]/EBCS[6]                | 122     | NC                      |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |

(1) PWR = power, GND = ground, REF = reference voltage, NC = no connect

(2) All I/O pins, except  $\overline{\text{RST}}$ , are configured as inputs while  $\overline{\text{PORRST}}$  is low and immediately after  $\overline{\text{PORRST}}$  goes high.

(3) IPD = internal pulldown, IPU = internal pullup (all internal pullups and pulldowns are active on input pins, independent of the  $\overline{\text{PORRST}}$  state.)

(4) Any pins marked as NC are physically connected to ground internal to the package. Care must be used to keep these pins in a high impedance input state.

| PIN                                       |            |                            | TYPE <sup>(1)</sup> (2) | CURRENT<br>OUTPUT | INTERNAL<br>PULLUP/<br>PULLDOWN <sup>(3)</sup> | DESCRIPTION                                                                                                                                                                                                                       |
|-------------------------------------------|------------|----------------------------|-------------------------|-------------------|------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                      | PAD<br>NO. | HFQ/<br>HKP <sup>(4)</sup> |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOD[0]/EBADDR[0]                         | 45         | NC                         | 3.3 V                   | 2 mA -z           | IPD (20 µA)                                    | <p>GIOB[0], GIOC[4:0], GIOD[5:0], GIOE[7:0:], GIOF[7:0], GIOG[7:0], and GIOH[5,0] are multiplexed with the expansion bus module.</p> <p>GIOF[7:0]/INT[15:8] are interrupt-capable pins.</p> <p>See <a href="#">Table 8-3</a>.</p> |
| GIOD[1]/EBADDR[1]                         | 42         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOD[2]/EBADDR[2]                         | 38         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOD[3]/EBADDR[3]                         | 33         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOD[4]/EBADDR[4]                         | 30         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOD[5]/EBADDR[5]                         | 25         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[0]/EBDATA[0]                         | 47         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[1]/EBDATA[1]                         | 50         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[2]/EBDATA[2]                         | 61         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[3]/EBDATA[3]                         | 64         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[4]/EBDATA[4]                         | 67         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[5]/EBDATA[5]                         | 70         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[6]/EBDATA[6]                         | 73         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[7]/EBDATA[7]                         | 80         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[0]/INT[8]/<br>EBADDR[6]/EBDATA[8]    | 83         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[1]/INT[9]/<br>EBADDR[7]/EBDATA[9]    | 85         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[2]/INT[10]/<br>EBADDR[8]/EBDATA[10]  | 92         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[3]/INT[11]/<br>EBADDR[9]/EBDATA[11]  | 93         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[4]/INT[12]/<br>EBADDR[10]/EBDATA[12] | 96         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[5]/INT[13]/<br>EBADDR[11]/EBDATA[13] | 99         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[6]/INT[14]/<br>EBADDR[12]/EBDATA[14] | 102        | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[7]/INT[15]/<br>EBADDR[13]/EBDATA[15] | 103        | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[0]/EBADDR[14]/<br>EBADDR[6]          | 21         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[1]/EBADDR[15]/<br>EBADDR[7]          | 10         | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[2]/EBADDR[16]/<br>EBADDR[8]          | 8          | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[3]/EBADDR[17]/<br>EBADDR[9]          | 6          | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[4]/EBADDR[18]/<br>EBADDR[10]         | 3          | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[5]/EBADDR[19]/<br>EBADDR[11]         | 150        | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[6]/EBADDR[20]/EBADDR[12]             | 148        | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[7]/EBADDR[21]/<br>EBADDR[13]         | 145        | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOH[0]/EBADDR[22]/<br>EBADDR[14]         | 144        | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |
| GIOH[5]/EBHOLD                            | 128        | NC                         |                         |                   |                                                |                                                                                                                                                                                                                                   |

# SM470R1B1M-HT

SPNS155I – SEPTEMBER 2009 – REVISED JUNE 2015

www.ti.com

| PIN                                                 |         |                         | TYPE <sup>(1)</sup> (2) | CURRENT OUTPUT           | INTERNAL PULLUP/ PULLDOWN <sup>(3)</sup> | DESCRIPTION                                                            |
|-----------------------------------------------------|---------|-------------------------|-------------------------|--------------------------|------------------------------------------|------------------------------------------------------------------------|
| NAME                                                | PAD NO. | HFQ/ HKP <sup>(4)</sup> |                         |                          |                                          |                                                                        |
| MULTI-BUFFERED ANALOG-TO-DIGITAL CONVERTER (MibADC) |         |                         |                         |                          |                                          |                                                                        |
| ADEVT                                               | 104     | 59                      | 3.3 V                   | 2 mA -z                  | IPD (20 µA)                              | MibADC event input. Can be programmed as a GIO pin.                    |
| ADIN[0]                                             | 120     | NC                      |                         | MibADC analog input pins |                                          |                                                                        |
| ADIN[1]                                             | 119     | NC                      |                         |                          |                                          |                                                                        |
| ADIN[2]                                             | 118     | NC                      |                         |                          |                                          |                                                                        |
| ADIN[3]                                             | 117     | NC                      |                         |                          |                                          |                                                                        |
| ADIN[4]                                             | 116     | NC                      |                         |                          |                                          |                                                                        |
| ADIN[5]                                             | 111     | NC                      |                         |                          |                                          |                                                                        |
| ADIN[6]                                             | 110     | 63                      |                         |                          |                                          |                                                                        |
| ADIN[7]                                             | 109     | NC                      |                         |                          |                                          |                                                                        |
| ADIN[8]                                             | 108     | 62                      |                         |                          |                                          |                                                                        |
| ADIN[9]                                             | 107     | 61                      |                         |                          |                                          |                                                                        |
| ADIN[10]                                            | 106     | 60                      |                         |                          |                                          |                                                                        |
| ADIN[11]                                            | 105     | NC                      |                         |                          |                                          |                                                                        |
| AD <sub>REFHI</sub>                                 | 112     | 64                      | 3.3 VREF                |                          |                                          | MibADC module high-voltage reference input                             |
| AD <sub>REFLO</sub>                                 | 113     | 65                      | GND REF                 |                          |                                          | MibADC module low-voltage reference input                              |
| V <sub>CCAD</sub>                                   | 114     | 66                      | 3.3-V PWR               |                          |                                          | MibADC analog supply voltage                                           |
| V <sub>SSAD</sub>                                   | 115     | 67                      | GND                     |                          |                                          | MibADC analog ground reference                                         |
| SERIAL PERIPHERAL INTERFACE 1 (SPI1)                |         |                         |                         |                          |                                          |                                                                        |
| SPI1CLK                                             | 4       | 3                       | 5-V tolerant            | 4 mA                     |                                          | SPI1 clock. SPI1CLK can be programmed as a GIO pin.                    |
| $\overline{\text{SPI1ENA}}$                         | 2       | 2                       |                         |                          |                                          | SPI1 chip enable. Can be programmed as a GIO pin.                      |
| $\overline{\text{SPI1SCS}}$                         | 1       | 1                       |                         |                          |                                          | SPI1 slave chip select. Can be programmed as a GIO pin.                |
| SPI1SIMO                                            | 5       | 4                       |                         |                          |                                          | SPI1 data stream. Slave in/master out. Can be programmed as a GIO pin. |
| SPI1SOMI                                            | 7       | 5                       |                         |                          |                                          | SPI1 data stream. Slave out/master in. Can be programmed as a GIO pin. |
| SERIAL PERIPHERAL INTERFACE 2 (SPI2)                |         |                         |                         |                          |                                          |                                                                        |
| SPI2CLK                                             | 59      | 31                      | 5-V tolerant            | 4 mA                     |                                          | SPI2 clock. Can be programmed as a GIO pin.                            |
| $\overline{\text{SPI2ENA}}$                         | 63      | 34                      |                         |                          |                                          | SPI2 chip enable. Can be programmed as a GIO pin.                      |
| $\overline{\text{SPI2SCS}}$                         | 65      | 35                      |                         |                          |                                          | SPI2 slave chip select. Can be programmed as a GIO pin.                |
| SPI2SIMO                                            | 62      | 33                      |                         |                          |                                          | SPI2 data stream. Slave in/master out. Can be programmed as a GIO pin. |
| SPI2SOMI                                            | 60      | 32                      |                         |                          |                                          | SPI2 data stream. Slave out/master in. Can be programmed as a GIO pin. |
| INTER-INTEGRATED CIRCUIT 1 (I2C1)                   |         |                         |                         |                          |                                          |                                                                        |
| I2C1SDA                                             | 90      | NC                      | 5-V tolerant            | 4 mA                     |                                          | I2C1 serial data pin or GIO pin                                        |
| I2C1SCL                                             | 91      | NC                      |                         |                          |                                          | I2C1 serial clock pin or GIO pin                                       |

| PIN                                      |         |                         | TYPE <sup>(1) (2)</sup> | CURRENT OUTPUT | INTERNAL PULLUP/ PULLDOWN <sup>(3)</sup> | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                       |
|------------------------------------------|---------|-------------------------|-------------------------|----------------|------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                     | PAD NO. | HFQ/ HKP <sup>(4)</sup> |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| INTER-INTEGRATED CIRCUIT 2 (I2C2)        |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| I2C2SDA                                  | 97      | 55                      | 5-V tolerant            | 4 mA           |                                          | I2C2 serial data pin or GIO pin                                                                                                                                                                                                                                                                                                                                   |
| I2C2SCL                                  | 98      | 56                      |                         |                |                                          | I2C2 serial clock pin or GIO pin                                                                                                                                                                                                                                                                                                                                  |
| INTER-INTEGRATED CIRCUIT 3 (I2C3)        |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| I2C3SDA                                  | 32      | NC                      | 5-V tolerant            | 4 mA           |                                          | I2C3 serial data pin or GIO pin                                                                                                                                                                                                                                                                                                                                   |
| I2C3SCL                                  | 31      | NC                      |                         |                |                                          | I2C3 serial clock pin or GIO pin                                                                                                                                                                                                                                                                                                                                  |
| INTER-INTEGRATED CIRCUIT 4 (I2C4)        |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| I2C4SDA                                  | 44      | 23                      | 5-V tolerant            | 4 mA           |                                          | I2C4 serial data pin or GIO pin                                                                                                                                                                                                                                                                                                                                   |
| I2C4SCL                                  | 43      | 22                      |                         |                |                                          | I2C4 serial clock pin or GIO pin                                                                                                                                                                                                                                                                                                                                  |
| INTER-INTEGRATED CIRCUIT 5 (I2C5)        |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| I2C5SDA                                  | 41      | NC                      | 5-V tolerant            | 4 mA           |                                          | I2C5 serial data pin or GIO pin                                                                                                                                                                                                                                                                                                                                   |
| I2C5SCL                                  | 40      | NC                      |                         |                |                                          | I2C5 serial clock pin or GIO pin                                                                                                                                                                                                                                                                                                                                  |
| ZERO-PIN PHASE-LOCKED LOOP (ZPLL)        |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| OSCIN                                    | 36      | 19                      | 1.8 V                   |                |                                          | Crystal connection pin or external clock input                                                                                                                                                                                                                                                                                                                    |
| OSCOUT                                   | 35      | 18                      |                         | 2 mA           |                                          | External crystal connection pin                                                                                                                                                                                                                                                                                                                                   |
| PLLDIS                                   | 100     | 57                      | 3.3 V                   |                | IPD (20 μA)                              | Enable/disable the ZPLL. The ZPLL can be bypassed and the oscillator becomes the system clock. If not in bypass mode, TI recommends that this pin be connected to ground or pulled down to ground by an external resistor.                                                                                                                                        |
| SERIAL COMMUNICATIONS INTERFACE 1 (SCI1) |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| SCI1CLK                                  | 51      | 26                      | 3.3 V                   | 2 mA -z        | IPD (20 μA)                              | SCI1 clock. SCI1CLK can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                               |
| SCI1RX                                   | 49      | 25                      | 5-V tolerant            | 4 mA           |                                          | SCI1 data receive. SCI1RX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                         |
| SCI1TX                                   | 48      | 24                      | 3.3 V                   | 2 mA -z        | IPU (20 μA)                              | SCI1 data transmit. SCI1TX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                        |
| SERIAL COMMUNICATIONS INTERFACE 2 (SCI2) |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| SCI2CLK                                  | 54      | NC                      | 3.3 V                   | 2 mA -z        | IPD (20 μA)                              | SCI2 clock. SCI2CLK can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                               |
| SCI2RX                                   | 53      | NC                      | 5-V tolerant            | 4 mA           |                                          | SCI2 data receive. SCI2RX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                         |
| SCI2TX                                   | 52      | NC                      | 3.3 V                   | 2 mA -z        | IPU (20 μA)                              | SCI2 data transmit. SCI2TX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                        |
| SERIAL COMMUNICATIONS INTERFACE 3 (SCI3) |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| SCI3CLK                                  | 27      | 14                      | 3.3 V                   | 2 mA -z        | IPD (20 μA)                              | SCI3 clock. SCI3CLK can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                               |
| SCI3RX                                   | 24      | 13                      | 5-V tolerant            | 4 mA           |                                          | SCI3 data receive. SCI3RX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                         |
| SCI3TX                                   | 23      | 12                      | 3.3 V                   | 2 mA -z        | IPU (20 μA)                              | SCI3 data transmit. SCI3TX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                        |
| SYSTEM MODULE (SYS)                      |         |                         |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| CLKOUT                                   | 84      | 48                      | 3.3 V                   | 8 mA           |                                          | Bidirectional pin. CLKOUT can be programmed as a GIO pin or the output of SYSCLK, ICLK, or MCLK.                                                                                                                                                                                                                                                                  |
| $\overline{\text{PORRST}}$               | 121     | 68                      | 3.3 V                   |                | IPD (20 μA)                              | Input master chip power-up reset. External V <sub>CC</sub> monitor circuitry must assert a power-on reset.                                                                                                                                                                                                                                                        |
| $\overline{\text{RST}}$                  | 124     | 69                      | 3.3 V                   | 4 mA           | IPU (20 μA)                              | <p>Bidirectional reset. The internal circuitry can assert a reset, and an external system reset can assert a device reset.</p> <p>On this pin, the output buffer is implemented as an open drain (drives low only).</p> <p>To ensure an external reset is not arbitrarily generated, TI recommends that an external pullup resistor be connected to this pin.</p> |

**SM470R1B1M-HT**

SPNS155I – SEPTEMBER 2009 – REVISED JUNE 2015

[www.ti.com](http://www.ti.com)

| PIN                                   |            |                            | TYPE <sup>(1)</sup> <sup>(2)</sup> | CURRENT<br>OUTPUT | INTERNAL<br>PULLUP/<br>PULLDOWN <sup>(3)</sup> | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|---------------------------------------|------------|----------------------------|------------------------------------|-------------------|------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                  | PAD<br>NO. | HFQ/<br>HKP <sup>(4)</sup> |                                    |                   |                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| WATCHDOG/REAL-TIME INTERRUPT (WD/RTI) |            |                            |                                    |                   |                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| AWD                                   | 39         | 21                         | 3.3 V                              | 8 mA              |                                                | Analog watchdog reset. The AWD pin provides a system reset if the WD KEY is not written in time by the system, providing an external RC network circuit is connected. If the user is not using AWD, TI recommends that this pin be connected to ground or pulled down to ground by an external resistor.<br><br>For more details on the external RC network circuit, see the <i>TMS470R1x System Module Reference Guide</i> ( <a href="#">SPNU189</a> ). |
| TEST/DEBUG (T/D)                      |            |                            |                                    |                   |                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| TCK                                   | 79         | 45                         | 3.3 V                              |                   | IPD (20 μA)                                    | Test clock. TCK controls the test hardware (JTAG).                                                                                                                                                                                                                                                                                                                                                                                                       |
| TDI                                   | 77         | 43                         |                                    | 8 mA              | IPU (20 μA)                                    | Test data in. TDI inputs serial data to the test instruction register, test data register, and programmable test address (JTAG).                                                                                                                                                                                                                                                                                                                         |
| TDO                                   | 78         | 44                         |                                    | 8 mA              | IPD (20 μA)                                    | Test data out. TDO outputs serial data from the test instruction register, test data register, identification register, and programmable test address (JTAG).                                                                                                                                                                                                                                                                                            |
| TEST                                  | 127        | 72                         | 3.3 V                              |                   | IPD (20 μA)                                    | Test enable. Reserved for internal use only. TI recommends that this pin be connected to ground or pulled down to ground by an external resistor.                                                                                                                                                                                                                                                                                                        |
| TMS                                   | 18         | 11                         |                                    | 8 mA              | IPU (20 μA)                                    | Serial input for controlling the state of the CPU test access port (TAP) controller (JTAG).                                                                                                                                                                                                                                                                                                                                                              |
| TMS2                                  | 17         | 10                         |                                    | 8 mA              | IPU (20 μA)                                    | Serial input for controlling the second TAP. TI recommends that this pin be connected to V <sub>CCIO</sub> or pulled up to V <sub>CCIO</sub> by an external resistor.                                                                                                                                                                                                                                                                                    |
| $\overline{\text{TRST}}$              | 151        | 84                         |                                    |                   | IPD (20 μA)                                    | Test hardware reset to TAP1 and TAP2. IEEE Standard 1149-1 (JTAG) Boundary-Scan Logic. TI recommends that this pin be pulled down to ground by an external resistor.                                                                                                                                                                                                                                                                                     |
| FLASH                                 |            |                            |                                    |                   |                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| FLTP2                                 | 135        | 77                         | NC                                 | NC                |                                                | Flash test pad 2. <b>For proper operation, this pin must not be connected [no connect (NC)].</b>                                                                                                                                                                                                                                                                                                                                                         |
| V <sub>CCP</sub>                      | 134        | 76                         | 3.3-V PWR                          |                   |                                                | Flash external pump voltage (3.3 V)                                                                                                                                                                                                                                                                                                                                                                                                                      |
| SUPPLY VOLTAGE CORE (1.8 V)           |            |                            |                                    |                   |                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| V <sub>CC</sub>                       | 14         | 8                          | 1.8-V PWR                          |                   |                                                | Core logic supply voltage                                                                                                                                                                                                                                                                                                                                                                                                                                |
|                                       | 34         | 17                         |                                    |                   |                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|                                       | 56         | 28                         |                                    |                   |                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|                                       | 95         | 54                         |                                    |                   |                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|                                       | 126        | 71                         |                                    |                   |                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|                                       | 133        | 75                         |                                    |                   |                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                          |

| PIN                                |         |                         | TYPE <sup>(1) (2)</sup> | CURRENT OUTPUT | INTERNAL PULLUP/ PULLDOWN <sup>(3)</sup> | DESCRIPTION                         |
|------------------------------------|---------|-------------------------|-------------------------|----------------|------------------------------------------|-------------------------------------|
| NAME                               | PAD NO. | HFQ/ HKP <sup>(4)</sup> |                         |                |                                          |                                     |
| SUPPLY VOLTAGE DIGITAL I/O (3.3 V) |         |                         |                         |                |                                          |                                     |
| V <sub>CCIO</sub>                  | 28      | 15                      | 3.3-V PWR               |                |                                          | Digital I/O supply voltage          |
|                                    | 72      | 40                      |                         |                |                                          |                                     |
|                                    | 89      | 52                      |                         |                |                                          |                                     |
|                                    | 141     | 81                      |                         |                |                                          |                                     |
| SUPPLY GROUND CORE                 |         |                         |                         |                |                                          |                                     |
| V <sub>SS</sub>                    | 15      | 9                       | GND                     |                |                                          | Core supply ground reference        |
|                                    | 37      | 20                      |                         |                |                                          |                                     |
|                                    | 55      | 27                      |                         |                |                                          |                                     |
|                                    | 94      | 53                      |                         |                |                                          |                                     |
|                                    | 125     | 70                      |                         |                |                                          |                                     |
|                                    | 132     | 74                      |                         |                |                                          |                                     |
| SUPPLY GROUND DIGITAL I/O          |         |                         |                         |                |                                          |                                     |
| V <sub>SSIO</sub>                  | 29      | 16                      | GND                     |                |                                          | Digital I/O supply ground reference |
|                                    | 71      | 39                      |                         |                |                                          |                                     |
|                                    | 88      | 51                      |                         |                |                                          |                                     |
|                                    | 142     | 82                      |                         |                |                                          |                                     |

### 5.3 Pin Functions (PGE Package)

| PIN                            |     | TYPE <sup>(1) (2)</sup> | CURRENT OUTPUT | INTERNAL PULLUP/ PULLDOWN <sup>(3)</sup> | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|--------------------------------|-----|-------------------------|----------------|------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                           | NO. |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HIGH-END TIMER (HET)           |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[0]                         | 73  | 3.3 V                   | 2 mA -z        | IPD (20 μA)                              | Timer input capture or output compare. The HET[8:0,18,20,22] applicable pins can be programmed as general-purpose input/output (GIO) pins. All are high-resolution pins.<br><br>The high-resolution (HR) SHARE feature allows even HR pins to share the next higher odd HR pin structures. This HR sharing is independent of whether or not the odd pin is available externally. If an odd pin is available externally and shared, then the odd pin can only be used as a general-purpose I/O. For more information on HR SHARE, see the <i>TMS470R1x High-End Timer (HET) Reference Guide</i> ( <a href="#">SPNU199</a> ). |
| HET[1]                         | 72  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[2]                         | 71  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[3]                         | 66  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[4]                         | 65  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[5]                         | 63  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[6]                         | 9   |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[7]                         | 11  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[8]                         | 12  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[18]                        | 15  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[20]                        | 18  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HET[22]                        | 19  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| HIGH-END CAN CONTROLLER (HECC) |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| CAN1HRX                        | 83  | 5-V tolerant            | 4 mA           |                                          | HECC1 receive pin or GIO pin                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| CAN1HTX                        | 84  | 3.3 V                   | 2 mA -z        | IPU (20 μA)                              | HECC1 transmit pin or GIO pin                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| CAN2HRX                        | 54  | 5-V tolerant            | 4 mA           |                                          | HECC2 receive pin or GIO pin                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| CAN2HTX                        | 55  | 3.3 V                   | 2 mA -z        | IPU (20 μA)                              | HECC2 transmit pin or GIO pin                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| STANDARD CAN CONTROLLER (SCC)  |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| CANSRX                         | -   | 5-V tolerant            | 4 mA           |                                          | SCC receive pin. The CANSRX signal is only connected to the pad and not to a package pin. <b>For reduced power consumption in low power mode, CANSRX should be driven output LOW.</b>                                                                                                                                                                                                                                                                                                                                                                                                                                       |

(1) PWR = power, GND = ground, REF = reference voltage, NC = no connect

(2) All I/O pins, except RST, are configured as inputs while PORRST is low and immediately after PORRST goes high.

(3) IPD = internal pulldown, IPU = internal pullup (all internal pullups and pulldowns are active on input pins, independent of the PORRST state.)

| PIN                                  |     | TYPE <sup>(1)</sup> <sup>(2)</sup> | CURRENT<br>OUTPUT | INTERNAL<br>PULLUP/<br>PULLDOWN <sup>(3)</sup> | DESCRIPTION                                                                                                                                                                                                       |
|--------------------------------------|-----|------------------------------------|-------------------|------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                 | NO. |                                    |                   |                                                |                                                                                                                                                                                                                   |
| CANSTX                               | -   | 3.3 V                              | 2 mA -z           | IPU (20 µA)                                    | SCC transmit pin. The CANSTX signal is only connected to the pad and not to a package pin. <b>For reduced power consumption in low power mode, CANSTX should be driven output LOW.</b>                            |
| <b>GENERAL-PURPOSE I/O (GIO)</b>     |     |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOA[0]/INT[0]                       | 141 | 5-V tolerant                       | 4 mA              |                                                | General-purpose input/output pins. GIOA[7:0]/INT[7:0] are interrupt-capable pins.<br><br>GIOA[1]/INT[1]/ECLK pin is multiplexed with the external clock-out function of the external clock prescale (ECP) module. |
| GIOA[1]/INT[1]/ECLK                  | 136 |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOA[2]/INT[2]                       | 134 |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOA[3]/INT[3]                       | 133 |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOA[4]/INT[4]                       | 127 |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOA[5]/INT[5]                       | 98  |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOA[6]/INT[6]                       | 78  |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOA[7]/INT[7]                       | 79  |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOB[0]/EBDMAREQ0                    | 43  | 3.3 V                              | 2 mA -z           | IPD (20 µA)                                    | GIOB[0], GIOC[4:0], GIOD[5:0], GIOE[7:0], GIOF[7:0], GIOG[7:0], and GIOH[5:0] are multiplexed with the expansion bus module.<br><br>See <a href="#">Table 8-3</a> .                                               |
| GIOC[0]/ $\overline{\text{EBOE}}$    | 135 |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOC[1]/ $\overline{\text{EBWR}}[0]$ | 128 |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOC[2]/ $\overline{\text{EBWR}}[1]$ | 126 |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOC[3]/ $\overline{\text{EBCS}}[5]$ | 120 |                                    |                   |                                                |                                                                                                                                                                                                                   |
| GIOC[4]/ $\overline{\text{EBCS}}[6]$ | 119 |                                    |                   |                                                |                                                                                                                                                                                                                   |

| PIN                                       |     | TYPE <sup>(1)</sup> <sup>(2)</sup> | CURRENT<br>OUTPUT | INTERNAL<br>PULLUP/<br>PULLDOWN <sup>(3)</sup> | DESCRIPTION                                                                                                                                                                                                                       |
|-------------------------------------------|-----|------------------------------------|-------------------|------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                      | NO. |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOD[0]/EBADDR[0]                         | 42  | 3.3 V                              | 2 mA -z           | IPD (20 µA)                                    | <p>GIOB[0], GIOC[4:0], GIOD[5:0], GIOE[7:0:], GIOF[7:0], GIOG[7:0], and GIOH[5,0] are multiplexed with the expansion bus module.</p> <p>GIOF[7:0]/INT[15:8] are interrupt-capable pins.</p> <p>See <a href="#">Table 8-3</a>.</p> |
| GIOD[1]/EBADDR[1]                         | 39  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOD[2]/EBADDR[2]                         | 35  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOD[3]/EBADDR[3]                         | 30  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOD[4]/EBADDR[4]                         | 27  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOD[5]/EBADDR[5]                         | 23  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[0]/EBDATA[0]                         | 44  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[1]/EBDATA[1]                         | 47  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[2]/EBDATA[2]                         | 58  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[3]/EBDATA[3]                         | 61  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[4]/EBDATA[4]                         | 64  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[5]/EBDATA[5]                         | 67  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[6]/EBDATA[6]                         | 70  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOE[7]/EBDATA[7]                         | 77  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[0]/INT[8]/<br>EBADDR[6]/EBDATA[8]    | 80  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[1]/INT[9]/<br>EBADDR[7]/EBDATA[9]    | 82  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[2]/INT[10]/<br>EBADDR[8]/EBDATA[10]  | 89  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[3]/INT[11]/<br>EBADDR[9]/EBDATA[11]  | 90  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[4]/INT[12]/<br>EBADDR[10]/EBDATA[12] | 93  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[5]/INT[13]/<br>EBADDR[11]/EBDATA[13] | 96  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[6]/INT[14]/<br>EBADDR[12]/EBDATA[14] | 99  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOF[7]/INT[15]/<br>EBADDR[13]/EBDATA[15] | 100 |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[0]/EBADDR[14]/<br>EBADDR[6]          | 20  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[1]/EBADDR[15]/<br>EBADDR[7]          | 10  |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[2]/EBADDR[16]/<br>EBADDR[8]          | 8   |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[3]/EBADDR[17]/<br>EBADDR[9]          | 6   |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[4]/EBADDR[18]/<br>EBADDR[10]         | 3   |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[5]/EBADDR[19]/<br>EBADDR[11]         | 143 |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[6]/EBADDR[20]/EB<br>ADDR[12]         | 142 |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOG[7]/EBADDR[21]/<br>EBADDR[13]         | 140 |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOH[0]/EBADDR[22]/<br>EBADDR[14]         | 139 |                                    |                   |                                                |                                                                                                                                                                                                                                   |
| GIOH[5]/EBHOLD                            | 125 |                                    |                   |                                                |                                                                                                                                                                                                                                   |

| PIN                                                 |     | TYPE <sup>(1)</sup> (2) | CURRENT<br>OUTPUT        | INTERNAL<br>PULLUP/<br>PULLDOWN <sup>(3)</sup> | DESCRIPTION                                                            |
|-----------------------------------------------------|-----|-------------------------|--------------------------|------------------------------------------------|------------------------------------------------------------------------|
| NAME                                                | NO. |                         |                          |                                                |                                                                        |
| MULTI-BUFFERED ANALOG-TO-DIGITAL CONVERTER (MibADC) |     |                         |                          |                                                |                                                                        |
| ADEVT                                               | 101 | 3.3 V                   | 2 mA -z                  | IPD (20 μA)                                    | MibADC event input. Can be programmed as a GIO pin.                    |
| ADIN[0]                                             | 117 |                         | MibADC analog input pins |                                                |                                                                        |
| ADIN[1]                                             | 116 |                         |                          |                                                |                                                                        |
| ADIN[2]                                             | 115 |                         |                          |                                                |                                                                        |
| ADIN[3]                                             | 114 |                         |                          |                                                |                                                                        |
| ADIN[4]                                             | 113 |                         |                          |                                                |                                                                        |
| ADIN[5]                                             | 108 |                         |                          |                                                |                                                                        |
| ADIN[6]                                             | 107 |                         |                          |                                                |                                                                        |
| ADIN[7]                                             | 106 |                         |                          |                                                |                                                                        |
| ADIN[8]                                             | 105 |                         |                          |                                                |                                                                        |
| ADIN[9]                                             | 104 |                         |                          |                                                |                                                                        |
| ADIN[10]                                            | 103 |                         |                          |                                                |                                                                        |
| ADIN[11]                                            | 102 |                         |                          |                                                |                                                                        |
| AD <sub>REFHI</sub>                                 | 109 | 3.3 VREF                |                          |                                                | MibADC module high-voltage reference input                             |
| AD <sub>REFLO</sub>                                 | 110 | GND REF                 |                          |                                                | MibADC module low-voltage reference input                              |
| V <sub>CCAD</sub>                                   | 111 | 3.3-V PWR               |                          |                                                | MibADC analog supply voltage                                           |
| V <sub>SSAD</sub>                                   | 112 | GND                     |                          |                                                | MibADC analog ground reference                                         |
| SERIAL PERIPHERAL INTERFACE 1 (SPI1)                |     |                         |                          |                                                |                                                                        |
| SPI1CLK                                             | 4   | 5-V tolerant            | 4 mA                     |                                                | SPI1 clock. SPI1CLK can be programmed as a GIO pin.                    |
| SPI1ENA                                             | 2   |                         |                          |                                                | SPI1 chip enable. Can be programmed as a GIO pin.                      |
| SPI1SCS                                             | 1   |                         |                          |                                                | SPI1 slave chip select. Can be programmed as a GIO pin.                |
| SPI1SIMO                                            | 5   |                         |                          |                                                | SPI1 data stream. Slave in/master out. Can be programmed as a GIO pin. |
| SPI1SOMI                                            | 7   |                         |                          |                                                | SPI1 data stream. Slave out/master in. Can be programmed as a GIO pin. |
| SERIAL PERIPHERAL INTERFACE 2 (SPI2)                |     |                         |                          |                                                |                                                                        |
| SPI2CLK                                             | 56  | 5-V tolerant            | 4 mA                     |                                                | SPI2 clock. Can be programmed as a GIO pin.                            |
| SPI2ENA                                             | 60  |                         |                          |                                                | SPI2 chip enable. Can be programmed as a GIO pin.                      |
| SPI2SCS                                             | 62  |                         |                          |                                                | SPI2 slave chip select. Can be programmed as a GIO pin.                |
| SPI2SIMO                                            | 59  |                         |                          |                                                | SPI2 data stream. Slave in/master out. Can be programmed as a GIO pin. |
| SPI2SOMI                                            | 57  |                         |                          |                                                | SPI2 data stream. Slave out/master in. Can be programmed as a GIO pin. |
| INTER-INTEGRATED CIRCUIT 1 (I2C1)                   |     |                         |                          |                                                |                                                                        |
| I2C1SDA                                             | 87  | 5-V tolerant            | 4 mA                     |                                                | I2C1 serial data pin or GIO pin                                        |
| I2C1SCL                                             | 88  |                         |                          |                                                | I2C1 serial clock pin or GIO pin                                       |
| INTER-INTEGRATED CIRCUIT 2 (I2C2)                   |     |                         |                          |                                                |                                                                        |
| I2C2SDA                                             | 94  | 5-V tolerant            | 4 mA                     |                                                | I2C2 serial data pin or GIO pin                                        |
| I2C2SCL                                             | 95  |                         |                          |                                                | I2C2 serial clock pin or GIO pin                                       |

| PIN                                      |     | TYPE <sup>(1)</sup> (2) | CURRENT OUTPUT | INTERNAL PULLUP/ PULLDOWN <sup>(3)</sup> | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                       |
|------------------------------------------|-----|-------------------------|----------------|------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                     | NO. |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| INTER-INTEGRATED CIRCUIT 3 (I2C3)        |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| I2C3SDA                                  | 29  | 5-V tolerant            | 4 mA           |                                          | I2C3 serial data pin or GIO pin                                                                                                                                                                                                                                                                                                                                   |
| I2C3SCL                                  | 28  |                         |                |                                          | I2C3 serial clock pin or GIO pin                                                                                                                                                                                                                                                                                                                                  |
| INTER-INTEGRATED CIRCUIT 4 (I2C4)        |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| I2C4SDA                                  | 41  | 5-V tolerant            | 4 mA           |                                          | I2C4 serial data pin or GIO pin                                                                                                                                                                                                                                                                                                                                   |
| I2C4SCL                                  | 40  |                         |                |                                          | I2C4 serial clock pin or GIO pin                                                                                                                                                                                                                                                                                                                                  |
| INTER-INTEGRATED CIRCUIT 5 (I2C5)        |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| I2C5SDA                                  | 38  | 5-V tolerant            | 4 mA           |                                          | I2C5 serial data pin or GIO pin                                                                                                                                                                                                                                                                                                                                   |
| I2C5SCL                                  | 37  |                         |                |                                          | I2C5 serial clock pin or GIO pin                                                                                                                                                                                                                                                                                                                                  |
| ZERO-PIN PHASE-LOCKED LOOP (ZPLL)        |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| OSCIN                                    | 33  | 1.8 V                   |                |                                          | Crystal connection pin or external clock input                                                                                                                                                                                                                                                                                                                    |
| OSCOUT                                   | 32  |                         | 2 mA           |                                          | External crystal connection pin                                                                                                                                                                                                                                                                                                                                   |
| PLLDIS                                   | 97  | 3.3 V                   |                | IPD (20 μA)                              | Enable/disable the ZPLL. The ZPLL can be bypassed and the oscillator becomes the system clock. If not in bypass mode, TI recommends that this pin be connected to ground or pulled down to ground by an external resistor.                                                                                                                                        |
| SERIAL COMMUNICATIONS INTERFACE 1 (SCI1) |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| SCI1CLK                                  | 48  | 3.3 V                   | 2 mA -z        | IPD (20 μA)                              | SCI1 clock. SCI1CLK can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                               |
| SCI1RX                                   | 46  | 5-V tolerant            | 4 mA           |                                          | SCI1 data receive. SCI1RX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                         |
| SCI1TX                                   | 45  | 3.3 V                   | 2 mA -z        | IPU (20 μA)                              | SCI1 data transmit. SCI1TX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                        |
| SERIAL COMMUNICATIONS INTERFACE 2 (SCI2) |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| SCI2CLK                                  | 51  | 3.3 V                   | 2 mA -z        | IPD (20 μA)                              | SCI2 clock. SCI2CLK can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                               |
| SCI2RX                                   | 50  | 5-V tolerant            | 4 mA           |                                          | SCI2 data receive. SCI2RX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                         |
| SCI2TX                                   | 49  | 3.3 V                   | 2 mA -z        | IPU (20 μA)                              | SCI2 data transmit. SCI2TX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                        |
| SERIAL COMMUNICATIONS INTERFACE 3 (SCI3) |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| SCI3CLK                                  | 24  | 3.3 V                   | 2 mA -z        | IPD (20 μA)                              | SCI3 clock. SCI3CLK can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                               |
| SCI3RX                                   | 22  | 5-V tolerant            | 4 mA           |                                          | SCI3 data receive. SCI3RX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                         |
| SCI3TX                                   | 21  | 3.3 V                   | 2 mA -z        | IPU (20 μA)                              | SCI3 data transmit. SCI3TX can be programmed as a GIO pin.                                                                                                                                                                                                                                                                                                        |
| SYSTEM MODULE (SYS)                      |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                   |
| CLKOUT                                   | 81  | 3.3 V                   | 8 mA           |                                          | Bidirectional pin. CLKOUT can be programmed as a GIO pin or the output of SYSCLK, ICLK, or MCLK.                                                                                                                                                                                                                                                                  |
| $\overline{\text{PORRST}}$               | 118 | 3.3 V                   |                | IPD (20 μA)                              | Input master chip power-up reset. External V <sub>CC</sub> monitor circuitry must assert a power-on reset.                                                                                                                                                                                                                                                        |
| $\overline{\text{RST}}$                  | 121 | 3.3 V                   | 4 mA           | IPU (20 μA)                              | <p>Bidirectional reset. The internal circuitry can assert a reset, and an external system reset can assert a device reset.</p> <p>On this pin, the output buffer is implemented as an open drain (drives low only).</p> <p>To ensure an external reset is not arbitrarily generated, TI recommends that an external pullup resistor be connected to this pin.</p> |

| PIN                                   |     | TYPE <sup>(1) (2)</sup> | CURRENT OUTPUT | INTERNAL PULLUP/ PULLDOWN <sup>(3)</sup> | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                             |
|---------------------------------------|-----|-------------------------|----------------|------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                  | NO. |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| WATCHDOG/REAL-TIME INTERRUPT (WD/RTI) |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| AWD                                   | 36  | 3.3 V                   | 8 mA           |                                          | Analog watchdog reset. The AWD pin provides a system reset if the WD KEY is not written in time by the system, providing an external RC network circuit is connected. If the user is not using AWD, TI recommends that this pin be connected to ground or pulled down to ground by an external resistor.<br><br>For more details on the external RC network circuit, see the <i>TMS470R1x System Module Reference Guide (SPNU189)</i> . |
| TEST/DEBUG (T/D)                      |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| TCK                                   | 76  | 3.3 V                   |                | IPD (20 μA)                              | Test clock. TCK controls the test hardware (JTAG).                                                                                                                                                                                                                                                                                                                                                                                      |
| TDI                                   | 74  |                         | 8 mA           | IPU (20 μA)                              | Test data in. TDI inputs serial data to the test instruction register, test data register, and programmable test address (JTAG).                                                                                                                                                                                                                                                                                                        |
| TDO                                   | 75  |                         | 8 mA           | IPD (20 μA)                              | Test data out. TDO outputs serial data from the test instruction register, test data register, identification register, and programmable test address (JTAG).                                                                                                                                                                                                                                                                           |
| TEST                                  | 124 | 3.3 V                   |                | IPD (20 μA)                              | Test enable. Reserved for internal use only. TI recommends that this pin be connected to ground or pulled down to ground by an external resistor.                                                                                                                                                                                                                                                                                       |
| TMS                                   | 17  |                         | 8 mA           | IPU (20 μA)                              | Serial input for controlling the state of the CPU test access port (TAP) controller (JTAG).                                                                                                                                                                                                                                                                                                                                             |
| TMS2                                  | 16  |                         | 8 mA           | IPU (20 μA)                              | Serial input for controlling the second TAP. TI recommends that this pin be connected to V <sub>CCIO</sub> or pulled up to V <sub>CCIO</sub> by an external resistor.                                                                                                                                                                                                                                                                   |
| $\overline{\text{TRST}}$              | 144 |                         |                | IPD (20 μA)                              | Test hardware reset to TAP1 and TAP2. IEEE Standard 1149-1 (JTAG) Boundary-Scan Logic. TI recommends that this pin be pulled down to ground by an external resistor.                                                                                                                                                                                                                                                                    |
| FLASH                                 |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| FLTP2                                 | 132 | NC                      | NC             |                                          | Flash test pad 2. <b>For proper operation, this pin must not be connected [no connect (NC)].</b>                                                                                                                                                                                                                                                                                                                                        |
| V <sub>CCP</sub>                      | 131 | 3.3-V PWR               |                |                                          | Flash external pump voltage (3.3 V)                                                                                                                                                                                                                                                                                                                                                                                                     |
| SUPPLY VOLTAGE CORE (1.8 V)           |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| V <sub>CC</sub>                       | 13  | 1.8-V PWR               |                |                                          | Core logic supply voltage                                                                                                                                                                                                                                                                                                                                                                                                               |
|                                       | 31  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                       | 53  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                       | 92  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                       | 123 |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                       | 130 |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| SUPPLY VOLTAGE DIGITAL I/O (3.3 V)    |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| V <sub>CCIO</sub>                     | 25  | 3.3-V PWR               |                |                                          | Digital I/O supply voltage                                                                                                                                                                                                                                                                                                                                                                                                              |
|                                       | 69  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                       | 86  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                       | 137 |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| SUPPLY GROUND CORE                    |     |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| V <sub>SS</sub>                       | 14  | GND                     |                |                                          | Core supply ground reference                                                                                                                                                                                                                                                                                                                                                                                                            |
|                                       | 34  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                       | 52  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                       | 91  |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                       | 122 |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|                                       | 129 |                         |                |                                          |                                                                                                                                                                                                                                                                                                                                                                                                                                         |

| PIN                       |     | TYPE <sup>(1)</sup> (2) | CURRENT<br>OUTPUT | INTERNAL<br>PULLUP/<br>PULLDOWN <sup>(3)</sup> | DESCRIPTION                         |
|---------------------------|-----|-------------------------|-------------------|------------------------------------------------|-------------------------------------|
| NAME                      | NO. |                         |                   |                                                |                                     |
| SUPPLY GROUND DIGITAL I/O |     |                         |                   |                                                |                                     |
| V <sub>SSIO</sub>         | 26  | GND                     |                   |                                                | Digital I/O supply ground reference |
|                           | 68  |                         |                   |                                                |                                     |
|                           | 85  |                         |                   |                                                |                                     |
|                           | 138 |                         |                   |                                                |                                     |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range, A version (unless otherwise noted)<sup>(1)</sup>

|                                       |                                                                                                                                   | MIN  | MAX | UNIT |
|---------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|------|-----|------|
| Supply voltage                        | $V_{CC}$ <sup>(2)</sup>                                                                                                           | –0.3 | 2.5 | V    |
| Supply voltage                        | $V_{CCIO}$ , $V_{CCAD}$ , $V_{CCP}$ (flash pump) <sup>(2)</sup>                                                                   | –0.3 | 4.1 | V    |
| Input voltage                         | All 5-V tolerant input pins                                                                                                       | –0.3 | 6.0 | V    |
|                                       | All other input pins                                                                                                              | –0.3 | 4.1 | V    |
| Input clamp current                   | $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CCIO}$ )<br>All pins except ADIN[0:11], $\overline{PORRST}$ , $\overline{TRST}$ , TEST, and TCK |      | ±20 | mA   |
|                                       | $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CCAD}$ )<br>ADIN[0:11]                                                                          |      | ±10 | mA   |
| Operating free-air temperature, $T_A$ | HFQ/HKP package                                                                                                                   | –55  | 220 | °C   |
|                                       | PGE package                                                                                                                       | –55  | 150 | °C   |
| Storage temperature, $T_{stg}$        |                                                                                                                                   | –55  | 220 | °C   |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values are with respect to their associated grounds.

### 6.2 ESD Ratings

|                                            |                                                                                | VALUE | UNIT |
|--------------------------------------------|--------------------------------------------------------------------------------|-------|------|
| SM470R1B1M-HT in CFP Package               |                                                                                |       |      |
| V <sub>(ESD)</sub> Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | 2000  | V    |
|                                            | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | 750   |      |
| SM470R1B1M-HT in LQFP Package              |                                                                                |       |      |
| V <sub>(ESD)</sub> Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | 2000  | V    |
|                                            | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | 750   |      |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions<sup>(1)</sup>

|                                              |                                            | MIN  | NOM | MAX  | UNIT |
|----------------------------------------------|--------------------------------------------|------|-----|------|------|
| $V_{CC}$ Digital logic supply voltage (Core) | SYSCLK = 48 MHz<br>(pipeline mode enabled) | 1.71 |     | 2.05 | V    |
|                                              | SYSCLK = 60 MHz<br>(pipeline mode enabled) | 1.81 |     | 2.05 |      |
| $V_{CCIO}$                                   | Digital logic supply voltage (I/O)         | 3    |     | 3.6  | V    |
| $V_{CCAD}$                                   | ADC supply voltage                         | 3    |     | 3.6  | V    |
| $V_{CCP}$                                    | Flash pump supply voltage                  | 3    |     | 3.6  | V    |
| $V_{SS}$                                     | Digital logic supply ground                |      | 0   |      | V    |
| $V_{SSAD}$                                   | ADC supply ground <sup>(1)</sup>           | –0.1 |     | 0.1  | V    |
| $T_A$ Operating free-air temperature         | HFQ/HKP package                            | –55  |     | 220  | °C   |
|                                              | PGE package                                | –55  |     | 150  |      |

(1) All voltages are with respect to  $V_{SS}$ , except  $V_{CCAD}$ , which is with respect to  $V_{SSAD}$ .

## 6.4 Electrical Characteristics

Minimum and maximum parameters are characterized over the operating temperature range unless otherwise noted, but may not be production tested at that temperature. Production test limits with statistical guardbands are used to ensure high temperature performance. <sup>(1)</sup>

| PARAMETER        |                                               |                                    | TEST CONDITIONS                                                                         | MIN                     | TYP <sup>(2)</sup>      | MAX                   | UNIT |
|------------------|-----------------------------------------------|------------------------------------|-----------------------------------------------------------------------------------------|-------------------------|-------------------------|-----------------------|------|
| V <sub>hys</sub> | Input hysteresis                              |                                    |                                                                                         |                         | 0.15                    |                       | V    |
| V <sub>IL</sub>  | Low-level input voltage                       | All inputs <sup>(3)</sup>          |                                                                                         | –0.3                    |                         | 0.8                   | V    |
| V <sub>IH</sub>  | High-level input voltage                      | All inputs                         |                                                                                         | 2                       | V <sub>CCIO</sub> + 0.3 |                       | V    |
|                  | Input threshold voltage                       | AWD only <sup>(4)</sup>            |                                                                                         | 1.35                    |                         | 1.8                   |      |
|                  |                                               | OSCIN with digital input only      |                                                                                         | 0.7 V <sub>CC</sub>     |                         | V <sub>CC</sub> + 0.3 |      |
| V <sub>OL</sub>  | Low-level output voltage <sup>(5)</sup>       |                                    | I <sub>OL</sub> = I <sub>OL</sub> MAX                                                   |                         |                         | 0.2 V <sub>CCIO</sub> | V    |
|                  |                                               |                                    | I <sub>OL</sub> = 50 µA                                                                 |                         |                         | 0.2                   |      |
| V <sub>OH</sub>  | High-level output voltage <sup>(5)</sup>      |                                    | I <sub>OH</sub> = I <sub>OH</sub> MIN                                                   | 0.8 V <sub>CCIO</sub>   |                         |                       | V    |
|                  |                                               |                                    | I <sub>OH</sub> = 50 µA                                                                 | V <sub>CCIO</sub> – 0.2 |                         |                       |      |
| I <sub>IC</sub>  | Input clamp current (I/O pins) <sup>(6)</sup> |                                    | V <sub>I</sub> < V <sub>SSIO</sub> – 0.3 or<br>V <sub>I</sub> > V <sub>CCIO</sub> + 0.3 | –2                      |                         | 2                     | mA   |
| I <sub>I</sub>   | Input current (3.3 V input pins)              | I <sub>IL</sub> Pulldown           | V <sub>I</sub> = V <sub>SS</sub>                                                        | –1                      |                         | 1                     | µA   |
|                  |                                               | I <sub>IH</sub> Pulldown           | V <sub>I</sub> = V <sub>CCIO</sub>                                                      | 5                       |                         | 100                   |      |
|                  |                                               | I <sub>IL</sub> Pullup             | V <sub>I</sub> = V <sub>SS</sub>                                                        | –100                    |                         | –5                    |      |
|                  |                                               | I <sub>IH</sub> Pullup             | V <sub>I</sub> = V <sub>CCIO</sub>                                                      | –1                      |                         | 1                     |      |
|                  |                                               | All other pins                     | No pullup or pulldown                                                                   | –1                      |                         | 1                     |      |
|                  | Input current (5 V tolerant input pins)       |                                    | V <sub>I</sub> = V <sub>SS</sub>                                                        | –1                      |                         | 1                     | µA   |
|                  |                                               |                                    | V <sub>I</sub> = V <sub>CCIO</sub>                                                      | 1                       |                         | 5                     |      |
|                  |                                               |                                    | V <sub>I</sub> = 5 V                                                                    | 5                       |                         | 25                    |      |
|                  |                                               |                                    | V <sub>I</sub> = 5.5 V                                                                  | 25                      |                         | 50                    |      |
| I <sub>OL</sub>  | Low-level output current                      | CLKOUT, AWD, TDI, TDO, TMS, TMS2   | V <sub>OL</sub> = V <sub>OL</sub> MAX                                                   |                         |                         | 8                     | mA   |
|                  |                                               | $\overline{\text{RST}}$            |                                                                                         |                         |                         | 4                     |      |
|                  |                                               | All other 3.3 V I/O <sup>(7)</sup> |                                                                                         |                         |                         | 2                     |      |
|                  |                                               | 5 V tolerant                       |                                                                                         |                         |                         | 4                     |      |
| I <sub>OH</sub>  | High-level output current                     | CLKOUT, TDI, TDO, TMS, TMS2        | V <sub>OH</sub> = V <sub>OH</sub> MIN                                                   | –8                      |                         |                       | mA   |
|                  |                                               | $\overline{\text{RST}}$            |                                                                                         | –4                      |                         |                       |      |
|                  |                                               | All other 3.3 V I/O <sup>(7)</sup> |                                                                                         | –2                      |                         |                       |      |
|                  |                                               | 5 V tolerant                       |                                                                                         | –4                      |                         |                       |      |

(1) Source currents (out of the device) are negative while sink currents (into the device) are positive.

(2) The typical values indicated in this table are the expected values during operation under normal operating conditions: nominal V<sub>CC</sub>, V<sub>CCIO</sub>, or V<sub>CCAD</sub>, room temperature.

(3) This does not apply to the  $\overline{\text{PORRST}}$  pin. For  $\overline{\text{PORRST}}$  exceptions, see the  $\overline{\text{RST}}$  and  $\overline{\text{PORRST}}$  Timings section.

(4) These values help to determine the external RC network circuit. For more details, see the *TMS470R1x System Module Reference Guide* (SPNU189).

(5) V<sub>OL</sub> and V<sub>OH</sub> are linear with respect to the amount of load current (I<sub>OL</sub>/I<sub>OH</sub>) applied.

(6) Parameter does not apply to input-only or output-only pins.

(7) Some of the 2 mA buffers on this device are zero-dominant buffers, as indicated by a -z in the Output Current column of the Pin Functions table. If two of these buffers are shorted together and one is outputting a low level and the other is outputting a high level, the resulting value will always be low.

## Electrical Characteristics (continued)

Minimum and maximum parameters are characterized over the operating temperature range unless otherwise noted, but may not be production tested at that temperature. Production test limits with statistical guardbands are used to ensure high temperature performance. <sup>(1)</sup>

| PARAMETER         |                                                                          | TEST CONDITIONS                                                   | MIN | TYP <sup>(2)</sup> | MAX | UNIT |
|-------------------|--------------------------------------------------------------------------|-------------------------------------------------------------------|-----|--------------------|-----|------|
| I <sub>CC</sub>   | V <sub>CC</sub> Digital supply current (operating mode)                  | SYSCLK = 48 MHz,<br>ICLK = 24 MHz, V <sub>CC</sub> = 2.05 V       |     |                    | 110 | mA   |
|                   |                                                                          | SYSCLK = 60 MHz,<br>ICLK = 30 MHz, V <sub>CC</sub> = 2.05 V       |     |                    | 125 | mA   |
|                   | V <sub>CC</sub> Digital supply current (standby mode) <sup>(8) (9)</sup> | OSCIN = 5 MHz, V <sub>CC</sub> = 2.05 V                           |     |                    | 28  | mA   |
|                   | V <sub>CC</sub> Digital supply current (halt mode) <sup>(8) (9)</sup>    | All frequencies, V <sub>CC</sub> = 2.05 V                         |     |                    | 700 | μA   |
| I <sub>CCIO</sub> | V <sub>CCIO</sub> Digital supply current (operating mode)                | No DC load, V <sub>CCIO</sub> = 3.6 V <sup>(10)</sup>             |     |                    | 20  | mA   |
|                   | V <sub>CCIO</sub> Digital supply current (standby mode) <sup>(9)</sup>   | No DC load, V <sub>CCIO</sub> = 3.6 V <sup>(10)</sup>             |     |                    | 250 | μA   |
|                   | V <sub>CCIO</sub> Digital supply current (halt mode) <sup>(9)</sup>      | No DC load, V <sub>CCIO</sub> = 3.6 V <sup>(10)</sup>             |     |                    | 225 | μA   |
| I <sub>CCAD</sub> | V <sub>CCAD</sub> supply current (operating mode)                        | All frequencies, V <sub>CCAD</sub> = 3.6 V                        |     |                    | 15  | mA   |
|                   | V <sub>CCAD</sub> supply current (standby mode)                          | All frequencies, V <sub>CCAD</sub> = 3.6 V                        |     |                    | 10  | μA   |
|                   | V <sub>CCAD</sub> supply current (halt mode)                             | All frequencies, V <sub>CCAD</sub> = 3.6 V                        |     |                    | 10  | μA   |
| I <sub>CCP</sub>  | V <sub>CCP</sub> pump supply current                                     | SYSCLK = 48 MHz, V <sub>CCP</sub> = 3.6 V<br>read operation       |     |                    | 45  | mA   |
|                   |                                                                          | SYSCLK = 60 MHz, V <sub>CCP</sub> = 3.6 V<br>read operation       |     |                    | 55  | mA   |
|                   |                                                                          | V <sub>CCP</sub> = 3.6 V program and erase                        |     |                    | 70  | mA   |
|                   |                                                                          | V <sub>CCP</sub> = 3.6 V standby mode<br>operation <sup>(8)</sup> |     |                    | 10  | μA   |
|                   |                                                                          | V <sub>CCP</sub> = 3.6 V halt mode<br>operation <sup>(8)</sup>    |     |                    | 10  | μA   |
| C <sub>I</sub>    | Input capacitance                                                        |                                                                   |     | 2                  |     | pF   |
| C <sub>O</sub>    | Output capacitance                                                       |                                                                   |     | 3                  |     | pF   |

(8) For flash banks/pumps in sleep mode.

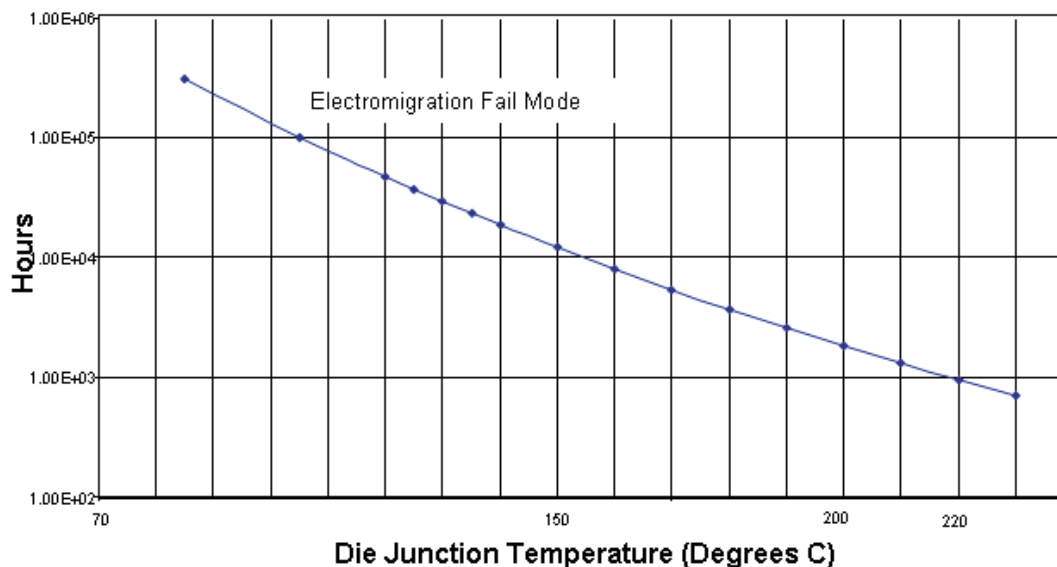
(9) For reduced power consumption in low power mode, CANSRX and CANSTX should be driven output LOW.

(10) I/O pins configured as inputs or outputs with no load. All pulldown inputs ≤ 0.2 V. All pullup inputs ≥ V<sub>CCIO</sub> – 0.2 V.

## 6.5 Thermal Characteristics

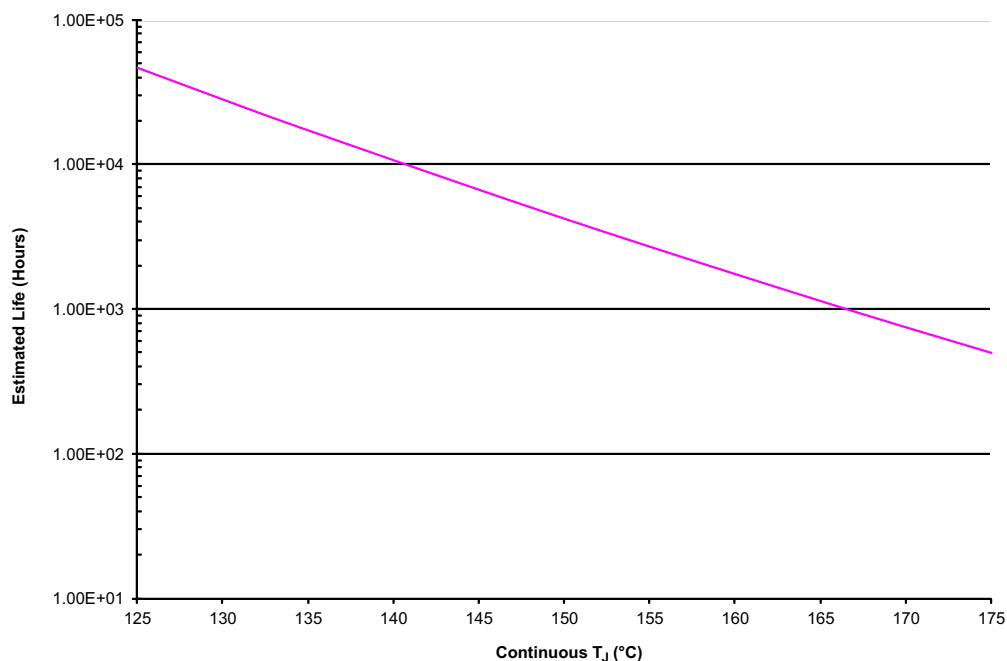
| THERMAL METRIC <sup>(1)</sup> |                                              | SM470R1B1M-HT           |            | UNIT |
|-------------------------------|----------------------------------------------|-------------------------|------------|------|
|                               |                                              | HFQ (CQFP) OR HKP (CFP) | PGE (LQFP) |      |
|                               |                                              | 64 PINS                 | 144 PINS   |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | N/A                     | 38.3       | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | N/A                     | 5.7        | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 152.0148                | 19.7       | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | N/A                     | 0.1        | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | N/A                     | 19.3       | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | 5.4898                  | N/A        | °C/W |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).



- (1) See data sheet for absolute maximum and minimum recommended operating conditions.
- (2) Silicon operating life design goal is 10 years at 105°C junction temperature (does not include package interconnect life).

**Figure 6-1. SM470R1B1M-HT Life Expectancy Curve (HFQ/HKP Package)**



- (1) See data sheet for absolute maximum and minimum recommended operating conditions.
- (2) Silicon operating life design goal is 10 years at 105°C junction temperature (does not include package interconnect life).
- (3) Device is qualified for 1000 hour operation at 150°C. Device is functional at 175°C, but at reduced operating life.

**Figure 6-2. SM470R1B1M-HT Wirebond Life Derating Chart (PGE Package)**

## 6.6 ZPLL and Clock Specifications

**Table 6-1. Timing Requirements for ZPLL Circuits Enabled or Disabled<sup>(1)</sup>**

|                |                                   | MIN | TYP | MAX | UNIT |
|----------------|-----------------------------------|-----|-----|-----|------|
| $f_{(OSC)}$    | Input clock frequency             | 4   |     | 10  | MHz  |
| $t_{c(OSC)}$   | Cycle time, OSCIN                 | 100 |     |     | ns   |
| $t_{w(OSCIL)}$ | Pulse duration, OSCIN low         | 15  |     |     | ns   |
| $t_{w(OSCIH)}$ | Pulse duration, OSCIN high        | 15  |     |     | ns   |
| $f_{(OSCRST)}$ | OSC FAIL frequency <sup>(2)</sup> |     | 53  |     | kHz  |

(1) Not production tested.

(2) Causes a device reset (specifically a clock reset) by setting the RST OSC FAIL (GLBCTRL.15) and the OSC FAIL flag (GLBSTAT.1) bits equal to 1. For more detailed information on these bits and device resets, see the *TMS470R1x System Module Reference Guide* ([SPNU189](#)).

**Table 6-2. Switching Characteristics over Recommended Operating Conditions for Clocks<sup>(1)(2) (3) (4)</sup>**

| PARAMETER       | TEST CONDITIONS <sup>(5)</sup>                 | MIN  | MAX               | UNIT |
|-----------------|------------------------------------------------|------|-------------------|------|
| $f_{(SYS)}$     | System clock frequency <sup>(6)</sup>          |      |                   |      |
|                 | Pipeline mode enabled                          |      | 60 <sup>(7)</sup> | MHz  |
|                 | Pipeline mode disabled                         |      | 24                | MHz  |
| $f_{(CONFIG)}$  | System clock frequency - flash config mode     |      | 24                | MHz  |
| $f_{(ICLK)}$    | Interface clock frequency                      |      |                   |      |
|                 | Pipeline mode enabled                          |      | 30                | MHz  |
|                 | Pipeline mode disabled                         |      | 24                | MHz  |
| $f_{(ECLK)}$    | External clock output frequency for ECP module |      |                   |      |
|                 | Pipeline mode enabled                          |      | 30                | MHz  |
|                 | Pipeline mode disabled                         |      | 24                | MHz  |
| $t_{c(SYS)}$    | Cycle time, system clock                       |      |                   |      |
|                 | Pipeline mode enabled                          | 16.7 |                   | ns   |
|                 | Pipeline mode disabled                         | 41.6 |                   | ns   |
| $t_{c(CONFIG)}$ | Cycle time, system clock - flash config mode   | 41.6 |                   | ns   |
| $t_{c(ICLK)}$   | Cycle time, interface clock                    |      |                   |      |
|                 | Pipeline mode enabled                          | 33.3 |                   | ns   |
|                 | Pipeline mode disabled                         | 41.6 |                   | ns   |
| $t_{c(ECLK)}$   | Cycle time, ECP module external clock output   |      |                   |      |
|                 | Pipeline mode enabled                          | 33.3 |                   | ns   |
|                 | Pipeline mode disabled                         | 41.6 |                   | ns   |

(1) Not production tested.

(2)  $f_{(SYS)} = M \times f_{(OSC)}/R$ , where  $M = \{8\}$ ,  $R = \{1,2,3,4,5,6,7,8\}$  when PLLDIS = 0. R is the system-clock divider determined by the CLKDIVPRE[2:0] bits in the global control register (GLBCTRL[2:0]) and M is the PLL multiplier determined by the MULT4 bit also in the GLBCTRL register (GLBCTRL.3).

$f_{(SYS)} = f_{(OSC)}/R$ , where  $R = \{1,2,3,4,5,6,7,8\}$  when PLLDIS = 1.

$f_{(ICLK)} = f_{(SYS)}/X$ , where  $X = \{1,2,3,4,5,6,7,8,9,10,11,12,13,14,15,16\}$ . X is the interface clock divider ratio determined by the PCR0[4:1] bits in the SYS module.

(3)  $f_{(ECLK)} = f_{(ICLK)}/N$ , where  $N = \{1 \text{ to } 256\}$ . N is the ECP prescale value defined by the ECPCTRL[7:0] register bits in the ECP module.

(4) Only ZPLL mode is available. FM mode must not be turned on.

(5) Pipeline mode enabled or disabled is determined by the ENPIPE bit (FMREGOPT.0).

(6) Flash Vread must be set to 5 V to achieve maximum system clock frequency.

(7) Operating  $V_{CC}$  range for this system clock frequency is 1.81 to 2.05 V.

**Table 6-3. Switching Characteristics over Recommended Operating Conditions for External Clocks<sup>(1)(2)</sup>**  
**(3) (4)**

(see [Figure 6-3](#) and [Figure 6-4](#))

| PARAMETER                                | TEST CONDITIONS                         | MIN                                    | MAX | UNIT |
|------------------------------------------|-----------------------------------------|----------------------------------------|-----|------|
| $t_{w(COL)}$ Pulse duration, CLKOUT low  | SYSCLK or MCLK <sup>(5)</sup>           | $0.5t_{c(SYS)} - t_f$                  |     | ns   |
|                                          | ICLK: X is even or 1 <sup>(6)</sup>     | $0.5t_{c(ICLK)} - t_f$                 |     |      |
|                                          | ICLK: X is odd and not 1 <sup>(6)</sup> | $0.5t_{c(ICLK)} + 0.5t_{c(SYS)} - t_f$ |     |      |
| $t_{w(COH)}$ Pulse duration, CLKOUT high | SYSCLK or MCLK <sup>(5)</sup>           | $0.5t_{c(SYS)} - t_r$                  |     | ns   |
|                                          | ICLK: X is even or 1 <sup>(6)</sup>     | $0.5t_{c(ICLK)} - t_r$                 |     |      |
|                                          | ICLK: X is odd and not 1 <sup>(6)</sup> | $0.5t_{c(ICLK)} - 0.5t_{c(SYS)} - t_r$ |     |      |
| $t_{w(EOL)}$ Pulse duration, ECLK low    | N is even and X is even or odd          | $0.5t_{c(ECLK)} - t_f$                 |     | ns   |
|                                          | N is odd and X is even                  | $0.5t_{c(ECLK)} - t_f$                 |     |      |
|                                          | N is odd and X is odd and not 1         | $0.5t_{c(ECLK)} + 0.5t_{c(SYS)} - t_f$ |     |      |
| $t_{w(EOH)}$ Pulse duration, ECLK high   | N is even and X is even or odd          | $0.5t_{c(ECLK)} - t_r$                 |     | ns   |
|                                          | N is odd and X is even                  | $0.5t_{c(ECLK)} - t_r$                 |     |      |
|                                          | N is odd and X is odd and not 1         | $0.5t_{c(ECLK)} - 0.5t_{c(SYS)} - t_r$ |     |      |

(1) Not production tested.

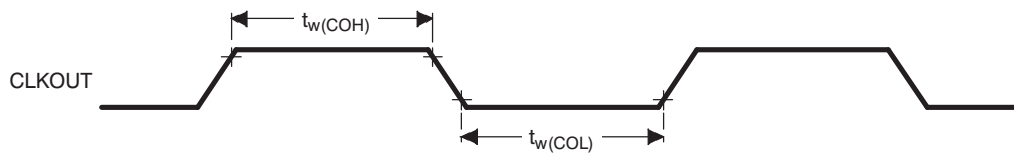
(2)  $X = \{1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, 16\}$ . X is the interface clock divider ratio determined by the PCR0[4:1] bits in the SYS module.

(3)  $N = \{1 \text{ to } 256\}$ . N is the ECP prescale value defined by the ECPCTRL[7:0] register bits in the ECP module.

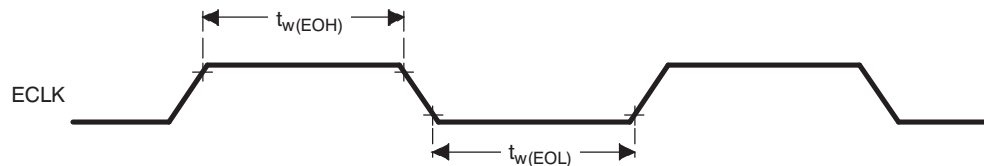
(4) CLKOUT/ECLK pulse durations (low/high) are a function of the OSCIN pulse durations when PLLDIS is active.

(5) Clock source bits are selected as either SYSCLK (CLKCNTL[6:5] = 11 binary) or MCLK (CLKCNTL[6:5] = 10 binary).

(6) Clock source bits are selected as ICLK (CLKCNTL[6:5] = 01 binary).



**Figure 6-3. CLKOUT Timing Diagram**



**Figure 6-4. ECLK Timing Diagram**

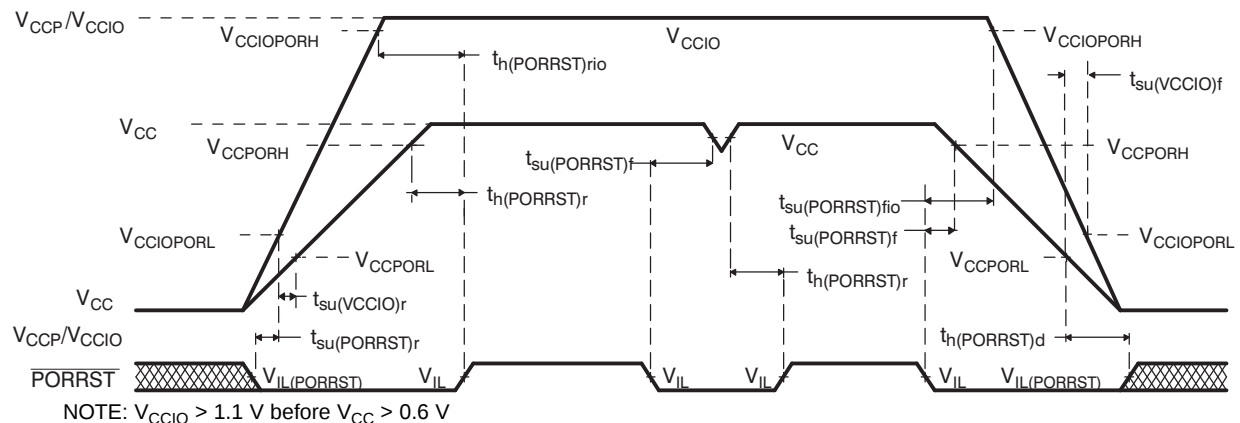
## 6.7 $\overline{\text{RST}}$ and $\overline{\text{PORRST}}$ Timings

**Table 6-4. Timing Requirements for  $\overline{\text{PORRST}}$ <sup>(1)</sup>**

(see Figure 6-5)

|                                                        |                                                                                                                                            | MIN  | MAX                   | UNIT          |
|--------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------|------|-----------------------|---------------|
| $V_{\text{CCPORL}}$                                    | $V_{\text{CC}}$ low supply level when $\overline{\text{PORRST}}$ must be active during power up                                            |      | 0.6                   | V             |
| $V_{\text{CCPORH}}$                                    | $V_{\text{CC}}$ high supply level when $\overline{\text{PORRST}}$ must remain active during power up and become active during power down   | 1.5  |                       | V             |
| $V_{\text{CCIOPORL}}$                                  | $V_{\text{CCIO}}$ low supply level when $\overline{\text{PORRST}}$ must be active during power up                                          |      | 1.1                   | V             |
| $V_{\text{CCIOPORH}}$                                  | $V_{\text{CCIO}}$ high supply level when $\overline{\text{PORRST}}$ must remain active during power up and become active during power down | 2.75 |                       | V             |
| $V_{\text{IL}}$                                        | Low-level input voltage after $V_{\text{CCIO}} > V_{\text{CCIOPORH}}$                                                                      |      | $0.2 V_{\text{CCIO}}$ | V             |
| $V_{\text{IL}}(\overline{\text{PORRST}})$              | Low-level input voltage of $\overline{\text{PORRST}}$ before $V_{\text{CCIO}} > V_{\text{CCIOPORL}}$                                       |      | 0.5                   | V             |
| $t_{\text{su}}(\overline{\text{PORRST}})_r$            | Setup time, $\overline{\text{PORRST}}$ active before $V_{\text{CCIO}} > V_{\text{CCIOPORL}}$ during power up                               | 0    |                       | ms            |
| $t_{\text{su}}(V_{\text{CCIO}})_r$                     | Setup time, $V_{\text{CCIO}} > V_{\text{CCIOPORL}}$ before $V_{\text{CC}} > V_{\text{CCPORL}}$                                             | 0    |                       | ms            |
| $t_{\text{h}}(\overline{\text{PORRST}})_r$             | Hold time, $\overline{\text{PORRST}}$ active after $V_{\text{CC}} > V_{\text{CCPORH}}$                                                     | 1    |                       | ms            |
| $t_{\text{su}}(\overline{\text{PORRST}})_f$            | Setup time, $\overline{\text{PORRST}}$ active before $V_{\text{CC}} \leq V_{\text{CCPORH}}$ during power down                              | 8    |                       | $\mu\text{s}$ |
| $t_{\text{h}}(\overline{\text{PORRST}})_{\text{rio}}$  | Hold time, $\overline{\text{PORRST}}$ active after $V_{\text{CC}} > V_{\text{CCIOPORH}}$                                                   | 1    |                       | ms            |
| $t_{\text{h}}(\overline{\text{PORRST}})_d$             | Hold time, $\overline{\text{PORRST}}$ active after $V_{\text{CC}} < V_{\text{CCPORL}}$                                                     | 0    |                       | ms            |
| $t_{\text{su}}(\overline{\text{PORRST}})_{\text{fio}}$ | Setup time, $\overline{\text{PORRST}}$ active before $V_{\text{CC}} \leq V_{\text{CCIOPORH}}$ during power down                            | 0    |                       | ns            |
| $t_{\text{su}}(V_{\text{CCIO}})_f$                     | Setup time, $V_{\text{CC}} < V_{\text{CCPORL}}$ before $V_{\text{CCIO}} < V_{\text{CCIOPORL}}$                                             | 0    |                       | ns            |

(1) Not production tested.



**Figure 6-5.  $\overline{\text{PORRST}}$  Timing Diagram**

**Table 6-5. Switching Characteristics over Recommended Operating Conditions for  $\overline{\text{RST}}$ <sup>(1)</sup> (2)**

|                                       | PARAMETER                                                                                                                           | MIN                            | MAX | UNIT |
|---------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|--------------------------------|-----|------|
| $t_{\text{v}}(\overline{\text{RST}})$ | Valid time, $\overline{\text{RST}}$ active after $\overline{\text{PORRST}}$ inactive                                                | $4112t_{\text{c}}(\text{OSC})$ |     | ns   |
|                                       | Valid time, $\overline{\text{RST}}$ active (all others)                                                                             | $8t_{\text{c}}(\text{SYS})$    |     |      |
| $t_{\text{su}}$                       | Flash start up time, from $\overline{\text{RST}}$ inactive to fetch of first instruction from flash (flash pump stabilization time) | $836t_{\text{c}}(\text{OSC})$  |     | ns   |

(1) Not production tested.

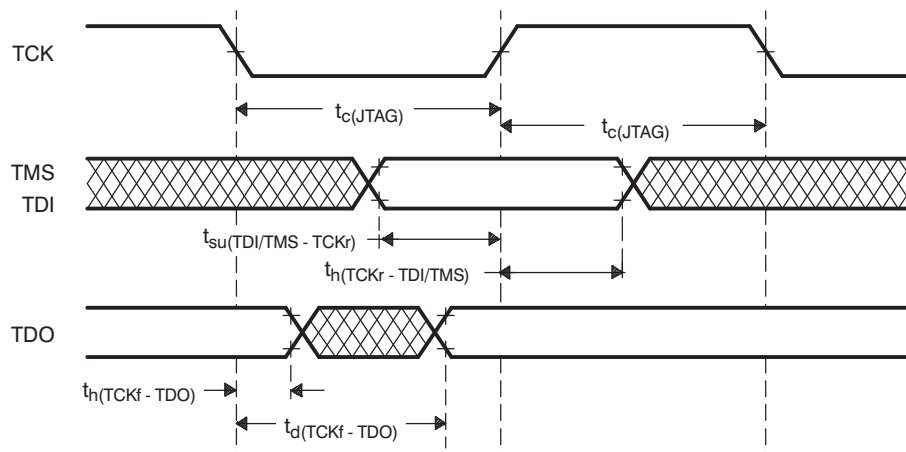
(2) Specified values do NOT include rise/fall times. For rise and fall timings, see the "switching characteristics for output timings versus load capacitance" table.

## 6.8 JTAG Scan Interface Timing

**Table 6-6. JTAG Clock Specification 10-MHz and 50-pF Load on TDO Output<sup>(1)</sup>**

|                          |                                             | MIN | MAX | UNIT |
|--------------------------|---------------------------------------------|-----|-----|------|
| $t_{c(JTAG)}$            | Cycle time, JTAG low and high period        | 50  |     | ns   |
| $t_{su(TDI/TMS - TCKr)}$ | Setup time, TDI, TMS before TCK rise (TCKr) | 15  |     | ns   |
| $t_h(TCKr - TDI/TMS)$    | Hold time, TDI, TMS after TCKr              | 15  |     | ns   |
| $t_h(TCKf - TDO)$        | Hold time, TDO after TCKf                   | 10  |     | ns   |
| $t_d(TCKf - TDO)$        | Delay time, TDO valid after TCK fall (TCKf) |     | 45  | ns   |

(1) Not production tested.



**Figure 6-6. JTAG Scan Timings**

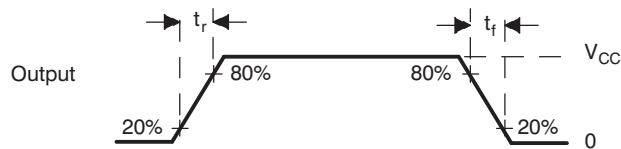
## 6.9 Output Timings

**Table 6-7. Switching Characteristics for Output Timings versus Load Capacitance ( $C_L$ )<sup>(1)</sup>**

(see Figure 6-7)

| PARAMETER |                                                                  | MIN                    | MAX | UNIT |
|-----------|------------------------------------------------------------------|------------------------|-----|------|
| $t_r$     | Rise time, AWD, CLKOUT, $\overline{\text{TDI}}$ , TDO, TMS, TMS2 | $C_L = 15 \text{ pF}$  | 0.5 | 2.5  |
|           |                                                                  | $C_L = 50 \text{ pF}$  | 1.5 | 5.0  |
|           |                                                                  | $C_L = 100 \text{ pF}$ | 3.0 | 9.0  |
|           |                                                                  | $C_L = 150 \text{ pF}$ | 4.5 | 12.5 |
| $t_f$     | Fall time, AWD, CLKOUT, $\overline{\text{TDI}}$ , TDO, TMS, TMS2 | $C_L = 15 \text{ pF}$  | 0.5 | 2.5  |
|           |                                                                  | $C_L = 50 \text{ pF}$  | 1.5 | 5.0  |
|           |                                                                  | $C_L = 100 \text{ pF}$ | 3.0 | 9.0  |
|           |                                                                  | $C_L = 150 \text{ pF}$ | 4.5 | 12.5 |
| $t_r$     | Rise time, $\overline{\text{RST}}$                               | $C_L = 15 \text{ pF}$  | 2.5 | 8    |
|           |                                                                  | $C_L = 50 \text{ pF}$  | 5   | 14   |
|           |                                                                  | $C_L = 100 \text{ pF}$ | 9   | 23   |
|           |                                                                  | $C_L = 150 \text{ pF}$ | 13  | 32   |
| $t_r$     | Rise time, 4-mA, 5-V tolerant pins                               | $C_L = 15 \text{ pF}$  | 3   | 10   |
|           |                                                                  | $C_L = 50 \text{ pF}$  | 3.5 | 12   |
|           |                                                                  | $C_L = 100 \text{ pF}$ | 7   | 21   |
|           |                                                                  | $C_L = 150 \text{ pF}$ | 9   | 28   |
| $t_f$     | Fall time, 4-mA, 5-V tolerant pins                               | $C_L = 15 \text{ pF}$  | 3   | 10   |
|           |                                                                  | $C_L = 50 \text{ pF}$  | 3.5 | 12   |
|           |                                                                  | $C_L = 100 \text{ pF}$ | 7   | 21   |
|           |                                                                  | $C_L = 150 \text{ pF}$ | 9   | 28   |
| $t_r$     | Rise time, all other output pins                                 | $C_L = 15 \text{ pF}$  | 2.5 | 10   |
|           |                                                                  | $C_L = 50 \text{ pF}$  | 6.0 | 25   |
|           |                                                                  | $C_L = 100 \text{ pF}$ | 12  | 45   |
|           |                                                                  | $C_L = 150 \text{ pF}$ | 18  | 65   |
| $t_f$     | Fall time, all other output pins                                 | $C_L = 15 \text{ pF}$  | 3   | 10   |
|           |                                                                  | $C_L = 50 \text{ pF}$  | 8.5 | 25   |
|           |                                                                  | $C_L = 100 \text{ pF}$ | 16  | 45   |
|           |                                                                  | $C_L = 150 \text{ pF}$ | 23  | 65   |

(1) Not production tested.



**Figure 6-7. CMOS-Level Outputs**

## 6.10 Input Timings

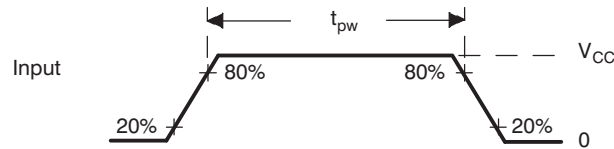
**Table 6-8. Timing Requirements for Input Timings<sup>(1)(2)</sup>**

(see Figure 6-8)

|                                    | MIN                | MAX | UNIT |
|------------------------------------|--------------------|-----|------|
| $t_{pw}$ Input minimum pulse width | $t_{c(ICLK)} + 10$ |     | ns   |

(1) Not production tested.

(2)  $t_{c(ICLK)}$  = interface clock cycle time =  $1/f_{(ICLK)}$



**Figure 6-8. CMOS-Level Inputs**

## 6.11 Flash Timings

**Table 6-9. Timing Requirements for Program Flash<sup>(1)(2)</sup>**

|                                                                                         | MIN   | TYP             | MAX | UNIT    |
|-----------------------------------------------------------------------------------------|-------|-----------------|-----|---------|
| $t_{prog(16-bit)}$ Half word (16-bit) programming time                                  | 4     | 16              | 200 | $\mu$ s |
| $t_{prog(Total)}$ 1MB programming time <sup>(3)</sup>                                   |       | 8               | 32  | s       |
| $t_{erase(sector)}$ Sector erase time, $T_A = -40^\circ\text{C}$ to $150^\circ\text{C}$ |       | 1.7             |     | s       |
| $t_{wec}$ Write/erase cycles at $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$         | 50000 |                 |     | cycles  |
| $t_{fp(RST)}$ Flash pump settling time from $\overline{RST}$ to SLEEP                   |       | $167t_{c(SYS)}$ |     | ns      |
| $t_{fp(SLEEP)}$ Initial flash pump settling time from SLEEP to STANDBY                  |       | $167t_{c(SYS)}$ |     | ns      |
| $t_{fp(STANDBY)}$ Initial flash pump settling time from STANDBY to ACTIVE               |       | $84t_{c(SYS)}$  |     | ns      |

(1) Not production tested.

(2) For more detailed information on the flash core sectors, see the *flash program and erase* section of this data sheet.

(3) The 1MB programming time includes overhead of state machine.

## 6.12 SPIn Master Mode Timing Parameters

**Table 6-10. SPIn Master Mode External Timing Parameters**

 (CLOCK PHASE = 0, SPInCLK = output, SPInSIMO = output, and SPInSOMI = input)<sup>(1)(2) (3) (4)</sup> (see Figure 6-9)

| NO.              |                                                                                             | MIN                     | MAX                  | UNIT |
|------------------|---------------------------------------------------------------------------------------------|-------------------------|----------------------|------|
| 1                | $t_{c(SPC)M}$ Cycle time, SPInCLK <sup>(5)</sup>                                            | 100                     | $256t_{c(I)CLK}$     |      |
| 2 <sup>(6)</sup> | $t_{w(SPCH)M}$ Pulse duration, SPInCLK high (clock polarity = 0)                            | $0.5t_{c(SPC)M} - t_r$  | $0.5t_{c(SPC)M} + 5$ |      |
|                  | $t_{w(SPCL)M}$ Pulse duration, SPInCLK low (clock polarity = 1)                             | $0.5t_{c(SPC)M} - t_f$  | $0.5t_{c(SPC)M} + 5$ |      |
| 3 <sup>(6)</sup> | $t_{w(SPCL)M}$ Pulse duration, SPInCLK low (clock polarity = 0)                             | $0.5t_{c(SPC)M} - t_f$  | $0.5t_{c(SPC)M} + 5$ |      |
|                  | $t_{w(SPCH)M}$ Pulse duration, SPInCLK high (clock polarity = 1)                            | $0.5t_{c(SPC)M} - t_r$  | $0.5t_{c(SPC)M} + 5$ |      |
| 4 <sup>(6)</sup> | $t_{d(SPCH-SIMO)M}$ Delay time, SPInCLK high to SPInSIMO valid (clock polarity = 0)         |                         | 10                   | ns   |
|                  | $t_{d(SPCL-SIMO)M}$ Delay time, SPInCLK low to SPInSIMO valid (clock polarity = 1)          |                         | 10                   |      |
| 5 <sup>(6)</sup> | $t_{v(SPCL-SIMO)M}$ Valid time, SPInSIMO data valid after SPInCLK low (clock polarity = 0)  | $t_{c(SPC)M} - 5 - t_f$ |                      |      |
|                  | $t_{v(SPCH-SIMO)M}$ Valid time, SPInSIMO data valid after SPInCLK high (clock polarity = 1) | $t_{c(SPC)M} - 5 - t_r$ |                      |      |
| 6 <sup>(6)</sup> | $t_{su(SOMI-SPCL)M}$ Setup time, SPInSOMI before SPInCLK low (clock polarity = 0)           | 6                       |                      |      |
|                  | $t_{su(SOMI-SPCH)M}$ Setup time, SPInSOMI before SPInCLK high (clock polarity = 1)          | 6                       |                      |      |
| 7 <sup>(6)</sup> | $t_{v(SPCL-SOMI)M}$ Valid time, SPInSOMI data valid after SPInCLK low (clock polarity = 0)  | 4                       |                      |      |
|                  | $t_{v(SPCH-SOMI)M}$ Valid time, SPInSOMI data valid after SPInCLK high (clock polarity = 1) | 4                       |                      |      |

(1) Not production tested.

(2) The MASTER bit (SPInCTRL2.3) is set and the CLOCK PHASE bit (SPInCTRL2.0) is cleared.

 (3)  $t_{c(I)CLK}$  = interface clock cycle time =  $1 / f_{(I)CLK}$ 

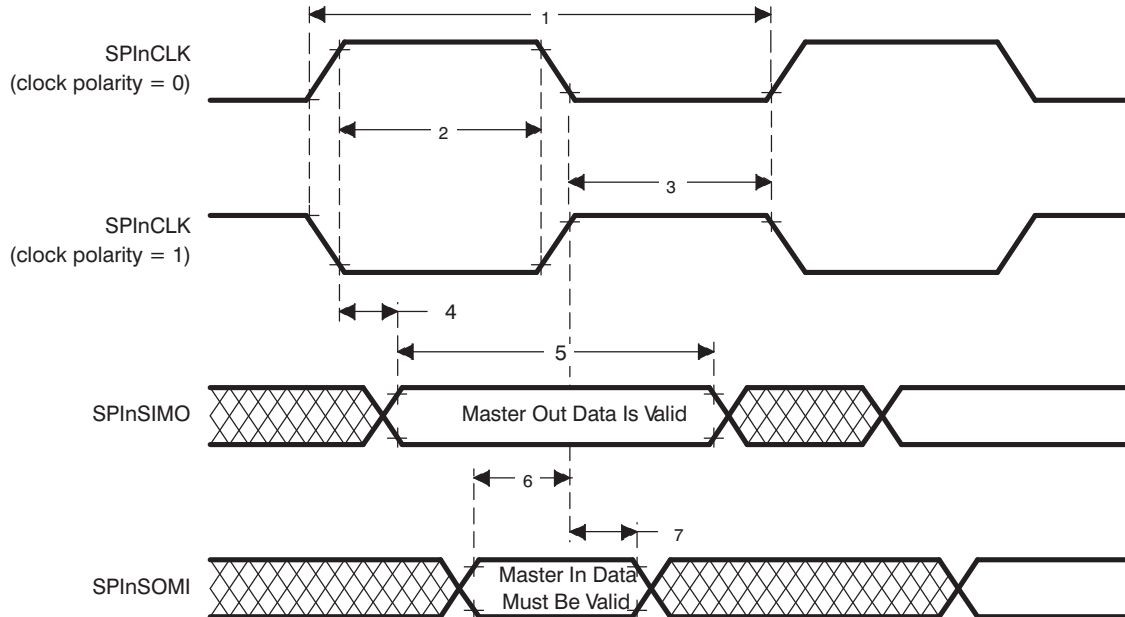
(4) For rise and fall timings, see the "Switching Characteristics for Output Timings versus Load Capacitance" table.

(5) When the SPI is in master mode, the following must be true:

 For PS values from 1 to 255:  $t_{c(SPC)M} \geq (PS + 1)t_{c(I)CLK} \geq 100$  ns, where PS is the prescale value set in the SPInCTL1[12:5] register bits.

 For PS values of 0:  $t_{c(SPC)M} = 2t_{c(I)CLK} \geq 100$  ns.

(6) The active edge of the SPInCLK signal referenced is controlled by the CLOCK POLARITY bit (SPInCTRL2.1).

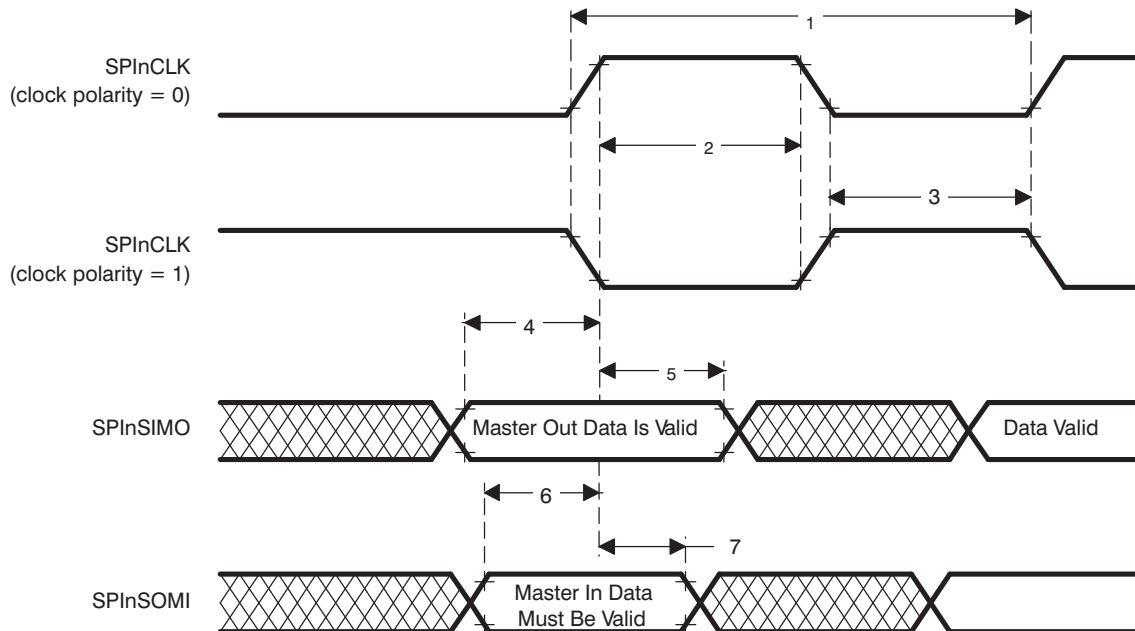

**Figure 6-9. SPIn Master Mode External Timing (CLOCK PHASE = 0)**

**Table 6-11. SPIn Master Mode External Timing Parameters<sup>(1)</sup>**

(CLOCK PHASE = 1, SPInCLK = output, SPInSIMO = output, and SPInSOMI = input)<sup>(2) (3) (4)</sup> (see Figure 6-10)

| NO.              |                      |                                                                         | MIN                        | MAX                  | UNIT |
|------------------|----------------------|-------------------------------------------------------------------------|----------------------------|----------------------|------|
| 1                | $t_{c(SPC)M}$        | Cycle time, SPInCLK <sup>(5)</sup>                                      | 100                        | $256t_{c(ICLK)}$     | ns   |
| 2 <sup>(6)</sup> | $t_{w(SPCH)M}$       | Pulse duration, SPInCLK high (clock polarity = 0)                       | $0.5t_{c(SPC)M} - t_r$     | $0.5t_{c(SPC)M} + 5$ |      |
|                  | $t_{w(SPCL)M}$       | Pulse duration, SPInCLK low (clock polarity = 1)                        | $0.5t_{c(SPC)M} - t_f$     | $0.5t_{c(SPC)M} + 5$ |      |
| 3 <sup>(6)</sup> | $t_{w(SPCL)M}$       | Pulse duration, SPInCLK low (clock polarity = 0)                        | $0.5t_{c(SPC)M} - t_f$     | $0.5t_{c(SPC)M} + 5$ |      |
|                  | $t_{w(SPCH)M}$       | Pulse duration, SPInCLK high (clock polarity = 1)                       | $0.5t_{c(SPC)M} - t_r$     | $0.5t_{c(SPC)M} + 5$ |      |
| 4 <sup>(6)</sup> | $t_{v(SIMO-SPCH)M}$  | Valid time, SPInCLK high after SPInSIMO data valid (clock polarity = 0) | $0.5t_{c(SPC)M} - 10$      |                      |      |
|                  | $t_{v(SIMO-SPCL)M}$  | Valid time, SPInCLK low after SPInSIMO data valid (clock polarity = 1)  | $0.5t_{c(SPC)M} - 10$      |                      |      |
| 5 <sup>(6)</sup> | $t_{v(SPCH-SIMO)M}$  | Valid time, SPInSIMO data valid after SPInCLK high (clock polarity = 0) | $0.5t_{c(SPC)M} - 5 - t_r$ |                      |      |
|                  | $t_{v(SPCL-SIMO)M}$  | Valid time, SPInSIMO data valid after SPInCLK low (clock polarity = 1)  | $0.5t_{c(SPC)M} - 5 - t_f$ |                      |      |
| 6 <sup>(6)</sup> | $t_{su(SOMI-SPCH)M}$ | Setup time, SPInSOMI before SPInCLK high (clock polarity = 0)           | 6                          |                      |      |
|                  | $t_{su(SOMI-SPCL)M}$ | Setup time, SPInSOMI before SPInCLK low (clock polarity = 1)            | 6                          |                      |      |
| 7 <sup>(6)</sup> | $t_{v(SPCH-SOMI)M}$  | Valid time, SPInSOMI data valid after SPInCLK high (clock polarity = 0) | 4                          |                      |      |
|                  | $t_{v(SPCL-SOMI)M}$  | Valid time, SPInSOMI data valid after SPInCLK low (clock polarity = 1)  | 4                          |                      |      |

- (1) Not production tested.  
(2) The MASTER bit (SPInCTRL2.3) is set and the CLOCK PHASE bit (SPInCTRL2.0) is set.  
(3)  $t_{c(ICLK)}$  = interface clock cycle time =  $1/f_{(ICLK)}$   
(4) For rise and fall timings, see the "Switching Characteristics for Output Timings versus Load Capacitance" table.  
(5) When the SPI is in master mode, the following must be true:  
For PS values from 1 to 255:  $t_{c(SPC)M} \geq (PS + 1)t_{c(ICLK)} \geq 100$  ns, where PS is the prescale value set in the SPInCTL1[12:5] register bits.  
For PS values of 0:  $t_{c(SPC)M} = 2t_{c(ICLK)} \geq 100$  ns.  
(6) The active edge of the SPInCLK signal referenced is controlled by the CLOCK POLARITY bit (SPInCTRL2.1).



**Figure 6-10. SPIn Master Mode External Timing (CLOCK PHASE = 1)**

## 6.13 SPIn Slave Mode Timing Parameters

**Table 6-12. SPIn Slave Mode External Timing Parameters<sup>(1)</sup>**

 (CLOCK PHASE = 0, SPInCLK = input, SPInSIMO = input, and SPInSOMI = output)<sup>(2) (3) (4) (5)</sup> (see [Figure 6-11](#))

| NO.              |                      |                                                                         | MIN                                | MAX                                | UNIT |
|------------------|----------------------|-------------------------------------------------------------------------|------------------------------------|------------------------------------|------|
| 1                | $t_{c(SPC)S}$        | Cycle time, SPInCLK <sup>(6)</sup>                                      | 100                                | $256t_{c(I)CLK}$                   | ns   |
| 2 <sup>(7)</sup> | $t_{w(SPCH)S}$       | Pulse duration, SPInCLK high (clock polarity = 0)                       | $0.5t_{c(SPC)S} - 0.25t_{c(I)CLK}$ | $0.5t_{c(SPC)S} + 0.25t_{c(I)CLK}$ |      |
|                  | $t_{w(SPCL)S}$       | Pulse duration, SPInCLK low (clock polarity = 1)                        | $0.5t_{c(SPC)S} - 0.25t_{c(I)CLK}$ | $0.5t_{c(SPC)S} + 0.25t_{c(I)CLK}$ |      |
| 3 <sup>(7)</sup> | $t_{w(SPCL)S}$       | Pulse duration, SPInCLK low (clock polarity = 0)                        | $0.5t_{c(SPC)S} - 0.25t_{c(I)CLK}$ | $0.5t_{c(SPC)S} + 0.25t_{c(I)CLK}$ |      |
|                  | $t_{w(SPCH)S}$       | Pulse duration, SPInCLK high (clock polarity = 1)                       | $0.5t_{c(SPC)S} - 0.25t_{c(I)CLK}$ | $0.5t_{c(SPC)S} + 0.25t_{c(I)CLK}$ |      |
| 4 <sup>(7)</sup> | $t_{d(SPCH-SOMI)S}$  | Delay time, SPInCLK high to SPInSOMI valid (clock polarity = 0)         |                                    | $6 + t_r$                          |      |
|                  | $t_{d(SPCL-SOMI)S}$  | Delay time, SPInCLK low to SPInSOMI valid (clock polarity = 1)          |                                    | $6 + t_f$                          |      |
| 5 <sup>(7)</sup> | $t_{v(SPCH-SOMI)S}$  | Valid time, SPInSOMI data valid after SPInCLK high (clock polarity = 0) | $t_{c(SPC)S} - 6 - t_r$            |                                    |      |
|                  | $t_{v(SPCL-SOMI)S}$  | Valid time, SPInSOMI data valid after SPInCLK low (clock polarity = 1)  | $t_{c(SPC)S} - 6 - t_f$            |                                    |      |
| 6 <sup>(7)</sup> | $t_{su(SIMO-SPCL)S}$ | Setup time, SPInSIMO before SPInCLK low (clock polarity = 0)            | 6                                  |                                    |      |
|                  | $t_{su(SIMO-SPCH)S}$ | Setup time, SPInSIMO before SPInCLK high (clock polarity = 1)           | 6                                  |                                    |      |
| 7 <sup>(7)</sup> | $t_{v(SPCL-SIMO)S}$  | Valid time, SPInSIMO data valid after SPInCLK low (clock polarity = 0)  | 6                                  |                                    |      |
|                  | $t_{v(SPCH-SIMO)S}$  | Valid time, SPInSIMO data valid after SPInCLK high (clock polarity = 1) | 6                                  |                                    |      |

(1) Not production tested.

(2) The MASTER bit (SPInCTRL2.3) is cleared and the CLOCK PHASE bit (SPInCTRL2.0) is cleared.

 (3) If the SPI is in slave mode, the following must be true:  $t_{c(SPC)S} \geq (PS + 1)t_{c(I)CLK}$ , where PS = prescale value set in SPInCTL1[12:5].

(4) For rise and fall timings, see the "Switching Characteristics for Output Timings versus Load Capacitance" table.

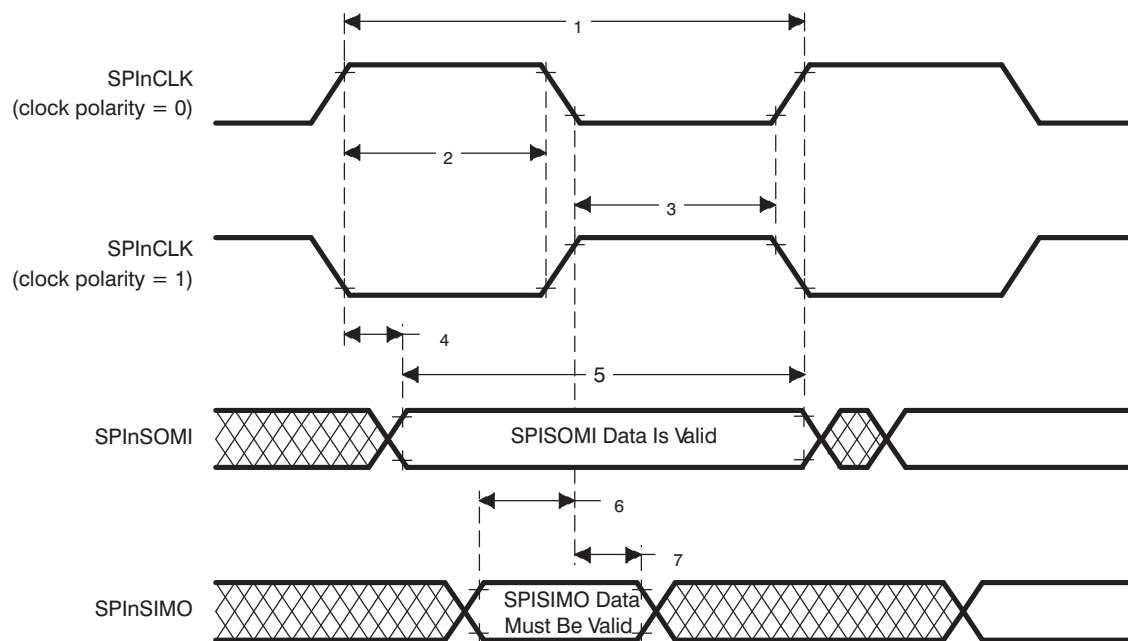
 (5)  $t_{c(I)CLK}$  = interface clock cycle time =  $1/f_{(I)CLK}$ 

(6) When the SPIn is in slave mode, the following must be true:

 For PS values from 1 to 255:  $t_{c(SPC)S} \geq (PS + 1)t_{c(I)CLK} \geq 100$  ns, where PS is the prescale value set in the SPInCTL1[12:5] register bits.

 For PS values of 0:  $t_{c(SPC)S} = 2t_{c(I)CLK} \geq 100$  ns.

(7) The active edge of the SPInCLK signal referenced is controlled by the CLOCK POLARITY bit (SPInCTRL2.1).



**Figure 6-11. SPIn Slave Mode External Timing (CLOCK PHASE = 0)**

**Table 6-13. SPIn Slave Mode External Timing Parameters<sup>(1)</sup>**(CLOCK PHASE = 1, SPInCLK = input, SPInSIMO = input, and SPInSOMI = output)<sup>(2) (3) (4) (5)</sup> (see Figure 6-12)

| NO.       |                      |                                                                         | MIN                                |                                    | MAX              | UNIT |
|-----------|----------------------|-------------------------------------------------------------------------|------------------------------------|------------------------------------|------------------|------|
| 1         | $t_{c(SPC)S}$        | Cycle time, SPInCLK <sup>(6)</sup>                                      | 100                                |                                    | $256t_{c(ICLK)}$ | ns   |
| $2^{(7)}$ | $t_{w(SPCH)S}$       | Pulse duration, SPInCLK high (clock polarity = 0)                       | $0.5t_{c(SPC)S} - 0.25t_{c(ICLK)}$ | $0.5t_{c(SPC)S} + 0.25t_{c(ICLK)}$ |                  |      |
|           | $t_{w(SPCL)S}$       | Pulse duration, SPInCLK low (clock polarity = 1)                        | $0.5t_{c(SPC)S} - 0.25t_{c(ICLK)}$ | $0.5t_{c(SPC)S} + 0.25t_{c(ICLK)}$ |                  |      |
| $3^{(7)}$ | $t_{w(SPCL)S}$       | Pulse duration, SPInCLK low (clock polarity = 0)                        | $0.5t_{c(SPC)S} - 0.25t_{c(ICLK)}$ | $0.5t_{c(SPC)S} + 0.25t_{c(ICLK)}$ |                  |      |
|           | $t_{w(SPCH)S}$       | Pulse duration, SPInCLK high (clock polarity = 1)                       | $0.5t_{c(SPC)S} - 0.25t_{c(ICLK)}$ | $0.5t_{c(SPC)S} + 0.25t_{c(ICLK)}$ |                  |      |
| $4^{(7)}$ | $t_{v(SOMI-SPCH)S}$  | Valid time, SPInCLK high after SPInSOMI data valid (clock polarity = 0) | $0.5t_{c(SPC)S} - 6 - t_r$         |                                    |                  |      |
|           | $t_{v(SOMI-SPCL)S}$  | Valid time, SPInCLK low after SPInSOMI data valid (clock polarity = 1)  | $0.5t_{c(SPC)S} - 6 - t_f$         |                                    |                  |      |
| $5^{(7)}$ | $t_{v(SPCH-SOMI)S}$  | Valid time, SPInSOMI data valid after SPInCLK high (clock polarity = 0) | $0.5t_{c(SPC)S} - 6 - t_r$         |                                    |                  |      |
|           | $t_{v(SPCL-SOMI)S}$  | Valid time, SPInSOMI data valid after SPInCLK low (clock polarity = 1)  | $0.5t_{c(SPC)S} - 6 - t_f$         |                                    |                  |      |
| $6^{(7)}$ | $t_{su(SIMO-SPCH)S}$ | Setup time, SPInSIMO before SPInCLK high (clock polarity = 0)           | 6                                  |                                    |                  |      |
|           | $t_{su(SIMO-SPCL)S}$ | Setup time, SPInSIMO before SPInCLK low (clock polarity = 1)            | 6                                  |                                    |                  |      |
| $7^{(7)}$ | $t_{v(SPCH-SIMO)S}$  | Valid time, SPInSIMO data valid after SPInCLK high (clock polarity = 0) | 6                                  |                                    |                  |      |
|           | $t_{v(SPCL-SIMO)S}$  | Valid time, SPInSIMO data valid after SPInCLK low (clock polarity = 1)  | 6                                  |                                    |                  |      |

(1) Not production tested.

(2) The MASTER bit (SPInCTRL2.3) is cleared and the CLOCK PHASE bit (SPInCTRL2.0) is set.

(3) If the SPI is in slave mode, the following must be true:  $t_{c(SPC)S} \geq (PS + 1)t_{c(ICLK)}$ , where PS = prescale value set in SPInCTL1[12:5].

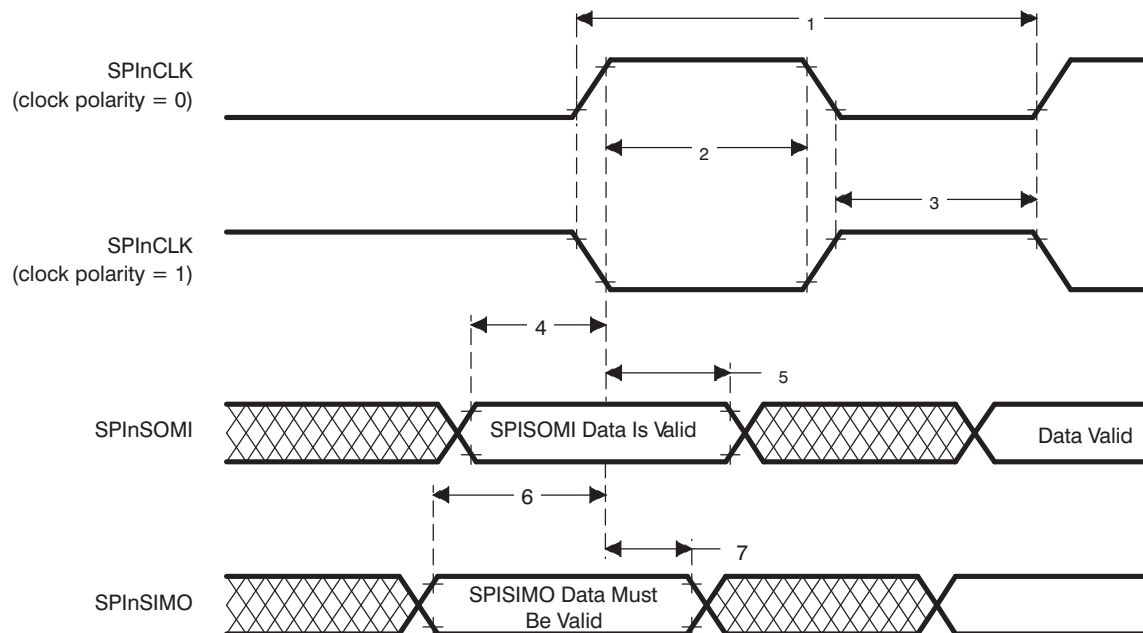
(4) For rise and fall timings, see the "Switching Characteristics for Output Timings versus Load Capacitance" table.

(5)  $t_{c(ICLK)}$  = interface clock cycle time =  $1/f_{(ICLK)}$ 

(6) When the SPIn is in slave mode, the following must be true:

For PS values from 1 to 255:  $t_{c(SPC)S} \geq (PS + 1)t_{c(ICLK)} \geq 100$  ns, where PS is the prescale value set in the SPInCTL1[12:5] register bits.For PS values of 0:  $t_{c(SPC)S} = 2t_{c(ICLK)} \geq 100$  ns.

(7) The active edge of the SPInCLK signal referenced is controlled by the CLOCK POLARITY bit (SPInCTRL2.1).

**Figure 6-12. SPIn Slave Mode External Timing (CLOCK PHASE = 1)**

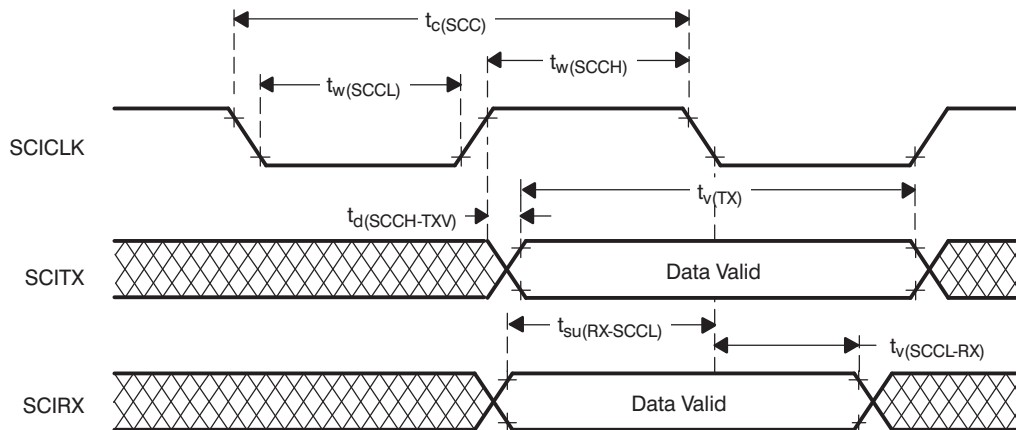
## 6.14 SCIN Isosynchronous Mode Timings - Internal Clock

**Table 6-14. Timing Requirements for Internal Clock SCIN Isosynchronous Mode<sup>(1)(2)(3)(4)</sup>**

(see Figure 6-13)

|                   |                                                    | (BAUD + 1)<br>IS EVEN OR BAUD = 0 |                      | (BAUD + 1)<br>IS ODD AND BAUD ≠ 0      |                                  | UNIT |
|-------------------|----------------------------------------------------|-----------------------------------|----------------------|----------------------------------------|----------------------------------|------|
|                   |                                                    | MIN                               | MAX                  | MIN                                    | MAX                              |      |
| $t_{c(SCC)}$      | Cycle time,<br>SCInCLK                             | $2t_{c(ICLK)}$                    | $2^{24} t_{c(ICLK)}$ | $3t_{c(ICLK)}$                         | $(2^{24} - 1) t_{c(ICLK)}$       | ns   |
| $t_{w(SCCL)}$     | Pulse duration,<br>SCInCLK low                     | $0.5t_{c(SCC)} - t_f$             | $0.5t_{c(SCC)} + 5$  | $0.5t_{c(SCC)} + 0.5t_{c(ICLK)} - t_f$ | $0.5t_{c(SCC)} + 0.5t_{c(ICLK)}$ | ns   |
| $t_{w(SCCH)}$     | Pulse duration,<br>SCInCLK high                    | $0.5t_{c(SCC)} - t_r$             | $0.5t_{c(SCC)} + 5$  | $0.5t_{c(SCC)} - 0.5t_{c(ICLK)} - t_r$ | $0.5t_{c(SCC)} - 0.5t_{c(ICLK)}$ | ns   |
| $t_{d(SCCH-TXV)}$ | Delay time,<br>SCInCLK high to<br>SCInTX valid     |                                   | 10                   |                                        | 10                               | ns   |
| $t_{v(TX)}$       | Valid time,<br>SCInTX data after<br>SCInCLK low    | $t_{c(SCC)} - 10$                 |                      | $t_{c(SCC)} - 10$                      |                                  | ns   |
| $t_{su(RX-SCCL)}$ | Setup time,<br>SCInRX before<br>SCInCLK low        | $t_{c(ICLK)} + t_f + 20$          |                      | $t_{c(ICLK)} + t_f + 20$               |                                  | ns   |
| $t_{v(SCCL-RX)}$  | Valid time,<br>SCInRX data<br>after SCInCLK<br>low | $-t_{c(ICLK)} + t_f + 20$         |                      | $-t_{c(ICLK)} + t_f + 20$              |                                  | ns   |

- (1) Not production tested.  
(2) BAUD = 24-bit concatenated value formed by the SCI[H,M,L]BAUD registers.  
(3)  $t_{c(ICLK)}$  = interface clock cycle time =  $1 / f_{(ICLK)}$   
(4) For rise and fall timings, see the "switching characteristics for output timings versus load capacitance" table.



NOTE: Data transmission/reception characteristics for isosynchronous mode with internal clocking are similar to the asynchronous mode. Data transmission occurs on the SCICLK rising edge, and data reception occurs on the SCICLK falling edge.

**Figure 6-13. SCIN Isosynchronous Mode Timing Diagram for Internal Clock**

## 6.15 SCIN Isosynchronous Mode Timings - External Clock

**Table 6-15. Timing Requirements for External Clock SCIN Isosynchronous Mode<sup>(1)(2) (3)</sup>**

(see [Figure 6-14](#))

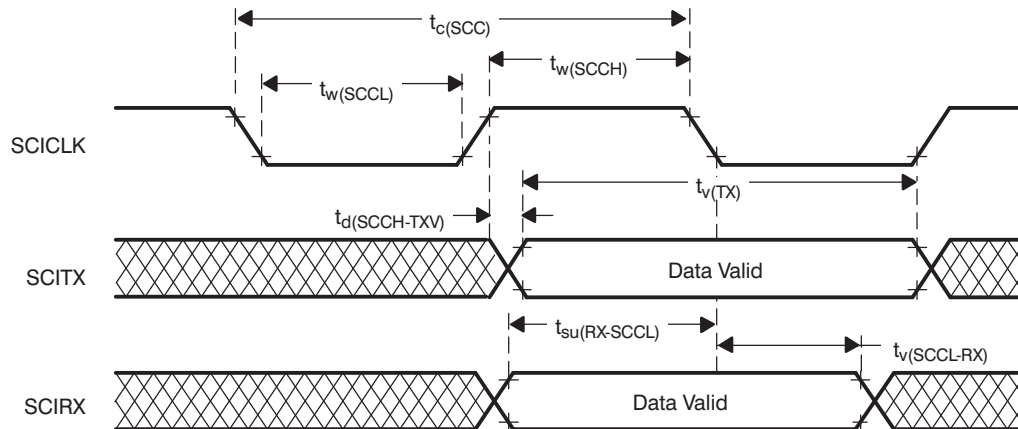
|                   |                                           | MIN                               | MAX                               | UNIT |
|-------------------|-------------------------------------------|-----------------------------------|-----------------------------------|------|
| $t_{c(SCC)}$      | Cycle time, SCInCLK <sup>(4)</sup>        | $8t_{c(ICLK)}$                    |                                   | ns   |
| $t_{w(SCCH)}$     | Pulse duration, SCInCLK high              | $0.5t_{c(SCC)} - 0.25t_{c(ICLK)}$ | $0.5t_{c(SCC)} + 0.25t_{c(ICLK)}$ | ns   |
| $t_{w(SCCL)}$     | Pulse duration, SCInCLK low               | $0.5t_{c(SCC)} - 0.25t_{c(ICLK)}$ | $0.5t_{c(SCC)} + 0.25t_{c(ICLK)}$ | ns   |
| $t_{d(SCCH-TXV)}$ | Delay time, SCInCLK high to SCInTX valid  |                                   | $2t_{c(ICLK)} + 12 + t_r$         | ns   |
| $t_{v(TX)}$       | Valid time, SCInTX data after SCInCLK low | $2t_{c(SCC)} - 10$                |                                   | ns   |
| $t_{su(RX-SCCL)}$ | Setup time, SCInRX before SCInCLK low     | 0                                 |                                   | ns   |
| $t_{v(SCCL-RX)}$  | Valid time, SCInRX data after SCInCLK low | $2t_{c(ICLK)} + 10$               |                                   | ns   |

(1) Not production tested.

(2)  $t_{c(ICLK)}$  = interface clock cycle time =  $1/f_{(ICLK)}$

(3) For rise and fall timings, see the "switching characteristics for output timings versus load capacitance" table.

(4) When driving an external SCInCLK, the following must be true:  $t_{c(SCC)} \geq 8t_{c(ICLK)}$ .



- A. Data transmission / reception characteristics for isosynchronous mode with external clocking are similar to the asynchronous mode. Data transmission occurs on the SCICLK rising edge, and data reception occurs on the SCICLK falling edge.

**Figure 6-14. SCIn Isosynchronous Mode Timing Diagram for External Clock**

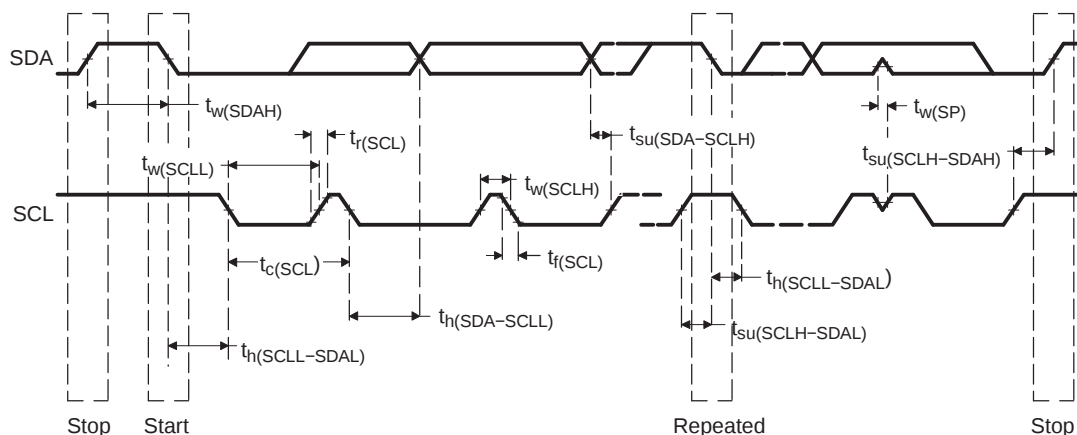
## 6.16 I<sup>2</sup>C Timing

**Table 6-16** Assumes testing over recommended operating conditions.

**Table 6-16. I<sup>2</sup>C Signals (SDA and SCL) Switching Characteristics<sup>(1)(2)</sup>**

| PARAMETER                     |                                                                      |                     | STANDARD MODE |                     | FAST MODE                           |     | UNIT |
|-------------------------------|----------------------------------------------------------------------|---------------------|---------------|---------------------|-------------------------------------|-----|------|
|                               |                                                                      |                     | MIN           | MAX                 | MIN                                 | MAX |      |
| t <sub>c</sub> (I2CCLK)       | Cycle time, I2C module clock                                         |                     | 75            | 150                 | 75                                  | 150 | ns   |
| t <sub>c</sub> (SCL)          | Cycle time, SCL                                                      |                     | 10            |                     | 2.5                                 |     | μs   |
| t <sub>su</sub> (SCLH-SDAL)   | Setup time, SCL high before SDA low (for a repeated START condition) |                     | 4.7           |                     | 0.6                                 |     | μs   |
| t <sub>h</sub> (SCLL-SDAL)    | Hold time, SCL low after SDA low (for a repeated START condition)    |                     | 4             |                     | 0.6                                 |     | μs   |
| t <sub>w</sub> (SCLL)         | Pulse duration, SCL low                                              |                     | 4.7           |                     | 1.3                                 |     | μs   |
| t <sub>w</sub> (SCLH)         | Pulse duration, SCL high                                             |                     | 4             |                     | 0.6                                 |     | μs   |
| t <sub>su</sub> (SDA-SCLH)    | Setup time, SDA valid before SCL high                                |                     | 250           |                     | 100                                 |     | ns   |
| t <sub>h</sub> (SDA-SCLL)     | Hold time, SDA valid after SCL low                                   | For I2C bus devices | 0             | 3.45 <sup>(3)</sup> | 0                                   | 0.9 | μs   |
| t <sub>w</sub> (SDAH)         | Pulse duration, SDA high between STOP and START conditions           |                     | 4.7           |                     | 1.3                                 |     | μs   |
| t <sub>r</sub> (SCL)          | Rise time, SCL                                                       |                     |               | 1000                | 20+0.1C <sub>b</sub> <sup>(4)</sup> | 300 | ns   |
| t <sub>r</sub> (SDA)          | Rise time, SDA                                                       |                     |               | 1000                | 20+0.1C <sub>b</sub> <sup>(4)</sup> | 300 | ns   |
| t <sub>f</sub> (SCL)          | Fall time, SCL                                                       |                     |               | 300                 | 20+0.1C <sub>b</sub> <sup>(4)</sup> | 300 | ns   |
| t <sub>f</sub> (SDA)          | Fall time, SDA                                                       |                     |               | 300                 | 20+0.1C <sub>b</sub> <sup>(4)</sup> | 300 | ns   |
| t <sub>su</sub> (SCLH-SDAH)   | Setup time, SCL high before SDA high (for STOP condition)            |                     | 4.0           |                     | 0.6                                 |     | μs   |
| t <sub>w</sub> (SP)           | Pulse duration, spike (must be suppressed)                           |                     |               |                     | 0                                   | 50  | ns   |
| C <sub>b</sub> <sup>(4)</sup> | Capacitive load for each bus line                                    |                     |               | 400                 |                                     | 400 | pF   |

- (1) Not production tested.
- (2) The I2C pins SDA and SCL do not feature fail-safe I/O buffers. These pins could potentially draw current when the device is powered down.
- (3) The maximum  $t_{h(SDA\_SCLL)}$  for I2C bus devices needs to be met only if the device does not stretch the low period ( $t_{w(SCLL)}$ ) of the SCL signal.
- (4)  $C_b$  = The total capacitance of one bus line in pF. If mixed with HS=mode devices, faster fall-times are allowed.



- A. A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the  $V_{IHmin}$  of the SCL signal) to bridge the undefined region of the falling edge of SCL.
- B. The maximum  $t_{h(SDA-SCLL)}$  needs only be met if the device does not stretch the LOW period ( $t_{w(SCLL)}$ ) of the SCL signal.
- C. A fast-mode I2C-bus device can be used in a standard-mode I2C-bus system, but the requirement  $t_{su(SDA-SCLH)} \geq 250$  ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line  $t_r max + t_{su(SDA-SCLH)}$ .
- D.  $C_b$  = total capacitance of one bus line in pF. If mixed with HS-mode devices, faster fall-times are allowed.

### Figure 6-15. I<sup>2</sup>C Timings

## 6.17 Standard Can Controller (SCC) Mode Timings

**Table 6-17. Dynamic Characteristics for the CANSTX and CANSRX Pins<sup>(1)</sup>**

| PARAMETER      |                                                                  | MIN | MAX | UNIT |
|----------------|------------------------------------------------------------------|-----|-----|------|
| $t_d$ (CANSTX) | Delay time, transmit shift register to CANSTX pin <sup>(2)</sup> |     | 15  | ns   |
| $t_d$ (CANSRX) | Delay time, CANSRX pin to receive shift register                 |     | 5   | ns   |

(1) Not production tested.

(2) These values do not include the rise/fall times of the output buffer.

## 6.18 Expansion Bus Module Timing

**Table 6-18. Expansion Bus Timing Parameters<sup>(1)</sup>**

–55°C ≤ T<sub>A</sub> ≤ 220°C, 3.0 V ≤ V<sub>CC</sub> ≤ 3.6 V (see [Figure 6-16](#) and [Figure 6-17](#))

|                               |                                                                           | MIN  | MAX     | UNIT |
|-------------------------------|---------------------------------------------------------------------------|------|---------|------|
| t <sub>c</sub> (CO)           | Cycle time, CLKOUT                                                        | 20.8 |         | ns   |
| t <sub>d</sub> (COH-EBADV)    | Delay time, CLKOUT high to EBADDR valid                                   |      | 21.4    | ns   |
| t <sub>h</sub> (COH-EBADIV)   | Hold time, EBADDR invalid after CLKOUT high                               |      | 12.4    | ns   |
| t <sub>d</sub> (COH-EBOE)     | Delay time, CLKOUT high to $\overline{\text{EBOE}}$ fall                  |      | 11.4    | ns   |
| t <sub>h</sub> (COH-EBOEH)    | Hold time, $\overline{\text{EBOE}}$ rise after CLKOUT high                |      | 11.4    | ns   |
| t <sub>d</sub> (COL-EBWR)     | Delay time, CLKOUT low to write strobe ( $\overline{\text{EBWR}}$ ) low   |      | 11.3    | ns   |
| t <sub>h</sub> (COL-EBWRH)    | Hold time, $\overline{\text{EBWR}}$ high after CLKOUT low                 |      | 11.6    | ns   |
| t <sub>su</sub> (EBRDATV-COH) | Setup time, EBDATA valid before CLKOUT high (READ) <sup>(2)</sup>         | 15.2 |         | ns   |
| t <sub>h</sub> (COH-EBRDATIV) | Hold time, EBDATA invalid after CLKOUT high (READ)                        |      | (–14.7) | ns   |
| t <sub>d</sub> (COL-EBWDATV)  | Delay time, CLKOUT low to EBDATA valid (WRITE) <sup>(3)</sup>             |      | 16.1    | ns   |
| t <sub>h</sub> (COL-EBWDATIV) | Hold time, EBDATA invalid after CLKOUT low (WRITE)                        |      | 14.7    | ns   |
| <b>SECONDARY TIMES</b>        |                                                                           |      |         |      |
| t <sub>d</sub> (COH-EBCS0)    | Delay, CLKOUT high to $\overline{\text{EBCS0}}$ fall                      |      | 13.6    | ns   |
| t <sub>h</sub> (COH-EBCS0H)   | Hold, $\overline{\text{EBCS0}}$ rise after CLKOUT high                    |      | 13.2    | ns   |
| t <sub>su</sub> (COH-EBHOLDL) | Setup time, $\overline{\text{EBHOLD}}$ low to CLKOUT high <sup>(2)</sup>  | 10.9 |         | ns   |
| t <sub>su</sub> (COH-EBHOLDH) | Setup time, $\overline{\text{EBHOLD}}$ high to CLKOUT high <sup>(2)</sup> | 10.5 |         | ns   |

(1) Not production tested.

(2) Setup time is the minimum time under worst case conditions. Data with less setup time will not work.

(3) Valid after CLKOUT goes low for write cycles.

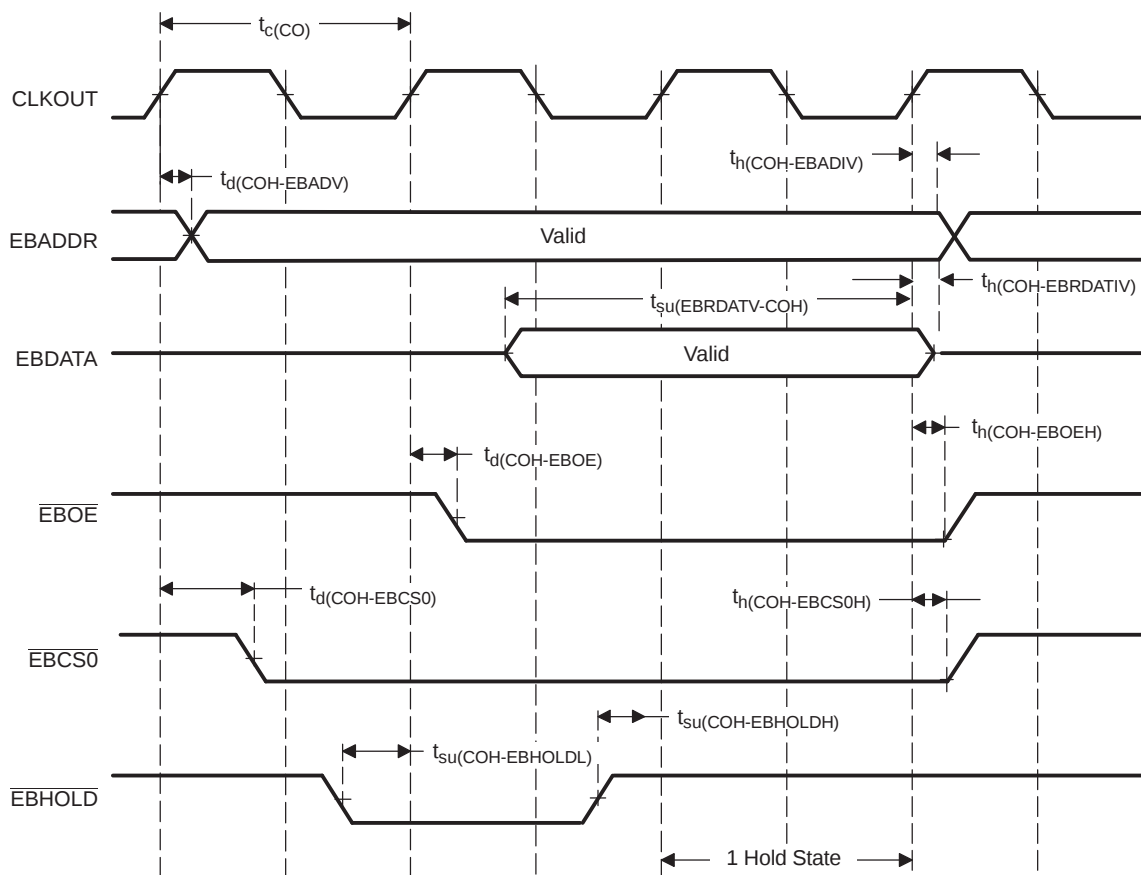
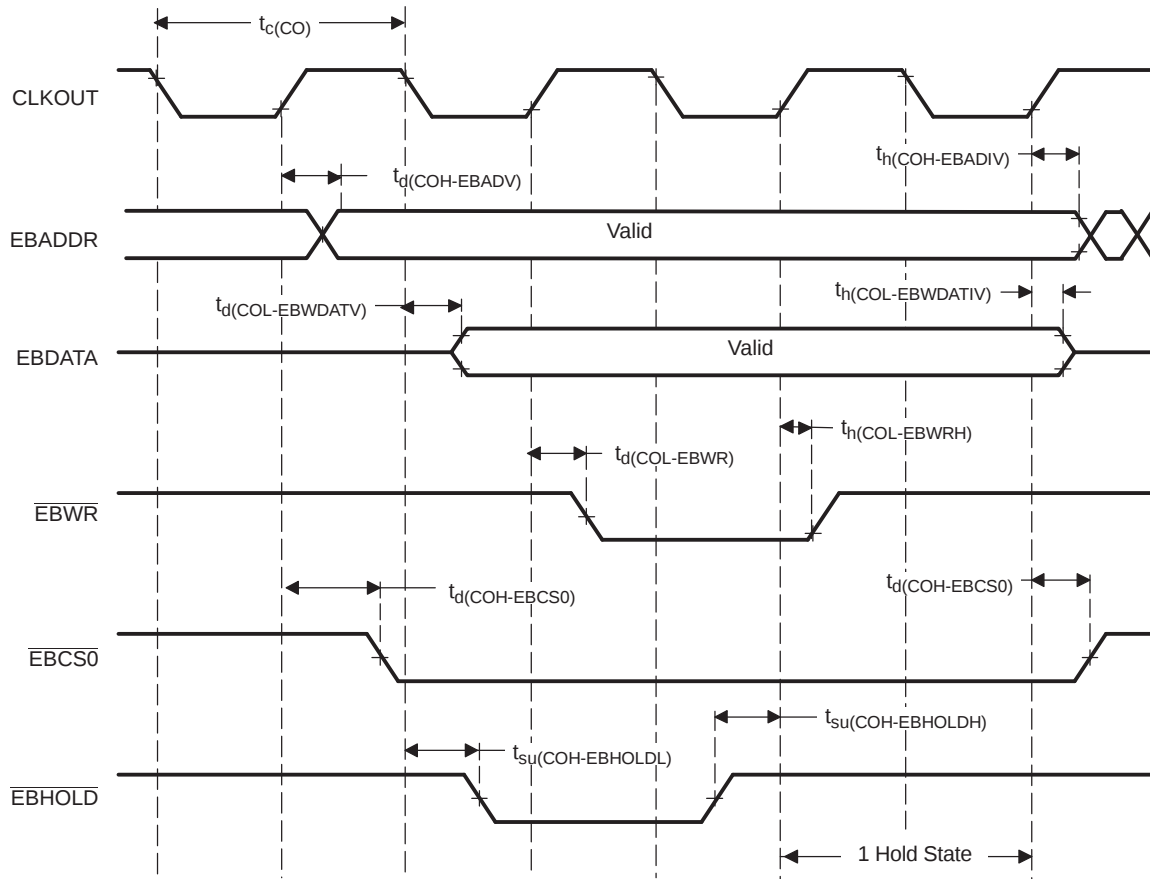


Figure 6-16. Expansion Memory Signal Timing - Reads



**Figure 6-17. Expansion Memory Signal Timing - Writes**

## 6.19 Multi-Buffered A-to-D Converter (MibADC)

The multi-buffered A-to-D converter (MibADC) has a separate power bus for its analog circuitry that enhances the A-to-D performance by preventing digital switching noise on the logic circuitry, which could be present on V<sub>SS</sub> and V<sub>CC</sub>, from coupling into the A-to-D analog stage. All A-to-D specifications are given with respect to AD<sub>REFLO</sub> unless otherwise noted.

|                        |                                                                                                             |
|------------------------|-------------------------------------------------------------------------------------------------------------|
| Resolution             | 10 bits (1024 values)                                                                                       |
| Monotonic              | Assured                                                                                                     |
| Output conversion code | 00h to 3FFh [00 for V <sub>AI</sub> ≤ AD <sub>REFLO</sub> ; 3FF for V <sub>AI</sub> ≥ AD <sub>REFHI</sub> ] |

**Table 6-19. MibADC Recommended Operating Conditions<sup>(1)</sup>**

|                     |                                                                                                                                       | MIN                     | MAX                     | UNIT |
|---------------------|---------------------------------------------------------------------------------------------------------------------------------------|-------------------------|-------------------------|------|
| AD <sub>REFHI</sub> | A-to-D high-voltage reference source                                                                                                  | V <sub>SSAD</sub>       | V <sub>CCAD</sub>       | V    |
| AD <sub>REFLO</sub> | A-to-D low-voltage reference source                                                                                                   | V <sub>SSAD</sub>       | V <sub>CCAD</sub>       | V    |
| V <sub>AI</sub>     | Analog input voltage                                                                                                                  | V <sub>SSAD</sub> – 0.3 | V <sub>CCAD</sub> + 0.3 | V    |
| I <sub>AIC</sub>    | Analog input clamp current <sup>(2)</sup><br>(V <sub>AI</sub> < V <sub>SSAD</sub> – 0.3 or V <sub>AI</sub> > V <sub>CCAD</sub> + 0.3) | –2                      | 2                       | mA   |

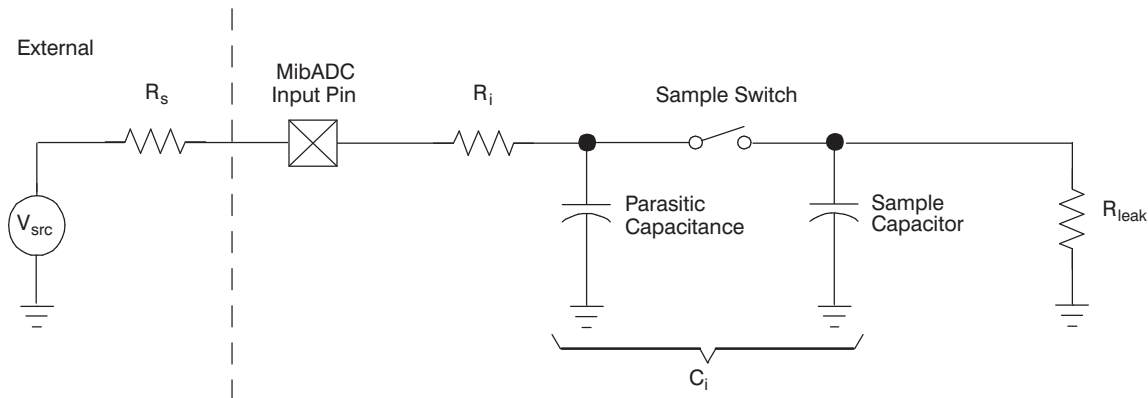
- (1) For V<sub>CCAD</sub> and V<sub>SSAD</sub> recommended operating conditions, see the "Device Recommended Operating Conditions" table.  
(2) Input currents into any ADC input channel outside the specified limits could affect conversion results of other channels.

**Table 6-20. Operating Characteristics over Full Ranges of Recommended Operating Conditions<sup>(1)(2)(3) (4)</sup>**

| PARAMETER     | DESCRIPTION/CONDITIONS                                       | MIN                                                                                                                                                   | TYP | MAX       | UNIT         |
|---------------|--------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----------|--------------|
| $R_i$         | Analog input resistance                                      | See Figure 6-18.                                                                                                                                      |     | 250       | 500 $\Omega$ |
| $C_i$         | Analog input capacitance                                     | See Figure 6-18.                                                                                                                                      |     | 10        | pF           |
|               |                                                              |                                                                                                                                                       |     | 30        | pF           |
| $I_{AIL}$     | Analog input leakage current                                 | See Figure 6-18.                                                                                                                                      |     | –1        | 1 $\mu$ A    |
| $I_{ADREFHI}$ | $AD_{REFHI}$ input current                                   | $AD_{REFHI} = 3.6$ V, $AD_{REFLO} = V_{SSAD}$                                                                                                         |     | 5         | mA           |
| CR            | Conversion range over which specified accuracy is maintained | $AD_{REFHI} - AD_{REFLO}$                                                                                                                             |     | 3         | 3.6 V        |
| $E_{DNL}$     | Differential nonlinearity error                              | Difference between the actual step width and the ideal value. See Figure 6-19.                                                                        |     | $\pm 1.5$ | LSB          |
| $E_{INL}$     | Integral nonlinearity error                                  | Maximum deviation from the best straight line through the MibADC. MibADC transfer characteristics, excluding the quantization error. See Figure 6-20. |     | $\pm 2$   | LSB          |
| $E_{TOT}$     | Total error/Absolute accuracy                                | Maximum value of the difference between an analog value and the ideal midstep value. See Figure 6-21.                                                 |     | $\pm 2.5$ | LSB          |

(1) Not production tested.

(2) INL and DNL values are valid for a max ADCCLK frequency of 15 MHz. For frequencies greater than 15 MHz missing codes are expected at higher temperature.

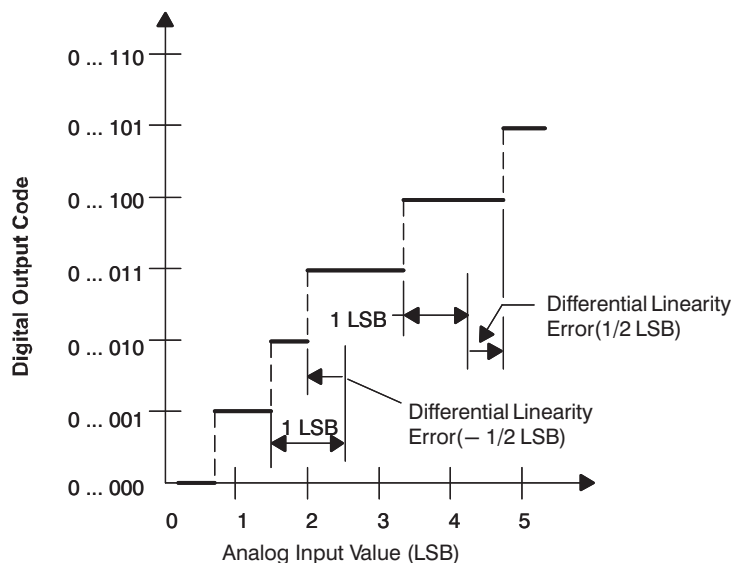
(3)  $V_{CCAD} = AD_{REFHI}$ (4)  $1 \text{ LSB} = (AD_{REFHI} - AD_{REFLO})/2^{10}$  for the MibADC**Figure 6-18. MibADC Input Equivalent Circuit****Table 6-21. Multi-Buffer ADC Timing Requirements<sup>(1)</sup>**

|                             | MIN                                               | NOM | MAX | UNIT    |
|-----------------------------|---------------------------------------------------|-----|-----|---------|
| $t_{c(ADCLK)}$              | Cycle time, MibADC clock                          |     |     | $\mu$ s |
| $t_{d(SH)}$                 | Delay time, sample and hold time                  |     |     | $\mu$ s |
| $t_{d(c)}$                  | Delay time, conversion time                       |     |     | $\mu$ s |
| $t_{d(SHC)}$ <sup>(2)</sup> | Delay time, total sample/hold and conversion time |     |     | $\mu$ s |

(1) Not production tested.

(2) This is the minimum sample/hold and conversion time that can be achieved. These parameters are dependent on many factors; for more details, see the *TMS470R1x Multi-Buffered Analog-to-Digital Converter (MibADC) Reference Guide* (SPNU206).

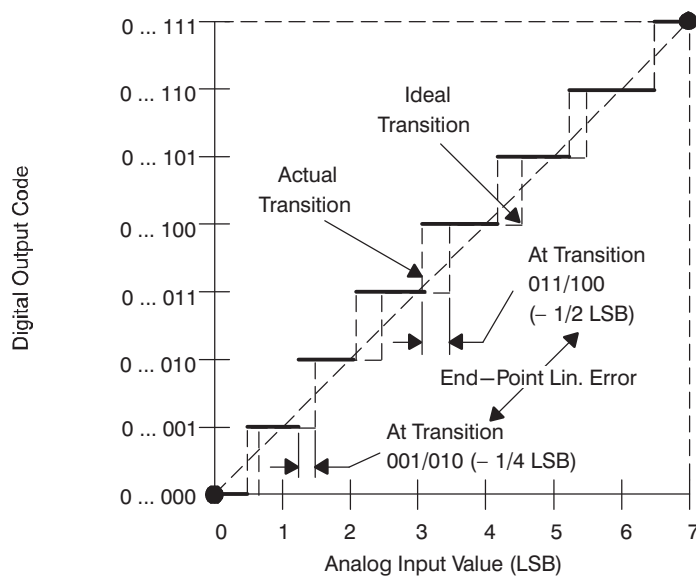
The differential nonlinearity error shown in [Figure 6-19](#) (sometimes referred to as differential linearity) is the difference between an actual step width and the ideal value of 1 LSB.



A.  $1 \text{ LSB} = (AD_{REFHI} - AD_{REFLO}) / 2^{10}$

**Figure 6-19. Differential Nonlinearity (DNL)**

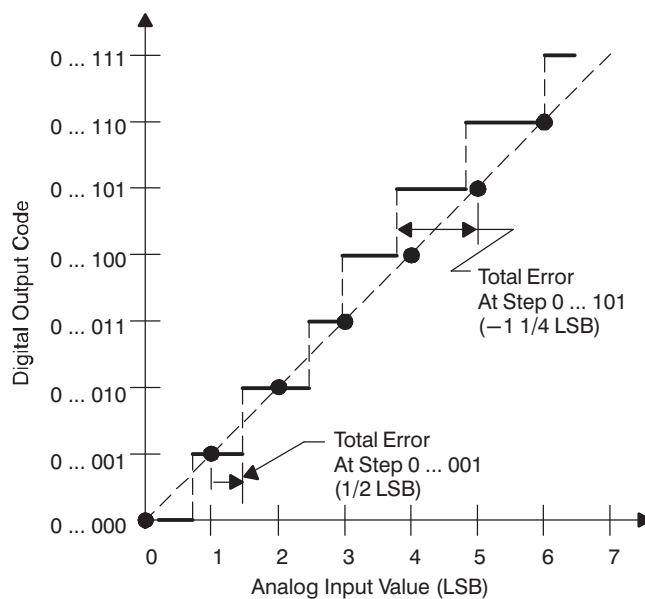
The integral nonlinearity error shown in [Figure 6-20](#) (sometimes referred to as linearity error) is the deviation of the values on the actual transfer function from a straight line.



A.  $1 \text{ LSB} = (AD_{REFHI} - AD_{REFLO}) / 2^{10}$

**Figure 6-20. Integral Nonlinearity (INL) Error**

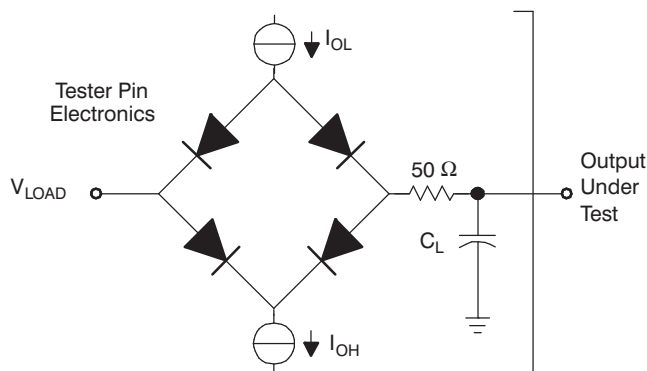
The absolute accuracy or total error of an MibADC as shown in [Figure 6-21](#) is the maximum value of the difference between an analog value and the ideal midstep value.



A.  $1 \text{ LSB} = (AD_{\text{REFHI}} - AD_{\text{REFLO}}) / 2^{10}$

**Figure 6-21. Absolute Accuracy (Total) Error**

## 7 Parameter Measurement Information



Where:  $I_{OL}$  =  $I_{OL}$  MAX for the respective pin (A)  
 $I_{OH}$  =  $I_{OH}$  MIN for the respective pin(A)  
 $V_{LOAD}$  = 1.5 V  
 $C_L$  = 150-pF typical load-circuit capacitance(B)

- A. For these values, see the [Section 6.4](#).
- B. All timing parameters measured using an external load capacitance of 150 pF unless otherwise noted.

**Figure 7-1. Test Load Circuit**

### 7.1 External Reference Resonator/Crystal Oscillator Clock Option

The oscillator is enabled by connecting the appropriate fundamental 4–10 MHz resonator/crystal and load capacitors across the external OSCIN and OSCOUT pins as shown in [Figure 7-2 \(a\)](#). The oscillator is a single-stage inverter held in bias by an integrated bias resistor. This resistor is disabled during leakage test measurement and HALT mode. **TI strongly encourages each customer to submit samples of the device to the resonator/crystal vendors for validation.** The vendors are equipped to determine what load capacitors will best tune their resonator/crystal to the microcontroller device for optimum start-up and operation over temperature/voltage extremes. **Please note that external crystal mode is specified to function only within the temperature ranges of –40°C to 150°C. Above this recommended temperature range it is strongly recommended to use an external clock signal as shown in [Figure 7-2 \(b\)](#).**

An external oscillator source can be used by connecting a 1.8-V clock signal to the OSCIN pin and leaving the OSCOUT pin unconnected (open) as shown in [Figure 7-2b](#).



- A. The values of C1 and C2 should be provided by the resonator/crystal vendor.

**Figure 7-2. Crystal/Clock Connection**

## 8 Detailed Description

### 8.1 Overview

#### 8.1.1 MibADC

The multi-buffered analog-to-digital converter (MibADC) accepts an analog signal and converts the signal to a 10-bit digital value.

The B1M MibADC module can function in two modes: compatibility mode, where its programmer's model is compatible with the SM470R1x ADC module and its digital results are stored in digital result registers; or in buffered mode, where the digital result registers are replaced with three FIFO buffers, one for each conversion group [event, group1 (G1), and group2 (G2)]. In buffered mode, the MibADC buffers can be serviced by interrupts or by the DMA.

##### 8.1.1.1 MibADC Event Trigger Enhancements

The MibADC includes two major enhancements over the event-triggering capability of the SM470R1x ADC.

- Both group 1 and the event group can be configured for event-triggered operation, providing up to two event-triggered groups.
- The trigger source and polarity can be selected individually for both group1 and the event group from the options identified in [Table 8-1](#).

**Table 8-1. MibADC Event Hookup Configuration**

| EVENT NO. | SOURCE SELECT BITS FOR G1 OR EVENT<br>(G1SRC[1:0] OR EVSRC[1:0]) | SIGNAL PIN NAME |
|-----------|------------------------------------------------------------------|-----------------|
| EVENT1    | 00                                                               | ADEVT           |
| EVENT2    | 01                                                               | HET18           |
| EVENT3    | 10                                                               | Reserved        |
| EVENT4    | 11                                                               | Reserved        |

For group1, these event-triggered selections are configured via the group 1 source select bits (G1SRC[1:0]) in the AD event source register (ADEVTSRC[5:4]). For the event group, these event-triggered selections are configured via the event group source select bits (EVSRC[1:0]) in the AD event source register (ADEVTSRC[1:0]).

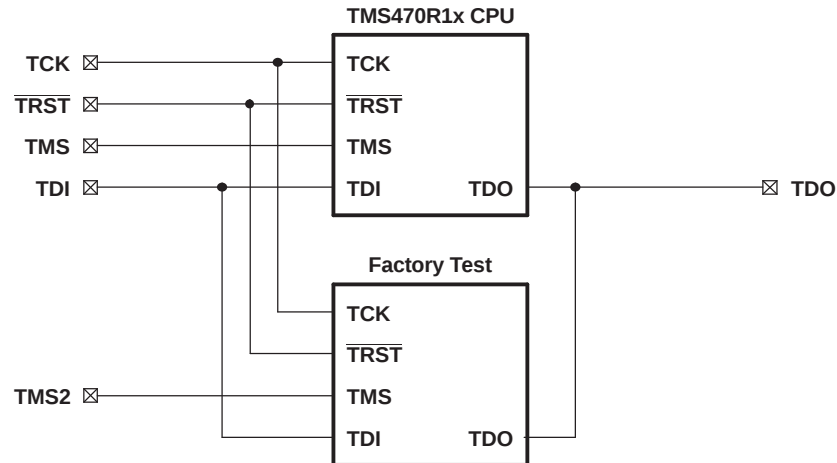
For more detailed functional information on the MibADC, see the *TMS470R1x Multi-Buffered Analog-to-Digital Converter (MibADC) Reference Guide* ([SPNU206](#)).

#### 8.1.2 JTAG Interface

There are two main test access ports (TAPs) on the device:

- SM470R1x CPU TAP
- Device TAP for factory test

Some of the JTAG pins are shared among these two TAPs. The hookup is illustrated in [Figure 8-1](#).



**Figure 8-1. JTAG Interface**

### 8.1.3 High-End Timer (HET) Timings

#### 8.1.3.1 Minimum PWM Output Pulse Width

This is equal to one high resolution clock period (HRP). The HRP is defined by the 6-bit high resolution prescale factor (hr), which is user defined, giving prescale factors of 1 to 64, with a linear increment of codes.

Therefore, the minimum PWM output pulse width =  $HRP(\min) = hr(\min)/SYSCLK = 1/SYSCLK$

For example, for a SYSCLK of 30 MHz, the minimum PWM output pulse width =  $1/30 = 33.33 \text{ ns}$

#### 8.1.3.2 Minimum Input Pulses that can be Captured

The input pulse width must be greater or equal to the low resolution clock period (LRP), that is, the HET loop (the HET program must fit within the LRP). The LRP is defined by the 3-bit loop-resolution prescale factor (lr), which is user defined, with a power of 2 increment of codes. That is, the value of lr can be 1, 2, 4, 8, 16, or 32.

Therefore, the minimum input pulse width =  $LRP(\min) = hr(\min) \times lr(\min)/SYSCLK = 1 \times 1/SYSCLK$

For example, with a SYSCLK of 30 MHz, the minimum input pulse width =  $1 \times 1/30 = 33.33 \text{ ns}$

#### NOTE

Once the input pulse width is greater than LRP, the resolution of the measurement is still HRP. (That is, the captured value gives the number of HRP clocks inside the pulse.)

Abbreviations:

hr = HET high resolution divide rate = 1, 2, 3,...63, 64

lr = HET low resolution divide rate = 1, 2, 4, 8, 16, 32

High resolution clock period =  $HRP = hr/SYSCLK$

Loop resolution clock period =  $LRP = hr \times lr/SYSCLK$

### 8.1.4 Interrupt Priority (IEM to CIM)

Interrupt requests originating from the B1M peripheral modules (that is, SPI1 or SPI2; SCI1 or SCI2; RTI; and so forth) are assigned to channels within the 48-channel interrupt expansion module (IEM) where, via programmable register mapping, these channels are then mapped to the 32-channel central interrupt manager (CIM) portion of the SYS module.

Programming multiple interrupt sources in the IEM to the same CIM channel effectively shares the CIM channel between sources.

The CIM request channels are maskable so that individual channels can be selectively disabled. All interrupt requests can be programmed in the CIM to be of either type:

- Fast interrupt request (FIQ)
- Normal interrupt request (IRQ)

The CIM prioritizes interrupts. The precedence of request channels decrease with ascending channel order in the CIM (0 [highest] and 31 [lowest] priority). For IEM-to-CIM default mapping, channel priorities, and their associated modules, see [Table 8-2](#).

**Table 8-2. Interrupt Priority (IEM and CIM)**

| MODULES   | INTERRUPT SOURCES             | DEFAULT CIM INTERRUPT LEVEL/CHANNEL | IEM CHANNEL |
|-----------|-------------------------------|-------------------------------------|-------------|
| SPI1      | SPI1 end-transfer/overflow    | 0                                   | 0           |
| RTI       | COMP2 interrupt               | 1                                   | 1           |
| RTI       | COMP1 interrupt               | 2                                   | 2           |
| RTI       | TAP interrupt                 | 3                                   | 3           |
| SPI2      | SPI2 end-transfer/overflow    | 4                                   | 4           |
| GIO       | GIO interrupt A               | 5                                   | 5           |
| Reserved  |                               | 6                                   | 6           |
| HET       | HET interrupt 1               | 7                                   | 7           |
| I2C1      | I2C1 interrupt                | 8                                   | 8           |
| SCI1/SCI2 | SCI1 or SCI2 error interrupt  | 9                                   | 9           |
| SCI1      | SCI1 receive interrupt        | 10                                  | 10          |
| Reserved  |                               | 11                                  | 11          |
| I2C2      | I2C2 interrupt                | 12                                  | 12          |
| HECC1     | HECC1 interrupt A             | 13                                  | 13          |
| SCC       | SCC interrupt A               | 14                                  | 14          |
| Reserved  |                               | 15                                  | 15          |
| MibADC    | MibADC end event conversion   | 16                                  | 16          |
| SCI2      | SCI2 receive interrupt        | 17                                  | 17          |
| DMA       | DMA interrupt 0               | 18                                  | 18          |
| I2C3      | I2C3 interrupt                | 19                                  | 19          |
| SCI1      | SCI1 transmit interrupt       | 20                                  | 20          |
| System    | SW interrupt (SSI)            | 21                                  | 21          |
| Reserved  |                               | 22                                  | 22          |
| HET       | HET interrupt 2               | 23                                  | 23          |
| HECC1     | HECC1 interrupt B             | 24                                  | 24          |
| SCC       | SCC interrupt B               | 25                                  | 25          |
| SCI2      | SCI2 transmit interrupt       | 26                                  | 26          |
| MibADC    | MibADC end Group 1 conversion | 27                                  | 27          |
| DMA       | DMA Interrupt 1               | 28                                  | 28          |
| GIO       | GIO interrupt B               | 29                                  | 29          |
| MibADC    | MibADC end Group 2 conversion | 30                                  | 30          |

**Table 8-2. Interrupt Priority (IEM and CIM) (continued)**

| MODULES  | INTERRUPT SOURCES       | DEFAULT CIM INTERRUPT LEVEL/CHANNEL | IEM CHANNEL |
|----------|-------------------------|-------------------------------------|-------------|
| SCI3     | SCI3 error interrupt    | 31                                  | 31          |
| Reserved |                         | 31                                  | 32–37       |
| HECC2    | HECC2 interrupt A       | 31                                  | 38          |
| HECC2    | HECC2 interrupt B       | 31                                  | 39          |
| SCI3     | SCI3 receive interrupt  | 31                                  | 40          |
| SCI3     | SCI3 transmit interrupt | 31                                  | 41          |
| I2C4     | I2C4 interrupt          | 31                                  | 42          |
| I2C5     | I2C5 interrupt          | 31                                  | 43          |
| Reserved |                         | 31                                  | 44–47       |

For more detailed functional information on the IEM, see the *TMS470R1x Interrupt Expansion Module (IEM) Reference Guide* ([SPNU211](#)). For more detailed functional information on the CIM, see the *TMS470R1x System Module Reference Guide* ([SPNU189](#)).

### 8.1.5 Expansion Bus Module (EBM)

The expansion bus module (EBM) is a standalone module used to bond out both general-purpose input/output pins and expansion bus interface pins. This module supports the multiplexing of the GIO and the expansion bus interface functions. The module also supports 8- and 16- bit expansion bus memory interface mappings as well as mapping of the following expansion bus signals:

- 27-bit address bus (EBADDR[26:0] for x8, 19-bit address bus (EBADDR[18:0] for x16)
- 8- or 16-bit data bus (EBDATA[7:0] or EBDATA[15:0])
- 2 write strobes (EBWR[1:0])
- 2 memory chip selects (EBCS[6:5])
- 1 output enable (EBOE)
- 1 external hold signal for interfacing to slow memories (EBHOLD)
- 1 DMA request line (EBDMAREQ[0])

Table 8-3 shows the multiplexing of I/O signals with the expansion bus interface signals. The mapping of these pins varies depending on the memory mode.

**Table 8-3. Expansion Bus MUX Mapping<sup>(1)</sup>**

| GIO       | EXPANSION BUS MODULE PINS     |                               |
|-----------|-------------------------------|-------------------------------|
|           | x8 <sup>(2)</sup>             | x16 <sup>(2)</sup>            |
| GIOB[0]   | EBDMAREQ[0]                   | EBDMAREQ[0]                   |
| GIOC[0]   | $\overline{\text{EBOE}}$      | $\overline{\text{EBOE}}$      |
| GIOC[2:1] | $\overline{\text{EBWR}}[1:0]$ | $\overline{\text{EBWR}}[1:0]$ |
| GIOC[4:3] | $\overline{\text{EBCS}}[6:5]$ | $\overline{\text{EBCS}}[6:5]$ |
| GIOD[5:0] | EBADDR[5:0]                   | EBADDR[5:0]                   |
| GIOE[7:0] | EBDATA[7:0]                   | EBDATA[7:0]                   |
| GIOF[7:0] | EBADDR[13:6]                  | EBDATA[15:8]                  |
| GIOG[7:0] | EBADDR[21:14]                 | EBADDR[13:6]                  |
| GIOH[5]   | $\overline{\text{EBHOLD}}$    | $\overline{\text{EBHOLD}}$    |
| I2C5SDA   | EBADDR[26]                    | EBADDR[18]                    |
| I2C5SCL   | EBADDR[25]                    | EBADDR[17]                    |
| I2C4SCL   | EBADDR[24]                    | EBADDR[16]                    |
| I2C4SDA   | EBADDR[23]                    | EBADDR[15]                    |
| GIOH[0]   | EBADDR[22]                    | EBADDR[14]                    |

(1) For more detailed information, see the *TMS470R1x Expansion Bus Module (EBM) Reference Guide* ([SPNU222](#)) and the *TMS470R1x General Purpose Input/Output Reference Guide* ([SPNU192](#)).

(2) X8 refers to size of memory in 8-bits; X16 refers to size of memory in 16-bits.

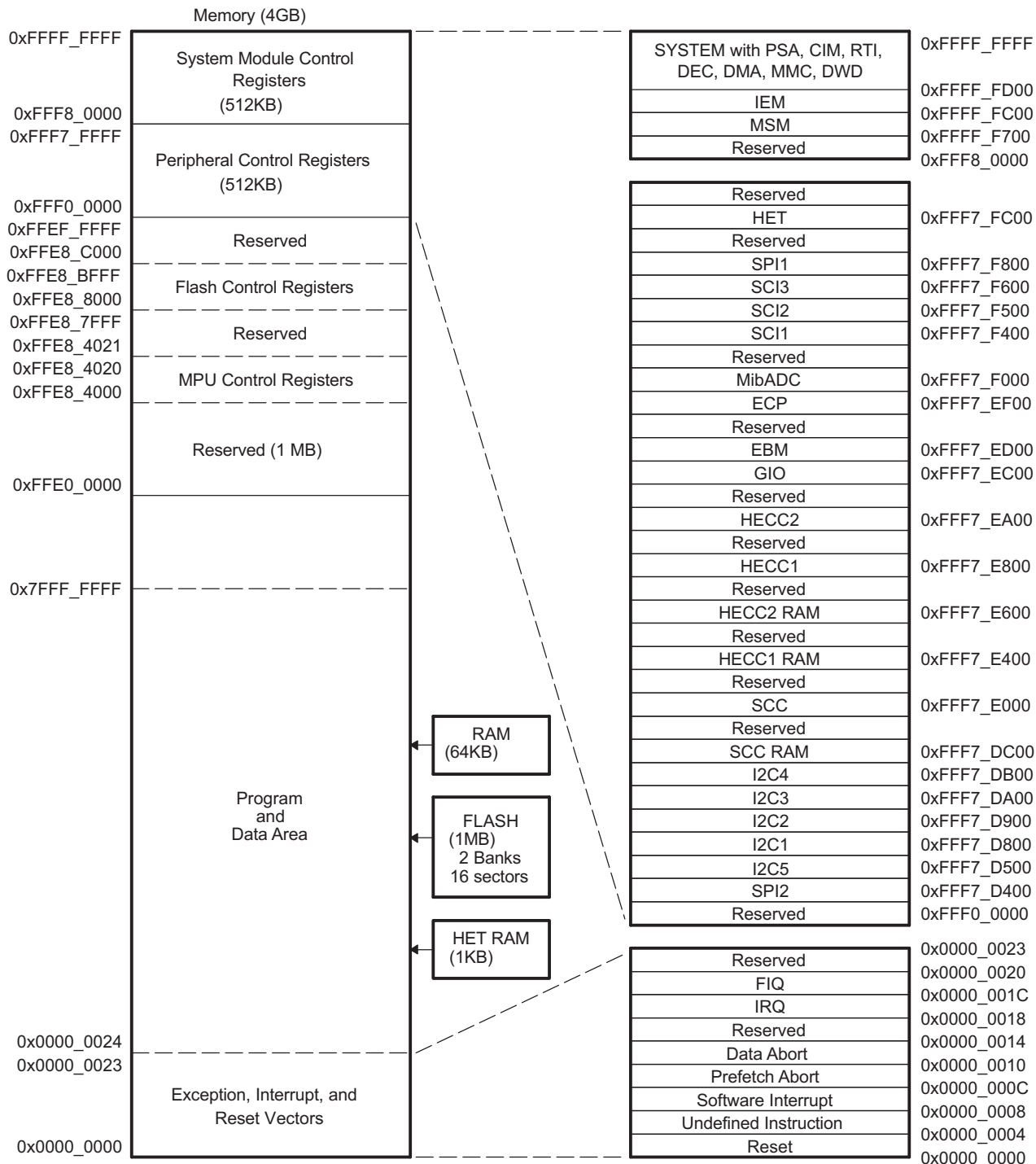
Table 8-4 lists the names of the expansion bus interface signals and their functions.

**Table 8-4. Expansion Bus Pins**

| PIN                        | DESCRIPTION                                                                                                       |
|----------------------------|-------------------------------------------------------------------------------------------------------------------|
| EBDMAREQ                   | Expansion bus DMA request                                                                                         |
| $\overline{\text{EBOE}}$   | Expansion bus pin enable                                                                                          |
| $\overline{\text{EBWR}}$   | Expansion bus write strobe EBWR[1] controls EBDATA[15:8] and EBWR[0] controls EBDATA[7:0]                         |
| $\overline{\text{EBCS}}$   | Expansion bus chip select                                                                                         |
| EBADDR                     | Expansion bus address pins                                                                                        |
| EBDATA                     | Expansion bus data pins                                                                                           |
| $\overline{\text{EBHOLD}}$ | Expansion bus hold: An external device may assert this signal to add wait states to an expansion bus transaction. |

## 8.2 Memory

Figure 8-2 shows the memory map of the B1M device.



- A. Memory addresses are configurable by the system (SYS) module within the range of 0x0000\_0000 to 0xFFE0\_0000.
- B. The CPU registers are not part of the memory map.

Figure 8-2. SM470R1B1M Memory Map

## 8.2.1 Memory Selects

Memory selects allow the user to address memory arrays (that is, flash, RAM, and HET RAM) at user-defined addresses. Each memory select has its own set (low and high) of memory base address registers (MFBAHRx and MFBALRx) that, together, define the array's starting (base) address, block size, and protection.

The base address of each memory select is configurable to any memory address boundary that is a multiple of the decoded block size. For more information on how to control and configure these memory select registers, see the bus structure and memory sections of the *TMS470R1x System Module Reference Guide* ([SPNU189](#)).

For the memory selection assignments and the memory selected, see [Table 8-5](#).

**Table 8-5. SM470R1B1M Memory Selection Assignment**

| MEMORY SELECT | MEMORY SELECTED (ALL INTERNAL) | MEMORY SIZE <sup>(1)</sup>            | MPU | MSM | MEMORY BASE ADDRESS REGISTER | STATIC MEM CTL REGISTER |
|---------------|--------------------------------|---------------------------------------|-----|-----|------------------------------|-------------------------|
| 0 (fine)      | FLASH/ROM                      | 1 M                                   | NO  | YES | MFBAHR0 and MFBALR0          |                         |
| 1 (fine)      | FLASH/ROM                      |                                       | NO  | YES | MFBAHR1 and MFBALR1          |                         |
| 2 (fine)      | RAM                            | 64 K <sup>(2)</sup>                   | YES | YES | MFBAHR2 and MFBALR2          |                         |
| 3 (fine)      | RAM                            |                                       | YES | YES | MFBAHR3 and MFBALR3          |                         |
| 4 (fine)      | HET RAM                        | 1 K                                   | NO  | NO  | MFBAHR4 and MFBALR4          | SMCR1                   |
| 5 (coarse)    | $\overline{CS}[5]/GIOC[3]$     | 512K x 8 (512KB)<br>256K x 16 (512KB) | NO  | NO  | MCBAHR2 and MCBALR2          | SMCR5                   |
| 6 (coarse)    | $\overline{CS}[6]/GIOC[4]$     | 512K x 8 (512KB)<br>256K x 16 (512KB) | NO  | NO  | MCBAHR3 and MCBALR3          | SMCR6                   |

(1) x8 refers to size of memory in 8-bits; x16 refers to size of memory in 16-bits.

(2) The starting addresses for both RAM memory-select signals cannot be offset from each other by a multiple of the user-defined block size in the memory-base address register.

### 8.2.1.1 JTAG Security Module

The B1M device includes a JTAG security module to provide maximum security to the memory contents. The visible unlock code can be in the OTP sector or in the first bank of the user-programmable memory. For the B1M, the visible unlock code is in the OTP sector at address 0x0000\_01F8.

### 8.2.1.2 Memory Security Module

The B1M device also includes a memory security module (MSM) to provide additional security and flexibility to the memory contents' protection. The password for unlocking the MSM is located in the four words just before the flash protection keys.

### 8.2.1.3 RAM

The B1M device contains 64KB of internal static RAM configurable by the SYS module to be addressed within the range of 0x0000\_0000 to 0xFFE0\_0000. This B1M RAM is implemented in one 64KB array selected by two memory-select signals. This B1M configuration imposes an additional constraint on the memory map for RAM; the starting addresses for both RAM memory selects cannot be offset from each other by the multiples of the size of the physical RAM (that is, 64K bytes for the B1M device). The B1M RAM is addressed through memory selects 2 and 3.

The RAM can be protected by the memory protection unit (MPU) portion of the SYS module, allowing the user finer blocks of memory protection than is allowed by the memory selects. The MPU is ideal for protecting an operating system while allowing access to the current task. For more detailed information on the MPU portion of the SYS module and memory protection, see the memory section of the *TMS470R1x System Module Reference Guide* ([SPNU189](#)).

#### **8.2.1.4 F05 Flash**

The F05 flash memory is a nonvolatile electrically erasable and programmable memory implemented with a 32-bit-wide data bus interface. The F05 flash has an external state machine for programming and erase functions. See the *Flash read* and *Flash program and erase* sections.

##### **8.2.1.4.1 Flash Protection Keys**

The B1M device provides flash protection keys. These four 32-bit protection keys prevent program/erase/compaction operations from occurring until after the four protection keys have been matched by the CPU loading the correct user keys into the FMPKEY control register. The protection keys on the B1M are located in the last 4 words of the first 64K sector.

##### **8.2.1.4.2 Flash Read**

The B1M flash memory is configurable by the SYS module to be addressed within the range of 0x0000\_0000 to 0xFFE0\_0000. The flash is addressed through memory selects 0 and 1.

---

#### **NOTE**

The flash external pump voltage ( $V_{CCP}$ ) is required for all operations (program, erase, and read).

---

##### **8.2.1.4.3 Flash Pipeline Mode**

When in pipeline mode, the flash operates with a system clock frequency of up to 60 MHz (versus a system clock frequency of 30 MHz in normal mode). Flash in pipeline mode is capable of accessing 64-bit words and provides two 32-bit pipelined words to the CPU. Also, in pipeline mode the flash can be read with no wait states when memory addresses are contiguous (after the initial 1- or 2-wait-state reads).

---

#### **NOTE**

After a system reset, pipeline mode is disabled (ENPIPE bit [FMREGOPT.0] is a 0). In other words, the B1M device powers up and comes out of reset in non-pipeline mode. Furthermore, setting the flash configuration mode bit (GBLCTRL.4) will override pipeline mode.

---

#### 8.2.1.4.4 Flash Program and Erase

The B1M device flash contains two 512KB memory arrays (or banks), for a total of 1MB of flash, and consists of sixteen sectors. These sixteen sectors are sized as follows:

**Table 8-6. Sectors**

| SECTOR NO. | SEGMENT | LOW ADDRESS | HIGH ADDRESS | MEMORY ARRAYS (OR BANKS) |
|------------|---------|-------------|--------------|--------------------------|
| OTP        | 2KB     | 0x0000_0000 | 0x0000_007FF | BANK0<br>(512KB)         |
| 0          | 64KB    | 0x0000_0000 | 0x0000_FFFF  |                          |
| 1          | 64KB    | 0x0001_0000 | 0x0001_FFFF  |                          |
| 2          | 64KB    | 0x0002_0000 | 0x0002_FFFF  |                          |
| 3          | 64KB    | 0x0003_0000 | 0x0003_FFFF  |                          |
| 4          | 64KB    | 0x0004_0000 | 0x0004_FFFF  |                          |
| 5          | 64KB    | 0x0005_0000 | 0x0005_FFFF  |                          |
| 6          | 64KB    | 0x0006_0000 | 0x0006_FFFF  |                          |
| 7          | 64KB    | 0x0007_0000 | 0x0007_FFFF  |                          |
| 0          | 64KB    | 0x0008_0000 | 0x0008_FFFF  | BANK1<br>(512KB)         |
| 1          | 64KB    | 0x0009_0000 | 0x0009_FFFF  |                          |
| 2          | 64KB    | 0x000A_0000 | 0x000A_FFFF  |                          |
| 3          | 64KB    | 0x000B_0000 | 0x000B_FFFF  |                          |
| 4          | 64KB    | 0x000C_0000 | 0x000C_FFFF  |                          |
| 5          | 64KB    | 0x000D_0000 | 0x000D_FFFF  |                          |
| 6          | 64KB    | 0x000E_0000 | 0x000E_FFFF  |                          |
| 7          | 64KB    | 0x000F_0000 | 0x000F_FFFF  |                          |

The minimum size for an erase operation is one sector. The maximum size for a program operation is one 16-bit word.

#### NOTE

The flash external pump voltage ( $V_{CCP}$ ) is required for all operations (program, erase, and read).

Execution can occur from one bank while programming/erasing any or all sectors of another bank. However, execution cannot occur from any sector within a bank that is being programmed or erased.

#### NOTE

When the OTP sector is enabled, the rest of flash memory is disabled. The OTP memory can only be read or programmed from code executed out of RAM.

#### 8.2.1.4.5 HET RAM

The B1M device contains HET RAM. The HET RAM has a 64-instruction capability. The HET RAM is configurable by the SYS module to be addressed within the range of 0x0000\_0000 to 0xFFE0\_0000. The HET RAM is addressed through memory select 4.

#### 8.2.1.4.6 Peripheral Selects and Base Addresses

The B1M device uses 10 of the 16 peripheral selects to decode the base addresses of the peripherals. These peripheral selects are fixed and transparent to the user since they are part of the decoding scheme used by the SYS module.

Control registers for the peripherals, SYS module, and flash begin at the base addresses shown in [Table 8-7](#).

**Table 8-7. B1M Peripherals, System Module, and Flash Base Addresses**

| CONNECTING MODULE | ADDRESS RANGE |                | PERIPHERAL SELECTS |
|-------------------|---------------|----------------|--------------------|
|                   | BASE ADDRESS  | ENDING ADDRESS |                    |
| SYSTEM            | 0 x FFFF_FFCC | 0 x FFFF_FFFF  | N/A                |
| RESERVED          | 0 x FFFF_FF70 | 0 x FFFF_FFCB  | N/A                |
| DWD               | 0xFFFF_FF60   | 0 x FFFF_FF6F  | N/A                |
| PSA               | 0 x FFFF_FF40 | 0 x FFFF_FF5F  | N/A                |
| CIM               | 0 x FFFF_FF20 | 0 x FFFF_FF3F  | N/A                |
| RTI               | 0 x FFFF_FF00 | 0 x FFFF_FF1F  | N/A                |
| DMA               | 0 x FFFF_FE80 | 0 x FFFF_FEFF  | N/A                |
| DEC               | 0 x FFFF_FE00 | 0 x FFFF_FE7F  | N/A                |
| RESERVED          | 0xFFFF_FD80   | 0xFFFF_FDFF    | N/A                |
| MMC               | 0 x FFFF_FD00 | 0 x FFFF_FD7F  | N/A                |
| IEM               | 0 x FFFF_FC00 | 0 x FFFF_FCFE  | N/A                |
| RESERVED          | 0 x FFFF_Fb00 | 0 x FFFF_FBFF  | N/A                |
| RESERVED          | 0 x FFFF_Fa00 | 0 x FFFF_FAFF  | N/A                |
| DMA CMD BUFFER    | 0 x FFFF_F800 | 0 x FFFF_F9FF  | N/A                |
| MSM               | 0xFFFF_F700   | 0xFFFF_F7FF    | N/A                |
| RESERVED          | 0xFFFF8_0000  | 0xFFFF_F6FF    | N/A                |
| RESERVED          | 0 x FFF7_FD00 | 0xFFFF_FFFF    | PS[0]              |
| HET               | 0xFFFF7_FC00  | 0xFFFF7_FCFE   |                    |
| RESERVED          | 0xFFFF7_F900  | 0xFFFF7_FBFF   | PS[1]              |
| SPI1              | 0xFFFF7_F800  | 0xFFFF7_F8FF   |                    |
| RESERVED          | 0xFFFF7_F700  | 0xFFFF7_F7FF   | PS[2]              |
| SCI3              | 0xFFFF7_F600  | 0xFFFF7_F6FF   |                    |
| SCI2              | 0xFFFF7_F500  | 0xFFFF7_F5FF   |                    |
| SCI1              | 0xFFFF7_F400  | 0xFFFF7_F4FF   |                    |
| RESERVED          | 0xFFFF7_F100  | 0xFFFF7_F3FF   | PS[3]              |
| MibADC            | 0xFFFF7_F000  | 0xFFFF7_F0FF   |                    |
| ECP               | 0xFFFF7_EF00  | 0xFFFF7_EFFF   | PS[4]              |
| RESERVED          | 0xFFFF7_EE00  | 0xFFFF7_EEFF   |                    |
| EBM               | 0xFFFF7_ED00  | 0xFFFF7_EDFF   |                    |
| GIO               | 0xFFFF7_EC00  | 0xFFFF7_ECFE   |                    |
| HECC2             | 0xFFFF7_EB00  | 0xFFFF7_EBFF   | PS[5]              |
|                   | 0xFFFF7_EA00  | 0xFFFF7_EAFF   |                    |
| HECC1             | 0xFFFF7_E900  | 0xFFFF7_E9FF   |                    |
|                   | 0xFFFF7_E800  | 0xFFFF7_E8FF   |                    |
| HECC2 RAM         | 0xFFFF7_E700  | 0xFFFF7_E7FF   | PS[6]              |
|                   | 0xFFFF7_E600  | 0xFFFF7_E6FF   |                    |
| HECC1 RAM         | 0xFFFF7_E500  | 0xFFFF7_E5FF   |                    |
|                   | 0xFFFF7_E400  | 0xFFFF7_E4FF   |                    |

**Table 8-7. B1M Peripherals, System Module, and Flash Base Addresses (continued)**

| CONNECTING MODULE       | ADDRESS RANGE |                | PERIPHERAL SELECTS |
|-------------------------|---------------|----------------|--------------------|
|                         | BASE ADDRESS  | ENDING ADDRESS |                    |
| RESERVED                | 0xFFF7_E100   | 0xFFF7_E3FF    | PS[7]              |
| SCC                     | 0xFFF7_E000   | 0xFFF7_E0FF    |                    |
| RESERVED                | 0xFFF7_DD00   | 0xFFF7_DFFF    | PS[8]              |
| SCC RAM                 | 0xFFF7_DC00   | 0xFFF7_DCFE    |                    |
| I2C4                    | 0xFFF7_DB00   | 0xFFF7_DBFF    | PS[9]              |
| I2C3                    | 0xFFF7_DA00   | 0xFFF7_DAFF    |                    |
| I2C2                    | 0xFFF7_D900   | 0xFFF7_D9FF    |                    |
| I2C1                    | 0xFFF7_D800   | 0xFFF7_D8FF    |                    |
| RESERVED                | 0xFFF7_D600   | 0xFFF7_D7FF    | PS[10]             |
| I2C5                    | 0xFFF7_D500   | 0xFFF7_D5FF    |                    |
| SPI2                    | 0xFFF7_D400   | 0xFFF7_D4FF    |                    |
| RESERVED                | 0xFFF7_CC00   | 0xFFF7_D3FF    | PS[11] – PS[12]    |
| RESERVED                | 0xFFF7_C800   | 0xFFF7_CBFF    | PS[13]             |
| RESERVED                | 0xFFF7_C000   | 0xFFF7_C7FF    | PS[14] – PS[15]    |
| RESERVED                | 0xFFF0_0000   | 0xFFF7_BFFF    | N/A                |
| FLASH CONTROL REGISTERS | 0xFFE8_8000   | 0xFFE8_BFFF    | N/A                |
| RESERVED                | 0xFFF8_4024   | 0xFFF8_7FFF    | N/A                |
| MPU CONTROL REGISTERS   | 0xFFE8_4000   | 0xFFE8_4023    | N/A                |
| RESERVED                | 0xFFF8_0000   | 0xFFF8_3FFF    | N/A                |

#### 8.2.1.4.7 Direct-Memory Access (DMA)

The direct-memory access (DMA) controller transfers data to and from any specified location in the B1M memory map (except for restricted memory locations like the system control registers area). The DMA manages up to 16 channels, and supports data transfer for both on-chip and off-chip memories and peripherals. The DMA controller is connected to both the CPU and peripheral buses, enabling these data transfers to occur in parallel with CPU activity and thus maximizing overall system performance.

Although the DMA controller has two possible configurations, for the B1M device, the DMA controller configuration is 32 control packets and 16 channels.

For the B1M DMA request hardwired configuration, see [Table 8-8](#).

**Table 8-8. DMA Request Lines Connections<sup>(1)</sup>**

| MODULES          | DMA REQUEST INTERRUPT SOURCES       |                             | DMA CHANNEL |
|------------------|-------------------------------------|-----------------------------|-------------|
| EBM              | Expansion Bus DMA request           | EBDMAREQ[0]                 | DMAREQ[0]   |
| SPI1/I2C4        | SPI1 end-receive/I2C4 read          | SPI1DMA0/I2C4DMA0           | DMAREQ[1]   |
| SPI1/I2C4        | SPI1 end-transmit/I2C4 write        | SPI1DMA1/I2C4DMA1           | DMAREQ[2]   |
| MibADC/I2C1      | ADC EV/I2C1 read                    | MibADCMA0/I2C1DMA0          | DMAREQ[3]   |
| MibADC/SCI1/I2C5 | ADC G1/SCI1 end-receive/I2C5 read   | MibADCMA1/SCI1DMA0/I2C5DMA0 | DMAREQ[4]   |
| MibADC/SCI1/I2C5 | ADC G2/SCI1 end-transmit/I2C5 write | MibADCMA2/SCI1DMA1/I2C5DMA1 | DMAREQ[5]   |
| I2C1             | I2C1 write                          | I2C1DMA1                    | DMAREQ[6]   |
| SCI3/SPI2        | SCI3 end-receive/SPI2 end-receive   | SCI3DMA0/SPI2DMA0           | DMAREQ[7]   |
| SCI3/SPI2        | SCI3 end-transmit/SPI2 end-transmit | SCI3DMA0/SPI2DMA1           | DMAREQ[8]   |
| I2C2             | I2C2 read end-receive               | I2C2DMA0                    | DMAREQ[9]   |
| I2C2             | I2C2 write end-transmit             | I2C2DMA1                    | DMAREQ[10]  |
| I2C3             | I2C3 read                           | I2C3DMA0                    | DMAREQ[11]  |
| I2C3             | I2C3 write                          | I2C3DMA1                    | DMAREQ[12]  |
| Reserved         |                                     |                             | DMAREQ[13]  |
| SCI2             | SCI2 end-receive                    | SCI2DMA0                    | DMAREQ[14]  |
| SCI2             | SCI2 end-transmit                   | SCI2DMA1                    | DMAREQ[15]  |

- (1) For DMA channels with more than one assigned request source, *only one* of the sources listed can be the DMA request generator in a given application. The device has software control to ensure that there are no conflicts between requesting modules.

Each channel has two control packets attached to it, allowing the DMA to continuously load RAM and generate periodic interrupts so that the data can be read by the CPU. The control packets allow for the interrupt enable, and the channels determine the priority level of the interrupt.

DMA transfers occur in one of two modes:

- Non-request mode (used when transferring from memory to memory)
- Request mode (used when transferring from memory to peripheral)

For more detailed functional information on the DMA controller, see the *TMS470R1x Direct Memory Access (DMA) Controller Reference Guide* ([SPNU194](#)).

## 9 Device and Documentation Support

### 9.1 Device Support

#### 9.1.1 Device Identification Code Register

The device identification code register identifies the silicon version, the technology family (TF), a ROM or flash device, and an assigned device-specific part number (see [Table 9-1](#)). The B1M device identification code register value is 0xnA5F.

**Figure 9-1. SM470 Device ID Bit Allocation Register [offset = 0xFFFF\_FFF0h]**

|          |    |    |    |     |     |             |    |    |    |    |    |     |     |     |    |
|----------|----|----|----|-----|-----|-------------|----|----|----|----|----|-----|-----|-----|----|
| 31       | 30 | 29 | 28 | 27  | 26  | 25          | 24 | 23 | 22 | 21 | 20 | 19  | 18  | 17  | 16 |
| Reserved |    |    |    |     |     |             |    |    |    |    |    |     |     |     |    |
| 15       | 14 | 13 | 12 | 11  | 10  | 9           | 8  | 7  | 6  | 5  | 4  | 3   | 2   | 1   | 0  |
| VERSION  |    |    |    | TF  | R/F | PART NUMBER |    |    |    |    |    | 1   | 1   | 1   |    |
| R-K      |    |    |    | R-K | R-K | R-K         |    |    |    |    |    | R-1 | R-1 | R-1 |    |

**LEGEND:**

For bits 3-15: R = Read only, -K = Value constant after  $\overline{\text{RESET}}$ .

For bits 0-2: R = Read only, -1 = Value after RESET.

**Table 9-1. SM470 Device ID Bit Allocation Register Field Descriptions**

| BIT   | FIELD       | VALUE  | DESCRIPTION                                                                                                                                                               |
|-------|-------------|--------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 31-16 | Reserved    |        | Reads are undefined and writes have no effect.                                                                                                                            |
| 15-12 | VERSION     |        | Silicon version (revision) bits<br>These bits identify the silicon version of the device.                                                                                 |
| 11    | TF          | 0<br>1 | Technology family bit<br>This bit distinguishes the technology family core power supply:<br>3.3 V for F10/C10 devices<br>1.8 V for F05/C05 devices                        |
| 10    | R/F         | 0<br>1 | ROM/flash bit<br>This bit distinguishes between ROM and flash devices:<br>Flash device<br>ROM device                                                                      |
| 9-3   | PART NUMBER |        | Device-specific part number bits<br>These bits identify the assigned device-specific part number. The assigned device-specific part number for the B1M device is 1001011. |
| 2-0   | 1           |        | Mandatory High<br>Bits 2, 1, and 0 are tied high by default.                                                                                                              |

#### 9.1.2 Timing Parameter Symbolology

Timing parameter symbols have been created in accordance with JEDEC Standard 100. To shorten the symbols, some of the pin names and other related terminology have been abbreviated as follows:

|           |                   |      |                                |
|-----------|-------------------|------|--------------------------------|
| CM        | Compaction, CMPCT | RD   | Read                           |
| CO        | CLKOUT            | RST  | Reset, $\overline{\text{RST}}$ |
| ER        | Erase             | RX   | SCInRX                         |
| ICLK      | Interface clock   | S    | Slave mode                     |
| M         | Master mode       | SCC  | SCInCLK                        |
| OSC, OSCI | OSCIN             | SIMO | SPInSIMO                       |
| OSCO      | OSCOOUT           | SOMI | SPInSOMI                       |
| P         | Program, PROG     | SPC  | SPInCLK                        |

|    |                        |     |              |
|----|------------------------|-----|--------------|
| R  | Ready                  | SYS | System clock |
| R0 | Read margin 0, RDMRGN0 | TX  | SCInTX       |
| R1 | Read margin 1, RDMRGN1 |     |              |

Lowercase subscripts and their meanings are:

|   |                     |    |                        |
|---|---------------------|----|------------------------|
| a | access time         | r  | rise time              |
| c | cycle time (period) | su | setup time             |
| d | delay time          | t  | transition time        |
| f | fall time           | v  | valid time             |
| h | hold time           | w  | pulse duration (width) |

The following additional letters are used with these meanings:

|   |       |   |                                        |
|---|-------|---|----------------------------------------|
| H | High  | X | Unknown, changing, or don't care level |
| L | Low   | Z | High impedance                         |
| V | Valid |   |                                        |

## 9.2 Development Support

TI offers an extensive line of development tools, including tools to evaluate the performance of the processors, generate code, develop algorithm implementations, and fully integrate and debug software and hardware modules. The tool's support documentation is electronically available within the Code Composer Studio™ Integrated Development Environment (IDE).

The following products support development of the SM470R1B1M-HT device applications:

**Software Development Tools:** Code Composer Studio™ Integrated Development Environment (IDE): including Editor C/C++/Assembly Code Generation, and Debug plus additional development tools Scalable, Real-Time Foundation Software (DSP/BIOS™), which provides the basic run-time target software needed to support any SM470R1B1M-HT device application.

**Hardware Development Tools:** Extended Development System (XDS™) Emulator

For a complete listing of development-support tools for the SM470R1B1M-HT platform, visit the Texas Instruments website at [www.ti.com](http://www.ti.com). For information on pricing and availability, contact the nearest TI field sales office or authorized distributor.

## 9.3 Device Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all DSP devices and support tools. Each DSP commercial family member has one of three prefixes: TMX, TMP, or TMS (for example, **TMS470R1B1M**). Texas Instruments recommends two of three possible prefix designators for its support tools: TMDX and TMDS. These prefixes represent evolutionary stages of product development from engineering prototypes (TMX/TMDX) through fully qualified production devices/tools (TMS/TMDS).

Device development evolutionary flow:

|            |                                                                                                                                      |
|------------|--------------------------------------------------------------------------------------------------------------------------------------|
| <b>TMX</b> | Experimental device that is not necessarily representative of the final device's electrical specifications                           |
| <b>TMP</b> | Final silicon die that conforms to the device's electrical specifications but has not completed quality and reliability verification |
| <b>SM</b>  | Fully qualified production device                                                                                                    |

Support tool development evolutionary flow:

**TMDX** Development-support product that has not yet completed Texas Instruments internal qualification testing.

**TMDS** Fully qualified development-support product

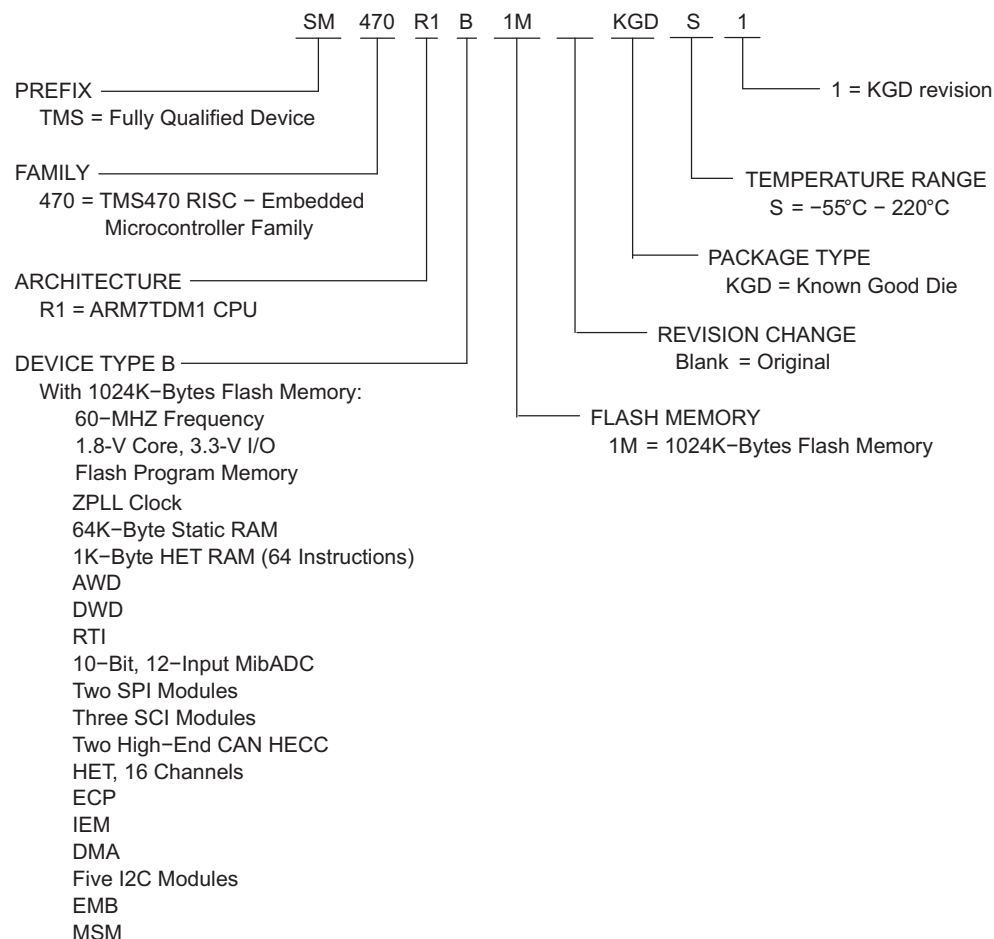
TMX and TMP devices and TMDX development-support tools are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

TMS devices and TMDS development-support tools have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (TMX or TMP) have a greater failure rate than the standard production devices. Texas Instruments recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

Figure 9-2 illustrates the numbering and symbol nomenclature for the SM470R1x family.



**Figure 9-2. SM470R1x Family Nomenclature**

## 9.4 Documentation Support

Extensive documentation supports all of the SM470 microcontroller family generation of devices. The types of documentation available include data sheets with design specifications; complete user's guides for all devices and development support tools; and hardware and software applications. Useful reference documentation includes:

- Bulletin
  - *TMS470 Microcontroller Family Product Bulletin* ([SPNB086](#))
- User's Guides
  - *TMS470R1x System Module Reference Guide* ([SPNU189](#))
  - *TMS470R1x General Purpose Input/Output (GPIO) Reference Guide* ([SPNU192](#))
  - *TMS470R1x Direct Memory Access (DMA) Controller Reference Guide* ([SPNU194](#))
  - *TMS470R1x Direct Memory Access (DMA) Controller Reference Guide* ([SPNU194](#))
  - *TMS470R1x Serial Peripheral Interface (SPI) Reference Guide* ([SPNU195](#))
  - *TMS470R1x Serial Communication Interface (SCI) Reference Guide* ([SPNU196](#))
  - *TMS470R1x Controller Area Network (CAN) Reference Guide* ([SPNU197](#))
  - *TMS470R1x High End Timer (HET) Reference Guide* ([SPNU199](#))
  - *TMS470R1x External Clock Prescale (ECP) Reference Guide* ([SPNU202](#))
  - *TMS470R1x MultiBuffered Analog to Digital (MibADC) Reference Guide* ([SPNU206](#))
  - *TMS470R1x Zero Pin Phase Locked Loop (ZPLL) Clock Module Reference Guide* ([SPNU212](#))
  - *TMS470R1x Digital Watchdog Timer Reference Guide* ([SPNU244](#))
  - *TMS470R1x Interrupt Expansion Module (IEM) Reference Guide* ([SPNU211](#))
  - *TMS470R1x Class II Serial Interface B (C2S1b) Reference Guide* ([SPNU214](#))
  - *TMS470R1x Class II Serial Interface A (C2S1a) Reference Guide* ([SPNU218](#))
  - *TMS470R1x Expansion Bus Module (EBM) Reference Guide* ([SPNU222](#))
  - *TMS470R1x Inter-Integrated Circuit (I2C) Reference Guide* ([SPNU223](#))
  - *TMS470R1x JTAG Security Module (JSM) Reference Guide* ([SPNU245](#))
  - *TMS470R1x Memory Security Module (MSM) Reference Guide* ([SPNU246](#))
  - *TMS470 Peripherals Overview Reference Guide* ([SPNU248](#))
- Errata Sheet
  - *TMS470R1B1M TMS470 Microcontrollers Silicon Errata* ([SPNZ139](#))

## 9.5 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**[TI E2E™ Online Community](#)** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](#), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**[TI Embedded Processors Wiki](#)** *Texas Instruments Embedded Processors Wiki*. Established to help developers get started with Embedded Processors from Texas Instruments and to foster innovation and growth of general knowledge about the hardware and software surrounding these devices.

## 9.6 Trademarks

E2E is a trademark of Texas Instruments.

ARM7TDMI is a trademark of Advanced RISC Machines Limited (ARM).

All other trademarks are the property of their respective owners.

## 9.7 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 9.8 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## **10 Mechanical Packaging and Orderable Information**

### **10.1 Packaging Information**

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| SM470R1B1MHFQS   | ACTIVE        | CFP          | HFQ                | 84   | 1              | TBD                        | AU                      | N / A for Pkg Type   | -55 to 220   | SM470R1B1<br>MHFQS      | <a href="#">Samples</a> |
| SM470R1B1MHKPS   | ACTIVE        | CFP          | HKP                | 84   | 10             | TBD                        | Call TI                 | N / A for Pkg Type   | -55 to 220   | SM470R1B1<br>MHKPS      | <a href="#">Samples</a> |
| SM470R1B1MKGDS1  | ACTIVE        | XCEPT        | KGD                | 0    | 36             | Green (RoHS<br>& no Sb/Br) | Call TI                 | N / A for Pkg Type   | -55 to 220   |                         | <a href="#">Samples</a> |
| SM470R1B1MPGES   | ACTIVE        | LQFP         | PGE                | 144  | 60             | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-4-260C-72 HR   | -55 to 150   | R1B1MPGES<br>SM470      | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and

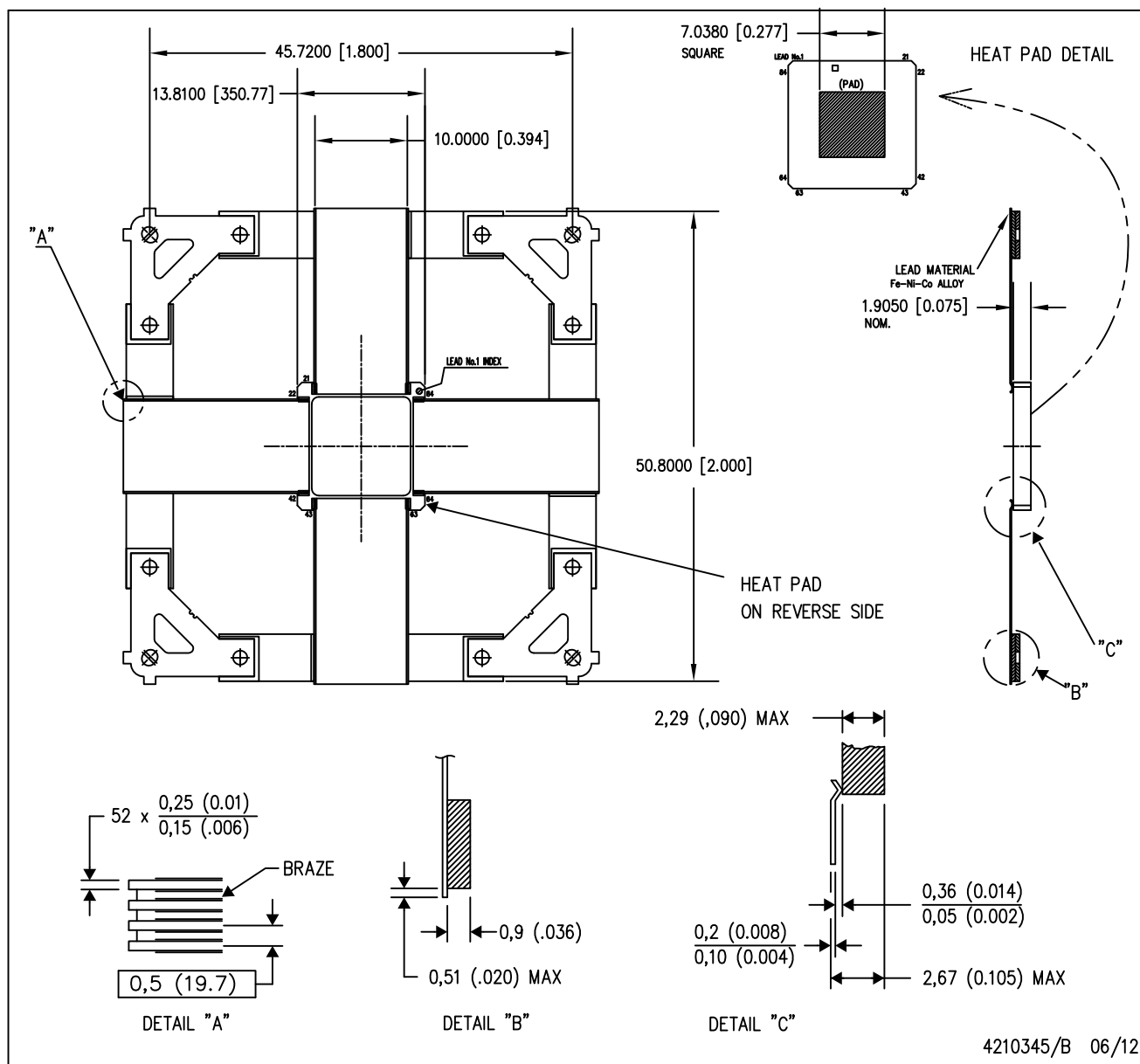
---

continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

HFQ (S-CQFP-F84)

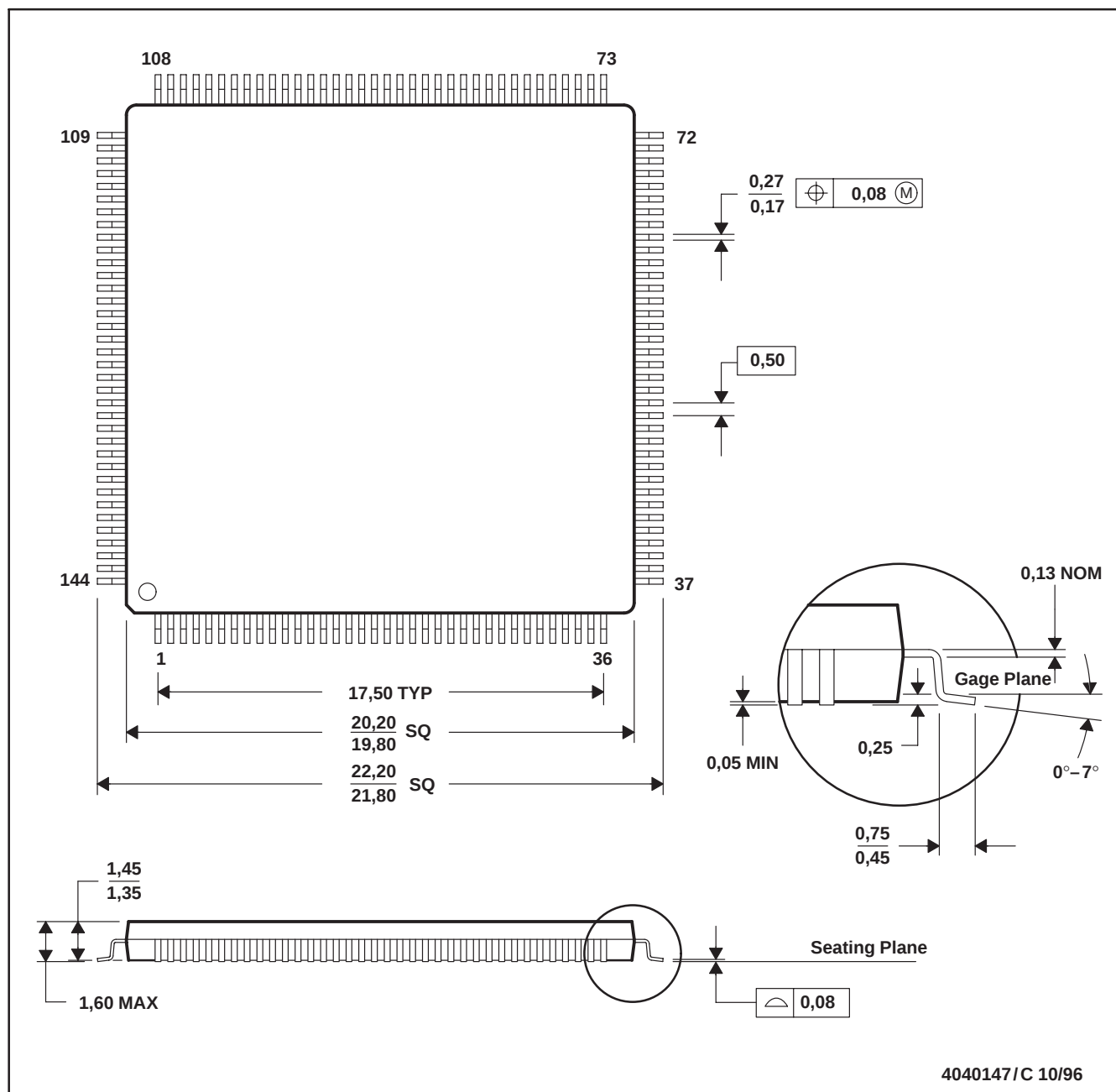
CERAMIC QUAD FLATPACK WITH NCTB



- NOTES:
- All linear dimensions are in millimeters (inches).
  - This drawing is subject to change without notice.
  - Ceramic quad flatpack with flat leads brazed to non-conductive tie bar carrier.
  - This package is hermetically sealed with a metal lid.
  - The leads are gold plated and can be solderdipped.
  - Leads not shown for clarity purposes.
  - Lid and heat sink are connected to GND leads.

## PGE (S-PQFP-G144)

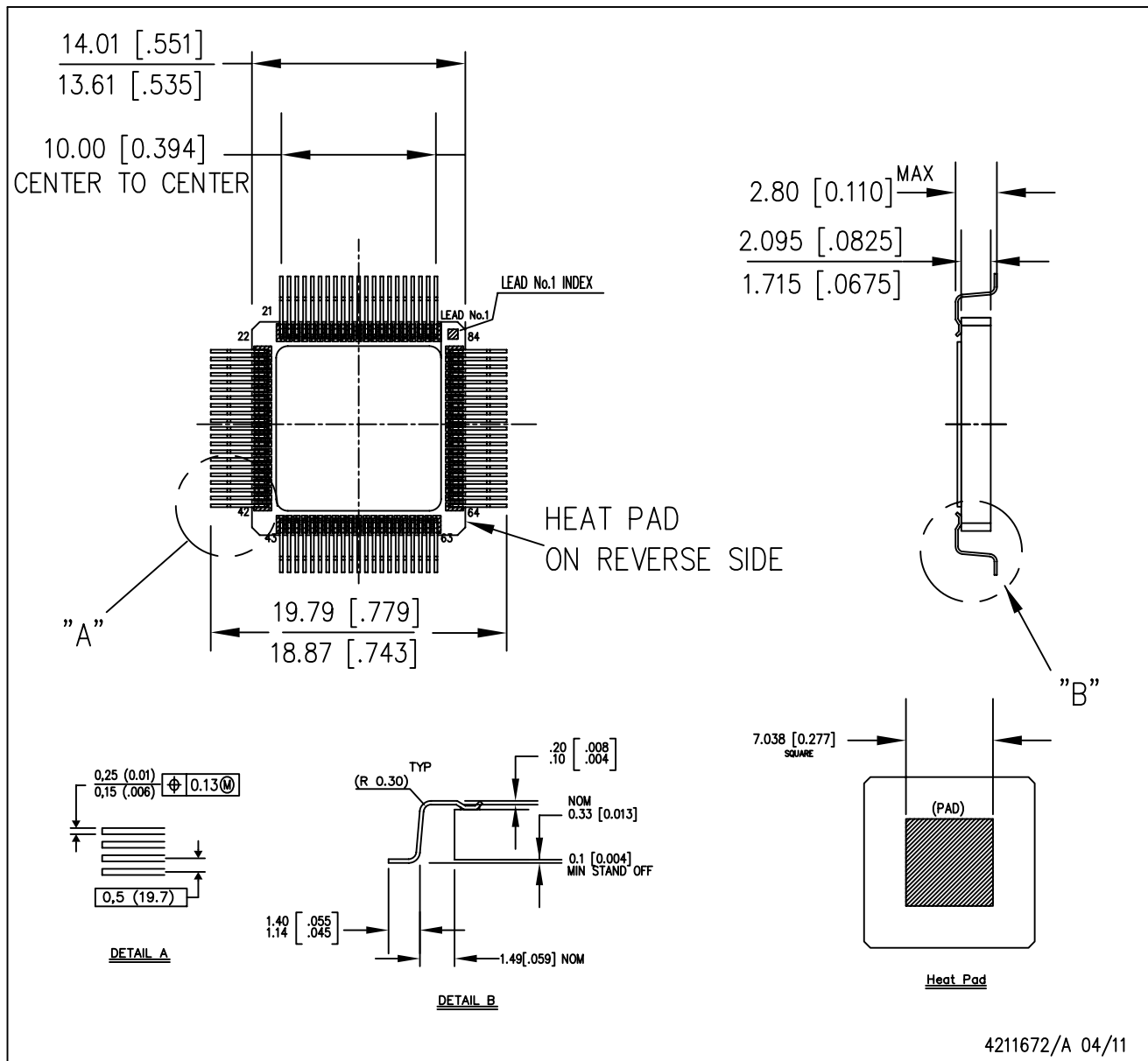
## PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-026

HKP (S-CQFP-G84)

CERAMIC QUAD FLATPACK – GULL WING



- NOTES:
- A. All linear dimensions are in millimeters (inches).
  - B. This drawing is subject to change without notice.
  - C. Ceramic quad flatpack with formed leads.
  - D. This package is hermetically sealed with a metal lid.
  - E. The leads are gold plated and can be solderdipped.
  - F. Lid and heat pad are electrically connected.

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale ([www.ti.com/legal/termsofsale.html](http://www.ti.com/legal/termsofsale.html)) or other applicable terms available either on [ti.com](http://ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2020, Texas Instruments Incorporated